

# 3-Input, 3-Output Any-to-Any Line Card

## PLL with Ultra-Low Jitter

32 Pin QFN

32 Pin QFN

Data Sheet

January 2018

Travs

Tape and Reel

ZL30151

## Features

- Input Clocks
  - Three inputs, two differential/CMOS, one CMOS
  - Any input frequency from 1kHz to 650MHz (1kHz to 300MHz for CMOS)
  - Inputs continually monitored for activity and frequency accuracy
  - Automatic or manual reference switching

#### Low-Bandwidth DPLL

- Programmable bandwidth, 1Hz to 500Hz
- Attenuates jitter up to several UI
- Freerun or holdover on loss of all inputs
- Hitless reference switching
- High-resolution holdover averaging
- Digitally controlled phase adjustment

#### Low-Jitter Fractional-N APLL and 3 Outputs

- Any output frequency from <1Hz to 650MHz
- High-resolution fractional frequency conversion with 0ppm error
- Easy-to-configure, encapsulated design requires no external VCXO or loop filter components
- Each output has independent dividers
- Output jitter is typically 0.16 to 0.28ps RMS (12kHz-20MHz integration band)
- Outputs are CML or 2xCMOS, can interface to LVDS, LVPECL, HSTL, SSTL and HCSL

#### Ordering Information

ZL30151LDG1 ZL30151LDF1

Matte Tin

Package size: 5 x 5 mm

#### -40°C to +85°C

- In 2xCMOS mode, the P and N pins can be different frequencies (e.g. 125MHz and 25MHz)
- Per-output supply pin with CMOS output voltages from 1.5V to 3.3V
- Precise output alignment circuitry and peroutput phase adjustment
- Per-output enable/disable and glitchless start/stop (stop high or low)
- General Features
  - Automatic self-configuration at power-up from internal EEPROM; up to four configurations pin-selectable
  - Numerically controlled oscillator mode
  - Zero-delay mode with external feedback
  - SPI or I<sup>2</sup>C processor Interface
  - Easy-to-use evaluation software

#### Applications

- Telecom line cards for SONET/SDH, PDH, Synchronous Etherenet, Fibre Channel
- Broadcast video equipment
- Frequency conversion and jitter attenuation in a wide variety of equipment types

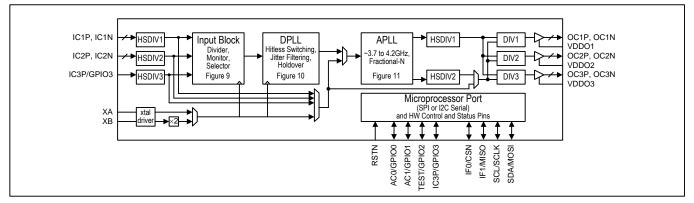


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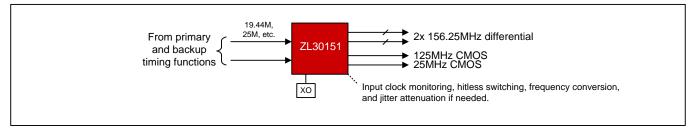
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# 1. Application Examples





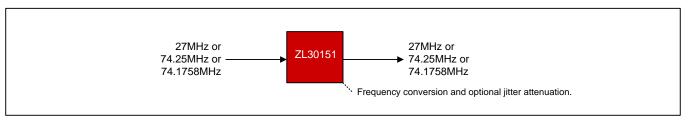


Figure 3 - Broadcast Video Frequency Conversion Application

# 2. Detailed Features

#### 2.1 Input Block Features

- Three input clocks, two differential or single-ended, one single-ended
- Input clocks can be any frequency from 1kHz up to 650MHz (differential) or 300MHz (single-ended)
- Supported telecom frequencies include PDH, SDH, Synchronous Ethernet, OTN, wireless
- Inputs constantly monitored by programmable activity monitors and frequency monitors
- Fast activity monitor can disqualify the selected reference after a few missing clock cycles
- Frequency measurement and monitoring with 1ppm resolution and accept/reject hysteresis
- Optional input clock invalidation on GPIO assertion to react to LOS signals from PHYs

# 2.2 DPLL Features

- Very high-resolution DPLL architecture
- State machine automatically transitions between tracking and freerun/holdover states
- Revertive or nonrevertive reference selection algorithm
- Programmable bandwidth from 1Hz to 500Hz
- Programmable phase-slope limiting
- Programmable frequency rate-of-change limiting
- Programmable tracking range (i.e. hold-in range)
- Truly hitless reference switching with <200ps output clock phase transient
- Output phase adjustment in 10ps steps
- High-resolution frequency and phase measurement
- Fast detection of input clock failure and transition to holdover mode
- Holdover frequency averaging with programmable averaging time and delay time
- Better than 100ppb initial holdover accuracy

#### 2.3 APLL Features

- Very high-resolution fractional scaling (i.e. non-integer multiplication)
- Any-to-any frequency conversion with 0ppm error
- Two high-speed dividers (integers 4 to 15, half divides 4.5 to 7.5)
- Easy-to-configure, completely encapsulated design requires no external VCXO or loop filter components
- Bypass mode supports system testing



#### 2.4 Output Clock Features

- Three low-jitter output clocks
- Each output can be one differential output or two CMOS outputs
- Output clocks can be any frequency from 1Hz to 650MHz (250MHz max for CMOS and HSTL outputs)
- Output jitter is typically 0.16 to 0.28ps RMS (12kHz to 20MHz)
- In CMOS mode, an additional divider allows the OCxN pin to be an integer divisor of the OCxP pin (Example 1: OC3P 125MHz, OC3N 25MHz. Example 2: OC2P 25MHz, OC2N 1Hz)
- Outputs easily interface with CML, LVDS, LVPECL, HSTL, SSTL, HCSL and CMOS components
- Supported telecom frequencies include PDH, SDH, Synchronous Ethernet, OTN
- Can produce clock frequencies for microprocessors, ASICs, FPGAs and other components
- Can produce PCIe clocks (PCIe gen. 1, 2 and 3)
- Sophisticated output-to-output phase alignment
- Per-output phase adjustment with high resolution and unlimited range
- Per-output enable/disable
- Per-output glitchless start/stop (stop high or low)

#### 2.5 General Features

- SPI or I<sup>2</sup>C serial microprocessor interface
- Automatic self-configuration at power-up from internal EEPROM memory; pin control to specify one of four stored configurations
- Numerically controlled oscillator (NCO) mode allows system software to steer DPLL frequency with resolution better than 0.01ppb
- Zero-delay buffer configuration using an external feedback path
- Four general-purpose I/O pins each with many possible status and control options
- Output frame sync signals: 2kHz or 8kHz (SONET/SDH), 1Hz (IEEE 1588) or other frequency
- Can operate as DPLL+APLL for jitter filtering and hitless switching or as APLL only
- Local oscillator can be fundamental-mode crystal or low-cost XO
- Internal compensation for local oscillator frequency error

#### 2.6 Evaluation Software

- Simple, intuitive Windows-based graphical user interface
- Supports all device features and register fields
- Makes lab evaluation of the ZL30151 quick and easy
- Generates configuration scripts to be stored in internal EEPROM
- · Generates full or partial configuration scripts to be run on a system processor
- Works with or without a ZL30151 evaluation board



# 3. Pin Diagram

The device is packaged in a 5x5mm 32-pin QFN.

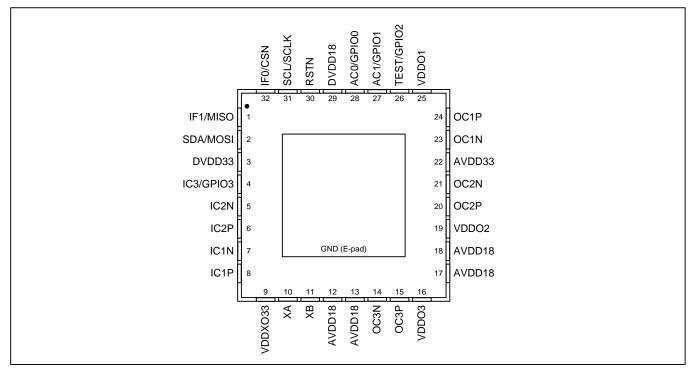


Figure 4 - Pin Diagram



# 4. Pin Descriptions

All device inputs and outputs are LVCMOS unless described otherwise. The Type column uses the following symbols: I – input,  $I_{PU}$  – input with 50k $\Omega$  internal pullup resistor, O – output, A – analog, P – power supply pin. All GPIO and SPI/I<sup>2</sup>C interface pins have Schmitt-trigger inputs and have output drivers that can be disabled (high impedance).

| Table | 1 - | Pin | Descri | ptions |
|-------|-----|-----|--------|--------|
|       |     |     |        |        |

| Pin #                            | Name   | Туре              | Description  |  |  |  |
|----------------------------------|--|-------------------|--|--|--|--|
| 8<br>7<br>6<br>5<br>4            | IC1P<br>IC1N<br>IC2P<br>IC2N<br>IC3P/GPIO3   | <br> <br> <br> /O | <ul> <li>Input Clock Pins         Differential or Single-ended signal format. Programmable frequency.     </li> <li><i>Differential:</i> See Table 10 for electrical specifications, and see Figure 21 for         recommended external circuitry for interfacing these differential inputs to         LVDS, LVPECL, CML or HSCL output pins on neighboring devices.     </li> <li><i>Single-ended:</i> For input signal amplitude &gt;2.5V, connect the signal directly to         ICxP pin. For input signal amplitude ≤2.5V, AC-coupling the signal to ICxP         is recommended. Connect the N pin to a capacitor (0.1µF or 0.01µF) to         VSS. As shown in Figure 21, the ICxP and ICxN pins are internally biased to         approximately 1.3V. Treat the ICxN pin as a sensitive node; minimize stubs;         do not connect to anything else including other ICxN pins.     </li> <li>Unused: Set ICEN.ICxEN=0. The ICxP and ICxN pins can be left floating.</li> <li>Note that the IC3N pin is not bonded out. A differential signal can be         connected to IC3P by AC-coupling the POS trace to IC3P and terminating the         signal on the driver side of the coupling cap. If not needed as an input clock         pin, IC3P can behave as general-purpose I/O pin GPIO3, which is configured         by GPIOCR2. Its state is indicated in GPIOSR.</li> </ul> |  |  |  |
| 10<br>11                         | XA<br>XB A/I                                 |                   | <ul> <li>Crystal or Master Clock Pins</li> <li>Crystal: MCR1.XAB=01. An on-chip crystal driver circuit is designed to work with an external crystal connected to the XA and XB pins. See section 5.4.2 for crystal characteristics and recommended external components.</li> <li>Master Clock: MCR1.XAB=10. An external local oscillator or clock signal (93-130MHz) can be connected to the XA pin. The XB pin must be left unconnected.</li> </ul>   |  |  |  |
| 24<br>23<br>20<br>21<br>15<br>14 | OC1P<br>OC1N<br>OC2P<br>OC2N<br>OC3P<br>OC3N | 0                 | Output Clock Pins<br>CML, HSTL or 1 or 2 CMOS. Programmable frequency and drive strength.<br>See Table 11 and Figure 23 for electrical specifications and recommended<br>external circuitry for interfacing to LVDS, LVPECL or CML input pins on<br>neighboring devices.<br>See Table 12 for electrical specifications for interfacing to CMOS and HSTL<br>inputs on neighboring devices.<br>See Figure 24 for recommended external circuitry for interfacing to HCSL inputs<br>on neighboring devices.  |  |  |  |
| 30                               | RSTN   | I <sub>PU</sub>   | on neighboring devices.<br><b>Reset (Active Low).</b> When this global asynchronous reset is pulled low, all<br>internal circuitry is reset to default values. The device is held in reset as long<br>as RSTN is low. See section 5.12.  |  |  |  |



| Pin #                      | Name        | Туре         | Description   |  |  |
|----------------------------|-------------|--------------|---|--|--|
|                            |             |              | Auto-Configure [1:0] / General Purpose I/O 0 and 1  |  |  |
| 28 AC0/GPIO<br>27 AC1/GPIO |             |              | <i>Auto Configure:</i> On the rising edge of RSTN these pins behave as AC[1:0] and specify one of the configurations stored in EEPROM. See section 5.3. <i>General-Purpose I/O:</i> After reset these pins are GPIO0 and GPIO1. GPIOCR1   |  |  |
|                            |             |              | configures the pins. Their states are indicated in GPIOSR.  |  |  |
|                            |             |              | Factory Test / General Purpose I/O 2  |  |  |
| 26                         | TEST/GPIO2  | I/O          | <i>Factory Test:</i> On the rising edge of RSTN the pin behaves as TEST. Factory test mode is enabled when TEST is high. For normal operation TEST must be low on the rising edge of RSTN.  |  |  |
|                            |             |              | <i>General-Purpose I/O:</i> After reset this pin is GPIO2. GPIOCR2 configures the pin. It state is indicated in GPIOSR.   |  |  |
|                            |             |              | Interface Mode 0 / SPI Chip Select (Active Low)   |  |  |
| 32                         | IF0/CSN     | I/O          | <i>Interface Mode:</i> On the rising edge of RSTN the pin behaves as IF0 and, together with IF1, specifies the interface mode for the device. See section 5.3.  |  |  |
|                            |             |              | <i>SPI Chip Select:</i> After reset this pin is CSN. When the device is configured as a SPI slave, an external SPI master must assert (low) CSN to access device registers.   |  |  |
|                            |             |              | I <sup>2</sup> Č Clock / SPI Clock  |  |  |
| 31                         | SCL/SCLK    | I/O          | <i>I</i> <sup>2</sup> <i>C Clock:</i> When the device is configured as an I <sup>2</sup> <i>C</i> slave, an external I <sup>2</sup> <i>C</i> master must provide the I <sup>2</sup> <i>C</i> clock signal on the SCL pin. Note that I <sup>2</sup> <i>C</i> requires an external pullup resistor on this signal. See the I <sup>2</sup> <i>C</i> specification for details. |  |  |
|                            |             |              | <i>SPI Clock:</i> When the device is configured as a SPI slave, an external SPI master must provide the SPI clock signal on SCLK.   |  |  |
|                            |             |              | Interface Mode 1 / SPI Master-In-Slave-Out  |  |  |
|                            |             |              | <i>Interface Mode:</i> On the rising edge of RSTN the pin behaves as IF1 and, together with IF0, specifies the interface mode for the device. See section 5.3.  |  |  |
| 1                          | IF1/MISO    | IF1/MISO I/O | <i>SPI MISO:</i> After reset this pin is MISO. When the device is configured as a SPI slave, the device outputs data to an external SPI master on MISO during SPI read transactions.  |  |  |
|                            |             |              | Note: On rev A parts, in I <sup>2</sup> C interface mode this pin toggles between driving low and high-<br>impedance during register accesses. Therefore in I <sup>2</sup> C mode this pin must not be wired directly to<br>VDD. To implement a static high value on IF1/MISO, wire it to VDD through a resistor<br>(approximately 10k $\Omega$ recommended).               |  |  |
|                            |             |              | I <sup>2</sup> C Data / SPI Master-Out-Slave-In   |  |  |
| 2                          | SDA/MOSI I, | I/O          | $I^2C$ Data: When the device is configured as an I <sup>2</sup> C slave, SDA is the bidirectional data line between the device and an external I <sup>2</sup> C master. Note that I <sup>2</sup> C requires an external pullup resistor on this signal. See the I <sup>2</sup> C specification for details.   |  |  |
|                            |             |              | <i>SPI MOSI:</i> When the device is configured as a SPI slave, an external SPI master sends commands, addresses and data to the device on MOSI.   |  |  |
| 12                         | AVDD18      | Р            | Analog Power Supply. 1.8V ±5%.  |  |  |

# Table 1 - Pin Descriptions (continued)

\sub Microsemi.

| Pin #     | Name                                  | Туре | Description |  |  |  |  |  |
|-----------|---------------------------------------|------|-------------|--|--|--|--|--|
| 13        |                                       |      |             |  |  |  |  |  |
| 17        |                                       |      |             |  |  |  |  |  |
| 18        |                                       |      |             |  |  |  |  |  |
| Table 1 - | able 1 - Pin Descriptions (continued) |      |             |  |  |  |  |  |

| Pin # | Name    | Туре | Description   |
|-------|---------|------|---|
| 22    | AVDD33  | Р    | Analog Power Supply. 3.3V ±5%.                              |
| 29    | DVDD18  | Р    | Digital Power Supply. 1.8V ±5%.                             |
| 3     | DVDD33  | Р    | Digital Power Supply. 3.3V ±5%.                             |
| 25    | VDDO1   | Р    | Output OC1 Power Supply. 1.5V to 3.3V ±5%.                  |
| 19    | VDDO2   | Р    | Output OC2 Power Supply. 1.5V to 3.3V ±5%.                  |
| 16    | VDDO3   | Р    | Output OC3 Power Supply. 1.5V to 3.3V ±5%.                  |
| 9     | VDDXO33 | Р    | Analog Power Supply for Crystal Driver Circuitry. 3.3V ±5%. |
| E-pad | VSS     | Р    | Ground. 0 Volts.  |

# 5. Functional Description

#### 5.1 Device Identification

The 12-bit read-only ID field and the 4-bit revision field are found in the ID1 and ID2 registers. Contact the factory to interpret the revision value and determine the latest revision.

## 5.2 Top-Level Configuration

The device has two fundamental modes of operation: APLL-only and DPLL+APLL.

# 5.2.1 APLL-Only Mode

In APLL-only mode, the input block and the DPLL are powered down (PLLEN.DPLLEN=0), and the device operates as a high-resolution fractional-N APLL. This reduces chip power consumption as shown in Table 7.

The bandwidth of the APLL is approximately 600kHz and therefore in APLL-only mode the device does not behave as a jitter filter. This means that, in applications where output signals must have sub-ps jitter, the APLL input signal must have sub-ps jitter. In addition, features of the input block and the DPLL including activity monitoring, frequency monitoring and hitless switching are not available. APLL-only mode is enabled when the APLL input mux is set to select an input other than the DPLL output (i.e. APLLCR3.APLLMUX=0xx).

APLL-only mode has two usage cases. First, the APLL can be locked to an external crystal as shown in Figure 5 for frequency synthesis applications. Second, the APLL can be locked to any of the four input clock signals, as shown in Figure 6 for frequency conversion applications.

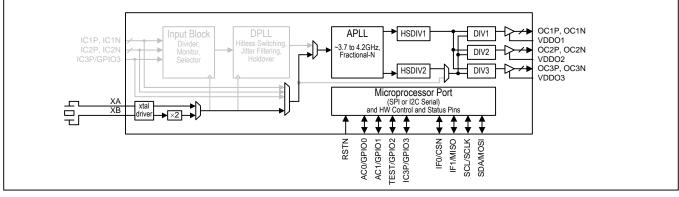


Figure 5 - APLL-Only Mode: Clock Synthesis from a Crystal

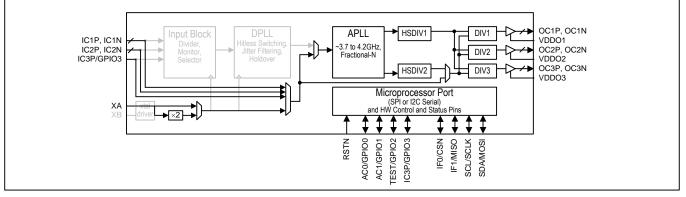


Figure 6 - APLL-Only Mode: Frequency Conversion from One of Four Input Clocks

# 5.2.2 DPLL+APLL Mode

In DPLL+APLL mode, the input block and DPLL are enabled and used. In this mode all input block features are available including activity monitoring, frequency monitoring and automatic reference switching. In addition, all DPLL features are available as well, including hitless switching, holdover, and bandwidths low enough to filter jitter on the input clock signals. Device power consumption is slightly higher than APLL-only mode.

DPLL+APLL mode is enabled when the APLL input mux is set to select the DPLL output (i.e. APLLCR3.APLLMUX=11x) and the input block and DPLL are enabled (PLLEN.DPLLEN=1).

DPLL+APLL mode includes the following three operating modes:

- Jitter Attenuation mode: The DPLL locks to a jittery input clock signal on IC1, IC2 or IC3 and attenuates (filters) the jitter. The device outputs low-jitter clocks on its OCx outputs.
- Numerically Controlled Oscillator (NCO) mode: The input block and most of the DPLL are shut down, and system software controls the DPLL's output frequency through register writes.

In DPLL+APLL mode the input block and the DPLL must operate from a master clock signal that is approximately 100MHz, 114.285MHz or 125MHz (see MCR2.MCLK for exact frequency ranges). DPLL+APLL mode has two usage cases. First, the master clock can be a clock signal on the XA pin, optionally doubled by the clock doubler, as shown in Option 1 in Figure 7. Second, the master clock can come from an external crystal, the internal crystal driver circuit, and the clock doubler as shown in Option 2 in Figure 7. This second use case requires a crystal frequency between 46.5MHz and 60MHz and the clock doubler in order to get a valid master clock frequency.

Note that the clock doubler can be used with an external XO in NCO mode, but the clock doubler generally should not be used with an external XO in jitter attenuation mode. See section 5.4.3 for more details.





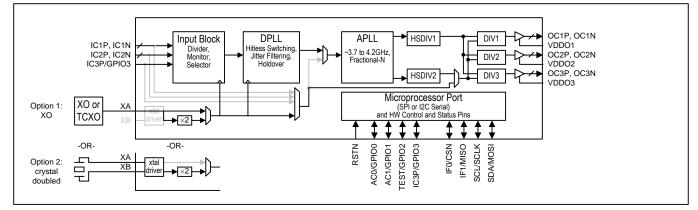


Figure 7 - DPLL+APLL Mode: Locked to One of Three Inputs, Master Clock from XO or Crystal

# 5.2.3 Evaluation Software for Device Configuration

Microsemi provides evaluation software that gives the user a simple, intuitive graphical user interface in which to generate complete device configurations. Often customers can generate base device configurations with the evaluation software without learning the device register set in detail. This saves time and money during system development. When the device is used in APLL-only mode, the use of the evaluation software is optional, but recommended to minimize engineering effort. When the device is used in DPLL+APLL mode, the use of the evaluation software is required as explained in sections 5.7.1 and 5.6.2.3.

# 5.3 Pin-Controlled Automatic Configuration at Reset

The device configuration is determined at reset (i.e. on the rising edge of RSTN) by the signal levels on five device pins: TEST/GPIO2, AC1/GPIO1, AC0/GPIO0, IF1/MISO and IF0/CSN. For each of these pins, the first name (TEST, AC1, AC0, IF1, IF0) indicates their function when they are sampled by the rising edge of the RSTN pin. The second name refers to their function after reset. The values of these pins are latched into the CFGSR register when RSTN goes high. To ensure the device properly samples the reset values of these pins, the following guidelines should be followed:

- 1. Any pullup or pulldown resistors used to set the value of these pins at reset should be  $1k\Omega$ .
- 2. RSTN must be asserted at least as long as specified in section 5.12.

The hardware configuration pins are grouped into three sets:

- 1. TEST Manufacturing test mode
- 2. IF[1:0] Microprocessor interface mode and I<sup>2</sup>C address
- 3. AC[1:0] Auto-configuration from EEPROM

The TEST pin selects manufacturing test modes when TEST=1 (the AC[1:0] pins specify the test mode). TEST=1 and AC[1:0]=00 configures the part so that production SPI EEPROM programmers can program the internal EEPROM. See section 5.14.2 for more information.

The IF[1:0] pins specify the processor interface mode and the I<sup>2</sup>C address:

| IF1 | IF0 | Processor Interface                      |  |  |  |  |
|-----|-----|--|--|--|--|--|
| 0   | 0   | I <sup>2</sup> C, slave address 11100 00 |  |  |  |  |
| 0   | 1   | I <sup>2</sup> C, slave address 11100 01 |  |  |  |  |
| 1   | 0   | I <sup>2</sup> C, slave address 11100 10 |  |  |  |  |
| 1   | 1   | SPI Slave                                |  |  |  |  |

The AC[1:0] pins specify which of four device configurations in the EEPROM to execute after reset:



| AC1 | AC0             | Auto Configuration |  |  |  |
|-----|-----------------|--------------------|--|--|--|
| 0   | Configuration 0 |                    |  |  |  |
| 0   | 1               | Configuration 1    |  |  |  |
| 1   | 0               | Configuration 2    |  |  |  |
| 1   | 1               | Configuration 3    |  |  |  |

For more information about auto-configuration from EEPROM see section 5.14.1.

#### 5.4 Local Oscillator or Crystal

Section 5.2 describes several device configurations that make use of either an external local oscillator (XO or TCXO) or an external crystal. Section 5.4.1 describes how to connect an external oscillator and the required characteristics of the oscillator. Section 5.4.2 describes how to connect an external crystal to the on-chip crystal driver circuit and the required characteristics of the crystal.

#### 5.4.1 External Oscillator

A signal from an external oscillator can be connected to the XA pin (XB must be left unconnected). Table 9 specifies the range of possible frequencies for the XA input. Several vendors including Vectron, Rakon and TXC offer low-cost, low-jitter XOs with output frequencies in this range. In DPLL+APLL jitter attenuation mode the frequency of the external oscillator must be specified in the MCR2.MCLK field. To minimize jitter, the signal must be properly terminated and must have very short trace length. A poorly terminated single-ended signal can greatly increase output jitter, and long single-ended trace lengths are more susceptible to noise. When MCR1.XAB=10, XA is enabled as a single-ended input.

In DPLL+APLL mode, the stability of the DPLL in freerun or holdover is equivalent to the stability of the external oscillator. While many applications can make use of a simple XO component, some applications may require the stability of a TCXO. Contact Microsemi timing products technical support for recommended oscillator components.

While the stability of the external oscillator can be important, its absolute frequency accuracy is less important because any known frequency inaccuracy of the oscillator can be compensated. When the device is configured for DPLL+APLL mode, the DPLL's DFREQZ parameter can be used to compensate for oscillator frequency error. When the device is configured for APLL-only mode, the APLL's fractional feedback divider value (AFBDIV) can be adjusted by ppb or ppm to compensate for oscillator frequency error.

The jitter on output clock signals depends on the phase noise and frequency of the external oscillator. For the device to operate with the lowest possible output jitter, the external oscillator should have the following characteristics:

- Phase Jitter: less than 0.1ps RMS over the 12kHz to 5MHz integration band
- Frequency: The higher the better, all else being equal

#### 5.4.2 External Crystal and On-Chip Driver Circuit

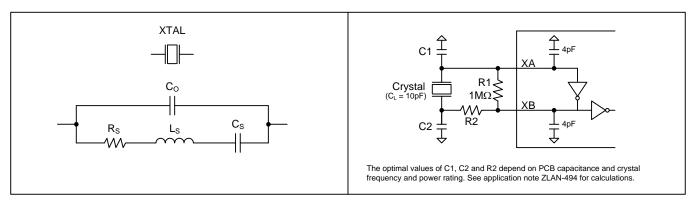
The on-chip crystal driver circuit is designed to work with a <u>fundamental mode, AT-cut</u> crystal resonator. See Table 2 for recommended crystal specifications. To enable the crystal driver, set MCR1.XAB=01.

See Figure 8 for the crystal equivalent circuit and the recommended external capacitor connections. To achieve a crystal load ( $C_L$ ) of 10pF, an external 16pF is placed in parallel with the 4pF internal capacitance of the XA pin, and an external 16pF is placed in parallel with the 4pF internal capacitance of the XB pin. The crystal then sees a load of 20pF in series with 20pF, which is 10pF total load. Note that the 16pF capacitance values in Figure 8 include all capacitance on those nodes. If, for example, PCB trace capacitance between crystal pin and IC pin is 2pF then 14pF capacitors should be used to make 16pF total.

The crystal, traces, and two external capacitors should be placed on the board as close as possible to the XA and XB pins to reduce crosstalk of active signals into the oscillator. Also no active signals should be routed under the crystal circuitry.



Note: Crystals have temperature sensitivies that can cause frequency changes in response to ambient temperature changes. In applications where significant temperature changes are expected near the crystal, it is recommended that the crystal be covered with a thermal cap, or an external XO or TCXO should be used instead.



#### Figure 8 - Crystal Equivalent Circuit / Recommended Crystal Circuit

#### Table 2 - Crystal Selection Parameters

| Parameter   |      | Symbol | Min. | Тур. | Max. | Units |
|---|------|--------|------|------|------|-------|
| Crystal oscillation frequency <sup>1</sup>  | fosc | 25     |      | 60   | MHz  |       |
| Shunt capacitance   | Co   |        | 2    | 5    | pF   |       |
| Load capacitance  |      | C∟     |      | 10   |      | pF    |
| Equivalent series resistance $f_{OSC} < 40 MHz$ (ESR) <sup>2</sup> $f_{OSC} > 40 MHz$ |      | Rs     |      |      | 60   | Ω     |
|   |      | Rs     |      |      | 50   | Ω     |
| Maximum crystal drive level   |      | 100    |      |      | μW   |       |

Note 1: Higher frequencies give lower output jitter, all else being equal.

Note 2: These ESR limits are chosen to constrain crystal drive level to less than 100μW. If the crystal can tolerate a drive level greater than 100μW then proportionally higher ESR is acceptable.

| Parameter                                    | Symbol           | Min. | Тур. | Max. | Units                   |
|--|------------------|------|------|------|-------------------------|
| Crystal Frequency Stability vs. Power Supply | f <sub>FVD</sub> |      | 0.2  | 0.5  | ppm per 10%<br>∆ in VDD |

Any known frequency inaccuracy of the crystal can be compensated in the DPLL or in the APLL. When the device is configured for DPLL+APLL mode, the DPLL's DFREQZ field can be used to compensate for crystal frequency error. When the device is configured for APLL-only mode, the APLL's fractional feedback divider value (AFBDIV) can be adjusted by ppb or ppm to compensate for crystal frequency error.

#### 5.4.3 Clock Doubler

Figure 1 shows an optional clock doubler ("x2" block) following the crystal driver block. The doubler, which is enabled by setting MCR1.DBL=1, can be used to double the frequency of the internal crystal driver circuit or a clock signal on the XA pin. The following table shows scenarios when the clock doubler can be used.

| Device Mode                    | With Crystal       | With XO or Clock Signal |
|--------------------------------|--------------------|-------------------------|
| APLL-Only, Integer Multiply    | Maybe <sup>1</sup> | Maybe <sup>1</sup>      |
| APLL-Only, Fractional Multiply | Yes                | Yes                     |
| DPLL+APLL Jitter Attenuation   | Yes                | Not Recommended         |
| DPLL+APLL NCO                  | Yes                | Yes                     |

Note 1: For APLL integer multiplication, use of the doubler is application-dependent. On the positive side, use of the doubler reduces random jitter. On the negative side, the doubler causes a large spur at the XA frequency (but this spur may be outside the band of interest for the application).



#### 5.4.4 Ring Oscillator (for System Start-Up)

To ensure that registers can be written immediately after system start-up, in its power-on reset state the device operates its registers and processor interface from an internal ring oscillator.

When operating the device in DPLL+APLL mode, as soon as the external oscillator connected to the XA pin has stabilized and is ready to use, the MCR1.MCSEL bit must be set to source the DPLL master clock from XA. If the ring oscillator causes undesirable spurs it can be disabled (powered down) by setting MCR1.ROSCD=1.

When operating the part in APLL-only mode, a master clock signal on the XA pin is not required, and the ring oscillator is left enabled to provide a clock for the processor interface logic and registers.

#### 5.5 Input Signal Format Configuration

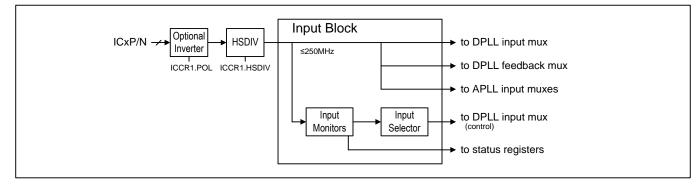
Input clocks IC1, IC2 and IC3 are enabled by setting the enable bits in the ICEN register. The power consumed by a differential receiver is shown in Table 7. The electrical specifications for these inputs are listed in Table 10. Each input clock can be configured to accept nearly any differential signal format by using the proper set of external components (see Figure 21). To configure these differential inputs to accept single-ended CMOS signals, connect the single-ended signal to the ICxP pin, and connect the ICxN pin to a capacitor ( $0.1\mu$ F or  $0.01\mu$ F) to VSS. Each ICxP and ICxN pin is internally biased to approximately 1.3V. If an input is not used, both ICxP and ICxN pins can be left floating. Note that the IC3N pin is not present. A differential signal can be connected to IC3P by AC-coupling the POS trace to IC3P and terminating the signal on the driver side of the coupling cap. If not needed as an input clock pin, IC3P can behave as general-purpose I/O pin GPIO3.

#### 5.6 Input Block: Input Divider, Monitor and Selector

The input block performs the following functions:

- Frequency division to a frequency suitable for DPLL locking
- Activity monitoring
- Frequency monitoring
- DPLL input clock selection (automatic or manual)

Figure 9 is a block diagram of the input block. This block requires a master clock as described in section 5.2.2.



#### Figure 9 - Input Block Diagram

# 5.6.1 Input Clock Inversion and High-Speed Dividers

The input block tolerates a wide range of duty cycles out to a minimum high time or minimum low time of 3ns or 30% of the clock period, whichever is smaller.

Any frequency in the 1kHz to 250MHz range can be accepted by the input block. Important notes about the input block:

• ICxCR1.POL specifies the edge to which the DPLL will lock (by default, the rising edge).

- ICxCR1.HSDIV must be set correctly to reduce the clock frequency below 250MHz.
- In DPLL+APLL mode, the frequencies of all enabled ICx input clocks must divide by integers to a common DPLL phase-frequency detector (PFD) frequency ≥ 1kHz. In addition, the common PFD frequency must be ≥ 20 times the DPLL bandwidth.

#### 5.6.2 Input Clock Monitoring

Each ICx input clock can be monitored continuously for activity and frequency accuracy.

The activity monitor counts the number of input clock cycles that occur during a configurable interval. This provides the fastest detection when the input clock is stopped or far off frequency. Register bit ICxSR.ACVAL indicates the real-time status of this monitor. The ACVAL bit stays low when the input clock is not toggling or its frequency is grossly too high; ACVAL flickers (i.e. rapidly changes states) when the input clock is toggling but its frequency is grossly too low.

Frequency monitoring is handled by either a percent frequency monitor (1% to 20% in 1% steps) or a ppm frequency monitor (1ppm to 500ppm in 1ppm steps) or a combination of both depending on the level of accuracy required. As with any frequency measurement, there is a tradeoff between accuracy and measurement time. Higher accuracy ppm monitoring requires longer measurement time (from tens of milliseconds to seconds) while lower accuracy percent monitoring can complete a measurement in as little as 10 µs. Register bits ICxSR.PCVAL and ICxSR.PPVAL indicate the real-time status of the percent and ppm monitors, respectively.

Any input clock that fails activity monitoring or frequency monitoring is declared invalid. The valid/invalid state of each input clock is reported in the corresponding real-time status bit in the VALSR registers. When the valid/invalid state of a clock changes, the corresponding latched status bit is set in the VALSR registers. Input clocks manually marked invalid in the DPLL's VALCR1 register cannot be automatically selected as the reference for the DPLL.

The activity, percent and ppm monitors can be enabled and disabled using the ACEN, PCEN and PPEN bits, respectively in the MONxCR2 register.

In addition to the monitors in the input block, the DPLL can also invalidate an input. If the input is the DPLL's selected reference and the DPLL cannot lock within the time specified by the PHLKTO register, the DPLL invalidates the input by setting the ICxSR.LKTO bit.

**Note 1:** For rev A parts only, when ACEN=PCEN=PPEN=0 for an input (which is the power-on default state of the device), that input is declared <u>valid</u> by the input monitoring logic, even when the input receiver is disabled by setting ICEN.ICxEN=0. To avoid this, set at least one of ACEN, PCEN and PPEN bits to 1.

**Note 2:** The percent monitor cannot be used with a 1kHz input clock and has a narrower range of settings for input frequencies below 2kHz. See the evaluation software for the exact range of settings available for a particular device configuration.

**Note 3:** The ppm monitor reject threshold must be  $\geq$ 3ppm higher than the accept threshold.

#### 5.6.2.1 External Monitoring

Some clock signals come from external components that can monitor the quality of a clock signal or the quality of a signal from which the clock signal is derived. One example is a BITS receiver in telecom equipment. This component receives a DS1, E1 or 2048kHz synchronization signal and recovers a clock from that signal. The BITS receiver monitors the incoming signal and can declare loss of signal (LOS), loss of frame alignment (LOF) and other defects in the incoming signal. Another example is a Synchronous Ethernet PHY, which receives an Ethernet signal and recovers a clock from that signal. This PHY can declare loss of lock, loss of codeword alignment and other defects.

When a neighboring component can detect that the incoming signal or the clock recovered from the signal is somehow out of specification, a loss-of-signal indication from that component can be connected to a GPIO pin on



the device to instantly invalidate the input clock. Any GPIO pin can be used as a loss-of-signal indicator for any of the IC1, IC2 or IC3 input clocks. ICxSR.LOS indicates the real-time LOS status from the GPIO pin.

**Example**: Configure GPIO1 to be the active-low LOS signal for IC1:

GPIOCR1.GPIO1C=0001(Configure GPIO1 to be an input with inversion)MON1CR2.LOSSS=010(Configure the IC1 monitor's LOS source to be GPIO1)

#### 5.6.2.2 Monitor Priority and Validation Timer

All enabled input monitors must declare an input valid for a configurable duration (which can be zero) before the input clock is validated and considered eligible for selection as the DPLL's selected reference. The monitors have a priority hierarchy in which an invalid declaration by a higher-priority monitor forces an invalid declaration in all lower-priority monitors. When a valid higher-priority monitor declares the input valid, the next lower priority monitor can then initiate its validation process. The monitor hierarchy is as follows:

- Input LOS from a GPIO pin forces all other monitors (activity and frequency) to declare the input invalid.
- When the activity monitor declares invalid, it forces the frequency monitors to declare invalid.

When a monitor is not enabled, it continually declares the input clock valid.

After all monitors declare an input clock valid (ICxSR.VAL=1) the validation timer requires all the monitors to continue to indicate the clock is valid for a configurable validation time before the input is declared valid for use as a DPLL input (ICxSR.VALT=1).

#### 5.6.2.3 Input Monitor Configuration

The device's input monitors are very sophisticated, but the configuration registers for these monitors are, generally speaking, low-level coefficients rather than user concepts such as ppm. As a result most input monitor registers are not documented in this data sheet. Instead, Microsemi provides evaluation software that gives the user a simple, intuitive graphical user interface in which to generate complete device configurations, including all aspects of input monitor behavior. Configuration files from the evaluation software can be stored in device EEPROM to allow the device to self-configure at reset. Alternately, system software can perform the register writes listed in the configuration files as needed to configure/reconfigure the device.

#### 5.6.3 Input Clock Priority, Selection and Switching for the DPLL

#### 5.6.3.1 Priority Configuration

During normal operation, the selected reference for the DPLL is chosen automatically based on the priority rankings assigned to the input clocks in the input priority registers (IPR1 and IPR2). The default input clock priorities are shown in Table 3.

Any unused input clock should be given the priority value 0, which disables the clock and marks it as unavailable for selection. Priority 1 is highest.

#### Table 3 - Default Input Clock Priorities

| INPUT CLOCK | DPLL<br>DEFAULT<br>PRIORITY |
|-------------|-----------------------------|
| IC1         | 1                           |
| IC2         | 2                           |
| IC3         | 3                           |

#### 5.6.3.2 Automatic Selection

When ICSCR1.EXTSW=0, automatic input clock reference selection is used for the DPLL. The input reference selection algorithm chooses the <u>highest-priority valid input clock</u> to be the selected reference. The real-time valid/invalid state of each input clock is maintained in the VALSR registers (see section 5.6.2). The priority of each



input clock is set as described in section 5.6.3.1. To select the DPLL input clock based on these criteria, the selection algorithm maintains a priority table of valid inputs. The top entry in this priority table and the selected reference are indicated in the PTAB1 register. The second- and third-priority inputs are indicated in the PTAB2 register.

If two or more input clocks are given the same priority number then those inputs are prioritized among themselves using a fixed circular list. If one equal-priority clock is the selected reference but becomes invalid then the next equal-priority clock in the list becomes the selected reference. If an equal-priority clock that is not the selected reference becomes invalid, it is simply skipped over in the circular list. The selection among equal-priority inputs is inherently nonrevertive, and revertive switching mode (see next paragraph) has no effect in the case where multiple equal-priority inputs have the highest priority.

An important input to the selection algorithm is the REVERT bit in the ICSCR1 register. In revertive mode (REVERT=1), if an input clock with a higher priority than the selected reference becomes valid, the higher priority reference immediately becomes the selected reference. In nonrevertive mode (REVERT=0), the higher priority reference does not immediately become the selected reference but does become the highest priority reference in the priority table (PTAB1.REF1). (The selection algorithm always switches to the highest-priority valid input when the selected reference goes invalid, regardless of the state of the REVERT bit.) For many applications, nonrevertive mode is preferred because it minimizes disturbances on the output clocks due to reference switching.

In nonrevertive mode, planned switchover to a newly-valid higher priority input clock can be done manually under software control. The validation of the new higher priority clock sets the corresponding latched status bit in the VALSR registers, which can drive an interrupt request if needed. System software can then respond to this change of state by briefly enabling revertive mode (toggling REVERT high then back low) to force the switchover to the higher priority clock.

#### 5.6.3.3 Manual Selection

The bits of the VALCR1 register can be used to perform manual selection of an input clock. When all input clocks have non-zero priorities in the IPR registers, an input clock can be manually selected by setting the VALCR1 bit for that input clock to 1 and the VALCR1 bits for the other input clocks to 0.

#### 5.6.3.4 External Reference Switching Mode

In this mode a GPIO pin controls reference switching between two input clocks. This mode is enabled by setting the ICSCR1.EXTSW=1. In this mode, if the GPIO pin is high, the DPLL is forced to lock to input IC1 (if the priority of IC1 is nonzero in IPR1) or IC3 (if the priority of IC1 is zero) whether or not the selected input has a valid reference signal. If the GPIO pin is low the DPLL is forced to lock to input IC2 whether or not IC2 has a valid reference signal. The GPIO pin is selected by MCR2.EXTSS.

In external reference switching mode the input selector logic behaves as a simple 2:1 mux, and the DPLL is forced to try to lock to the selected reference whether it is valid or not. This mode controls the PTAB1.SELREF field directly and, therefore, is not affected by the state of the ICSCR1.REVERT bit. During external reference switching mode, only PTAB1.SELREF is affected; the PTAB1.REF1 field continues to indicate the highest-priority valid input chosen by the automatic selection logic. The priorities of IC1, IC2 and IC3 in the IPR registers must be non-zero for proper behavior in external reference switching mode.

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#### 5.7 DPLL Architecture and Configuration

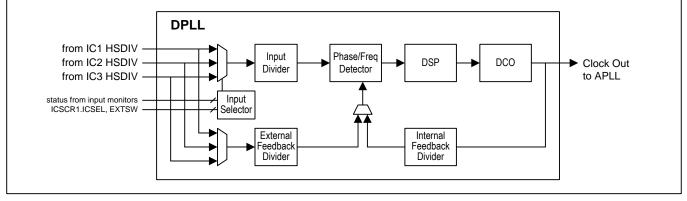


Figure 10 - DPLL Block Diagram

Digital PLLs have two key benefits: (1) stable, repeatable performance that is insensitive to process variations, temperature, and voltage; and (2) flexible behavior that is easily configured and reprogrammed. DPLLs use a digitally controlled oscillator (DCO) to generate the DPLL output clock. The DPLL output clock is then provided to an APLL for clock multiplication/frequency conversion.

The DPLL in the device is configurable for many PLL parameters including bandwidth, input frequency, pull-in/holdin range, input-to-output phase offset, hitless switching, and more. No knowledge of loop equations or gain parameters is required to configure and operate the device. No external components are required for the DPLL except a local oscillator connected to the XA pin to provide the DPLL's master clock (see section 5.2.2).

# 5.7.1 DPLL Configuration

The device's DPLL is very sophisticated, but the configuration registers for the DPLL are, generally speaking, very low-level coefficients rather than user concepts such as bandwidth and pull-in range. As a result most DPLL registers are not documented in this data sheet. Instead, Microsemi provides evaluation software that gives the user a simple, intuitive graphical user interface in which to generate complete device configurations, including all aspects of DPLL behavior. Configuration files from the evaluation software can be stored in device EEPROM to allow the device to self-configure at reset. Alternately, system software can perform the register writes listed in the configuration files as needed to configure/reconfigure the device. The most frequently used DPLL status register fields and real-time control register fields are documented in section 6.3.6 and discussed in the DPLL sections below.

# 5.7.2 DPLL States

**Tracking (Locked and Unlocked).** When a valid input clock is available, the DPLL is in the tracking state (DSRR1.TRK=1) and is either locked to an input clock (DSRR1.LOL=0) or unlocked (DSRR1.LOL=1). While locked to an input clock the DPLL can be configured to average its fractional frequency offset over time to calculate a holdover average.

**Freerun/Holdover.** When all input clocks become invalid, the DPLL enters the freerun/holdover state (DSRR1. TRK=0) in which it operates open-loop. In this mode the DPLL can be in freeun (DSRR1.HO=0) in which its output frequency has the same fractional frequency offset as the master clock signal. Or the DPLL can be in holdover (DSRR1.HO=1) in which the output frequency has the average fractional frequency offset calculated previously when the DPLL was locked to an input clock. The DPLL can automatically transition from the freerun/holdover state to the tracking state when an input clock is declared valid. The holdover average can be retained or cleared when the DPLL switches input clocks. The DPLLCR1.HOMODE field controls DPLL freerun/holdover behavior.

System software can manually force the DPLL into the freerun/holdover state as needed using the DPLLCR1.MODE field.



#### 5.7.3 DPLL Capabilities

**Bandwidth.** The DPLL can be configured for any bandwidth from 1Hz to 500Hz. The DPLL can easily be configured for a damping factor that ensures gain peaking near the DPLL's corner frequency is minimized.

**Pull-In/Hold-In Range.** The DPLL tracking range is configurable from  $\pm 1$ ppm to  $\pm 1000$ ppm. The DPLL reports when it has reached the limit of the range in the DSRR2.FLIM register bit. The DPLL's hold-in range is the same as its tracking range. The DPLL's pull-in range should be considered to be half the size of the tracking range for reasonable pull-in time. For example, when tracking range is  $\pm 1000$ ppm, pull-in range should be considered to be  $\pm 500$ ppm. Note that the ppm input monitor's accept threshold determines the pull-in range when the accept threshold is lower than the DPLL tracking range, and the monitor's reject threshold determines the hold-in range when the reject threshold is lower than the DPLL tracking range.

**Programmable Lock Criteria.** The DPLL has configurable criteria for defining when it declares lock. In addition to phase, the DPLL can also be configured to declare loss of lock when its fractional frequency offset exceeds the the DPLL's tracking range.

**Programmable Phase Lock Timeout.** When the DPLL fails to lock to the selected input clock within the timeout duration specified by the PHLKTO register, the input is declared invalid by the input block, which sets the ICxSR.LKTO bit.

**Frequency and Phase Reporting.** The DPLL reports in real-time its frequency (i.e. fractional frequency offet in ppb/ppm vs. its nominal frequency) and its phase vs. the input clock signal. DPLL frequency resolution is better than 0.005ppb. DPLL frequency offset is reported in the DFREQ registers. DPLL phase is reported in the DPHASE registers.

**Phase-Slope Limiting (PSL).** In the tracking state the DPLL can limit its phase rate-of-change to ensure that consumers of the device's output clocks can follow the phase change. The DPLL can be configured for a wide range of phase-slope limits. See the evaluation software for details. The DPLL reports when it is currently limiting its phase rate-of-change in the DSRR2.PSLIM register bit. Note that PSL can affect pull-in time and ability to pull in and must be used with care. Contact Microsemi for assistance. In general PSL in ns/sec should be  $\geq$  10x the DPLL bandwidth in Hz. Also, DPLL pull-in range in ppm is limited to the PSL value expressed in µs/sec.

**Frequency Rate-of-Change Limiting.** In the tracking state the DPLL can limit its frequency rate-of-change to any limit from 1ppb/s to 100ppm/s. One such limit is used while the DPLL is in the tracking state. Another limit can be used when the DPLL transitions to the freerun/holdover state. The DPLL reports when it is currently limiting its frequency rate-of-change in the DSRR2.FCHLIM register bit.

**Absolute Phase Locking and Relative Phase Locking.** The DPLL has two modes of tracking an input reference clock: absolute phase locking and relative phase locking. In absolute phase locking the DPLL's tracking goal is the absolute difference between input and feedback clocks specified by a DPLL parameter. Often this parameter (DPHOFF) is set to have the DPLL lock with zero phase difference. Using a non-zero value enables DPLL input-to-output phase adjustment.

In relative phase locking whenever a new input clock is selected, the DPLL measures the difference between input phase and feedback phase and sets that value as the tracking goal. Relative phase locking supports hitless switching. The difference between input phase and feedback phase is averaged for a programmable duration to determine the tracking goal.

**Hitless Switching.** The DPLL can perform truly hitless switching (max 200ps output phase change) between two input clocks that (1) have been divided by the input dividers to the same nominal PFD frequency, and (2) have the same fractional frequency offset (i.e. they are traceable to the same reference). The two input clocks can have any arbitrary phase relationship and can be any frequency in the PFD input frequency range (as long as the two are the same frequency). Note: when DPLL PFD input frequency is  $\leq 16$ kHz, output phase change can be up to 1ns with low-jitter/wander input clocks and could be somewhat higher with high-jitter/wander input clocks. Hitless switching is enabled/disabled by DPLLCR2.HSEN.



**Holdover Averaging.** The holdover averaging calculation has a programmable averaging window and a programmable throw-away window. The throw-away window specifies an interval of time, just prior to the DPLL entering holdover, that is not included in the average. When an input clock is invalidated by the input monitor for frequency error, the throw-away window allows the DPLL to exclude the worst of the frequency excursion from the holdover average.

**Numerically Controlled Oscillator (NCO) Mode.** In this mode most of the DPLL is shut down and system software controls the DPLL's output frequency using the 40-bit FREQZ field in the the DFREQZ registers. The resolution of frequency control is better than 0.01ppb. See section 5.7.7 for more details.

#### 5.7.4 Input Wander and Jitter Tolerance

Wander is tolerated up to the point where wander causes an apparent long-term frequency offset larger than the frequency threshold set in the input monitor. In such a situation the input clock would be declared invalid. Jitter can be tolerated up to the point of eye closure. The high-jitter input clock signal should be divided down to a lower frequency by the DPLL's input divider for high jitter tolerance.

#### 5.7.5 Jitter and Wander Transfer

The transfer of jitter and wander from the selected reference to the output clocks has a programmable transfer function that is determined by the DPLL bandwidth. The 3dB corner frequency of the jitter transfer function can be set to any value from 1Hz to 500Hz.

During locked mode, the transfer of wander from the local oscillator clock (connected to the XA pin) to the output clocks is not significant as long as the DPLL bandwidth is set high enough to allow the DPLL to quickly compensate for oscillator frequency changes. During freerun/holdover, local oscillator wander has a much more significant effect. See section 5.4.1.

#### 5.7.6 Output Jitter and Wander

Several factors contribute to jitter and wander on the output clocks, including:

- Jitter and wander amplitude on the selected reference (while in the locked state)
- The jitter/wander transfer characteristic of the device (while in the locked state)
- The jitter and wander on the local oscillator clock signal (especially wander while in the holdover state)

The DPLL has programmable bandwidth (see Section 5.7.3). With respect to jitter and wander, the DPLL behaves as a low-pass filter with a programmable pole. The bandwidth of the DPLL is normally set low enough to strongly attenuate jitter. The wander and jitter attenuation depends on the DPLL bandwidth chosen.

#### 5.7.7 Numerically Controlled Oscillator (NCO) Mode

In this mode of operation most of the DPLL is shut down, and system software controls the DPLL's output frequency using the 40-bit FREQZ field in the the DFREQZ registers. The resolution of frequency control is better than 0.01ppb.

The nominal FREQZ value, hereafter referred to as FREQZ0, is computed by the evaluation software for the desired device configuration When the FREQZ field is set to the FREQZ0 value, the device's output clock frequencies have a fractional frequency offset of zero with respect to the NCO master clock signal applied to the XA pin.

(Fractional frequency offset (FFO) is defined as (actual\_frequency – nominal\_frequency) / nominal\_frequency. FFO is a unitless number but is typically expressed in parts per billion (ppb), parts per million (ppm) or percent.)

To control the NCO, system software first reads the FREQZ0 value from the device. FREQZ0 is a 40-bit unsigned integer.

To change the NCO frequency to a specific FFO (in ppm), system software calculates newFREQZ (a 40-bit unsigned integer) as follows:

newFREQZ = round(FREQZ0 \* (1 + FFO/1e6))

System software then writes the newFREQZ value directly to the FREQZ field in the DFREQZ registers.

Note that any subsequent frequency changes are calculated using the same equation from the original FREQZ0 value and are <u>not</u> a function of the previous newFREQZ value. The value of newFREQZ should be kept within  $\pm$ 1000ppm of FREQZ0 and within  $\pm$ 500ppm of the previous newFREQZ value to avoid causing the APLL to lose lock.

# 5.8 APLL Configuration

#### 5.8.1 APLL Input Selection and Frequency

#### 5.8.1.1 APLL-Only Mode

In APLL-Only mode (APLLCR3.APLLMUX=0xx) the APLL can lock to any of inputs IC1 through IC3, a clock signal on XA or the crystal driver circuit (optionally clock-doubled) when a crystal is connected to XA and XB. See section 5.2.1 for details and diagrams.

The input to the APLL can be controlled by a GPIO pin or by the APLLCR3.APLLMUX register field. When APLLCR3.EXTSW=0, the APLLCR3.APLLMUX register field controls the APLL input mux.

When APLLCR3.EXTSW=1, a GPIO pin controls the APLL input mux. When the GPIO pin is low, the mux selects the input specified by APLLCR3.APLLMUX. When the GPIO pin is high, the mux selects the input specified by APLLCR3.ALTMUX. MCR2.EXTSS specifies which GPIO pin controls this behavior.

In APLL-only mode, the frequencies of all enabled input clocks (ICx and XA) must divide to a common APLL phase-frequency detector (PFD) frequency from 9.72MHz to 156.25MHz. In this mode the input high-speed dividers (ICxCR1.HSDIV) can be used to divide the ICx frequencies by 1, 2, 4 or 8. The XA pin does not have an internal divider, and, therefore, if XA is an enabled input clock then the XA frequency sets the APLL common PFD frequency. The polarity of an ICx input signal can be inverted by setting ICxCR1.POL.

#### 5.8.1.2 DPLL+APLL Mode

In DPLL+APLL mode (APLLCR3.APLLMUX=11x) the APLL locks to the DPLL output clock signal. Fractional multiplication in the APLL is used to generate the proper output clock frequency.

#### APLL APLLCR2.HSDIV1[3:0] Phase/ VCO Clock to Clock from APLL Loop High-Speed Freq Output 3.715-4.18 Input Muxes Filter Divider 1 Detector Dividers GHz (whole ÷ 4-15. half ÷ 4.5-7.5) Feedback Clock to High-Speed Divider Output Divider 2 Input Frequency Range: (fractional) Dividers 9.72MHz to 156.25MHz AFBDIV[74:0], AFBREM, APLLCR2.HSDIV2[3:0] AFBDEN, AFBBF

# 5.8.2 APLL Output Frequency





The APLL is enabled when PLLEN.APLLEN=1. The APLL has a fractional-N architecture and therefore can produce output frequencies that are either integer or non-integer multiples of the input clock frequency. Figure 11 shows a block diagram of the APLL, which is built around an ultra-low-jitter multi-GHz VCO. Register fields AFBDIV, AFBREM, AFBDEN and AFBBP configure the frequency multiplication ratio of the APLL. The APLLCR2.HSDIV1 and HSDIV2 fields specify how the VCO frequency is divided down by the high-speed dividers. Dividing by six is the typical setting to produce 622.08MHz for SDH/SONET or 625MHz for Ethernet applications.

Internally, the exact APLL feedback divider value is expressed in the form AFBDIV + AFBREM / AFBDEN \*  $2^{-(33-AFBBP)}$ . This feedback divider value must be chosen such that APLL\_input\_frequency \* feedback\_divider\_value is in the operating range of the VCO (as specified in Table 13). The AFBDIV term is a fixed-point number with 9 integer bits in APLL-only mode (7 integer bits in DPLL+APLL mode) and a configurable number of fractional bits (up to 33, as specified by AFBBP). Typically AFBBP is set to 9 to specify that AFBDIV has 33 - 9 = 24 fractional bits. Using more than 24 fractional bits does not yield a detectable benefit. Using less than 12 fractional bits is not recommended.

The following equations show how to calculate the feedback divider values for the situation where the APLL should multiply the APLL input frequency by integer M and also fractionally scale by the ratio of integers N / D. In other words, VCO\_frequency = input\_frequency \* M \* N / D. An example of this is multiplying 77.76MHz from the DPLL by M=48 and scaling by N / D = 255 / 237 for forward error correction applications.

| $AFBDIV = trunc(M * N / D * 2^{24})$         | (1) |
|--|-----|
| $lsb_fraction = M * N / D * 2^{24} - AFBDIV$ | (2) |
| AFBDEN = D                                   | (3) |
| AFBREM = round(lsb_fraction * AFBDEN)        | (4) |
| AFBBP = 33 – 24 = 9                          | (5) |

The trunc() function returns only the integer portion of the number. The round() function rounds the number to the nearest integer. In Equation (1), AFBDIV is set to the full-precision feedback divider value, M \* N / D, truncated after the 24<sup>th</sup> fractional bit. In Equation (2) the temporary variable 'lsb\_fraction' is the fraction that was truncated in Equation (1) and therefore is not represented in the AFBDIV value. In Equation (3), AFBDEN is set to the denominator of the original M \* N / D ratio. In Equation (4), AFBREM is calculated as the integer numerator of a fraction (with denominator AFBDEN) that equals the 'lsb\_fraction' temporary variable. Finally, in Equation (5) AFBBP is set to 33 – 24 = 9 to correspond with AFBDIV having 24 fractional bits.

When a fractional scaling scenario involves multiplying an integer M times multiple scaling ratios  $N_1 / D_1$  through  $N_n / D_n$ , the equations above can still be used if the numerators are multiplied together to get  $N = N_1 \times N_2 \times ... \times N_n$  and the denominators are multiplied together to get  $D = D_1 \times D_2 \times ... \times D_n$ .

The easiest way to calculate the exact values to write to the APLL registers is to use the ZL30151 evaluation software, available on the Microsemi website. This software can be used even when no evaluation board is attached to the computer.

Note: After the APLL's feedback divider settings are configured in register fields AFBDIV, AFBREM, AFBDEN and AFBBP, the APLL enable bit PLLEN.APLLEN should be changed from 0 to 1 to cause the APLL to reacquire lock with the new settings. The real-time lock/unlock status of the APLL is indicated by APLLSR.ALK and ALK2.

#### 5.8.3 APLL Phase Adjustment

The phase of the APLL's output clock can be incremented or decremented by 1/8<sup>th</sup> of a VCO cycle. This phase step size is 30ps at maximum VCO frequency of 4180MHz and 33.7ps at minimum VCO frequency of 3715MHz. The APLLCR4.PDSS field specifies the phase decrement control signal, which can be the APLLCR4.DECPH bit or



any of the four GPIOs. The APLLCR4.PISS field specifies the phase increment control signal, which can be the APLLCR4.INCPH bit or any of the four GPIOs. Phase is adjusted on every rising edge and every falling edge of the control signal. This phase adjustment affects the output of both high-speed dividers.

## 5.9 Output Clock Configuration

The device has three output clock signal pairs. Each output has individual divider, enable and signal format controls. In CMOS mode each signal pair can become two CMOS outputs, allowing the device to have up to six output clock signals. Also in CMOS mode, the OCxN pin can have an additional divider allowing the OCxN frequency to be an integer divisor of the OCxP frequency (example: OC3P 125MHz and OC3N 25MHz). The outputs can be aligned relative to each other and relative to an input signal, and the phases of output signals can be adjusted dynamically with high resolution and infinite range.

## 5.9.1 Output Enable, Signal Format, Voltage and Interfacing

To use an output, the output driver must be enabled by setting  $OCxCR2.OCSF \neq 0$ , and the per-output dividers must be enabled by setting the appropriate bit in the OCEN register. The per-output dividers include the medium-speed divider, the low-speed divider and the associated phase adjustment/alignment circuitry and start/stop logic.

Using the OCxCR2.OCSF register field, each output pair can be disabled or configured as a CML output, an HSTL output, or one or two CMOS outputs. When an output is disabled it is high impedance, and the output driver is in a low-power state. In CMOS mode, the OCxN pin can be disabled, in phase or inverted vs. the OCxP pin. In CML mode the normal 800mV  $V_{OD}$  differential voltage is available as well as a half-swing 400mV  $V_{OD}$ . All of these options are specified by OCxCR2.OCSF. The clock to the output driver can inverted by setting OCxCR2.POL=1. The CMOS/HSTL output driver can be set to any of four drive strengths using OCxCR2.DRIVE.

Each output has its own power supply pin to allow CMOS or HSTL signal swing from 1.5V to 3.3V for glueless interfacing to neighboring components. If OCSF is set to HSTL mode then a 1.5V power supply voltage should be used to get a standards-compliant HSTL output. Note that differential (CML) outputs must have a power supply of 3.3V.

The differential outputs can be easily interfaced to LVDS, LVPECL, CML, HCSL, HSTL and other differential inputs on neighboring ICs using a few external passive components. See Figure 23 for examples.

# 5.9.2 Output Frequency Configuration

The frequency of each output is determined by the configuration of the APLL, the high-speed dividers and the peroutput dividers. Each output can be connected to either high-speed divider 1 (HSDIV1) or 2 (HSDIV2) using the OCxCR3.DIVSEL field.

Each output has two output dividers, a 7-bit medium-speed divider (OCxCR1.MSDIV) and a 25-bit low-speed output divider (LSDIV field in the OCxDIV registers). These dividers are in series, medium-speed divider first then output divider. These dividers produce signals with 50% duty cycle for all divider values including odd numbers. The low-speed divider can only be used if the medium-speed divider is used (i.e. OCxCR1.MSDIV>0). The maximum input frequency to the medium-speed divider is 850MHz. The maximum input frequency to the low-speed divider is 425MHz.

Since each output has its own independent dividers, the device can output families of related frequencies that have an APLL HSDIV output frequency as a common multiple. For example, for Ethernet clocks, a 625MHz HSDIV output clock can be divided by four for one output to get 156.25MHz, divided by five for another output to get 125MHz, and divided by 25 for another output to get 25MHz. Similarly, for SDH/SONET clocks, a 622.08MHz HSDIV output clock can be divided by 4 to get 155.52MHz, by 8 to get 77.76MHz, by 16 to get 38.88MHz or by 32 to get 19.44MHz.

#### Two Different Frequencies in 2xCMOS Mode

When an output is in 2xCMOS mode it can be configured to have the frequency of the OCxN clock be an integer divisor of the frequency of the OCxP clock. Examples of where this can be useful:

- 125MHz on OCxP and 25MHz on OCxN for Ethernet applications
- 77.76MHz on OCxP and 19.44MHz on OCxN for SONET/SDH applications
- 25MHz on OCxP and 1Hz (i.e. 1PPS) on OCxN for telecom applications with Synchronous Ethernet and IEEE1588 timing

An output can be configured to operate like this by setting the LSDIV value in the OCxDIV registers to OCxP\_freq / OCxN\_freq - 1 and setting OCxCR3.LSSEL=0 and OCxCR3.NEGLSD=1. Here are some notest about this dual-frequency configuration option:

- In this mode only the medium speed divider is used to create the OCxP frequency. The lowspeed divider is then used to divide the OCxP frequency down to the OCxN frequency. This means that the lowest OCxP frequency is the high-speed divider output frequency divided by 128.
- An additional constraint is that the medium-speed divider must be configured to divide by 6 or more (i.e. must have OCxCR1.MSDIV≥5).

#### 5.9.3 Output Duty Cycle Adjustment

For output frequencies less than or equal to 141.666MHz, the duty cycle of the output clock can be modified using the OCxDC.OCDC register field. This behavior is only available when MSDIV>0 and LSDIV > 1. When OCDC = 0 the output clock is 50%. Otherwise the clock signal is a pulse with a width of OCDC number of MSDIV output clock periods. The range of OCDC can create pulse widths of 1 to 255 MSDIV output clock periods. When OCxCR2.POL=0, the pulse is high and the signal is low the remainder of the cycle. When POL=1, the pulse is low and the signal is high the remainder of the cycle.

Note that duty cycle adjustment is done in the low-speed divider. Therefore when OCxCR3.LSSEL=0 the duty cycle of the output is not affected. Also, when a CMOS output is configured with OCxCR3.LSSEL=0 and OCxCR3.NEGLSD=1, the OCxN pin has duty cycle adjustment but the OCxP pin does not. This allows a higher-speed 50% duty cycle clock signal to be output on the OCxP pin and a lower-speed frame/phase/time pulse (e.g. 2kHz, 8kHz or 1PPS) to be output on the OCxN pin at the same time.

An output configured for CMOS or HSTL signal format should not be configured to have a duty cycle with high time shorter than 2ns or low time shorter than 2ns.

#### 5.9.4 Output Phase Adjustment and Phase Alignment

The device has flexible, high-resolution tools for managing the phases of the output clocks relative to one another. The key register fields for this are found in the PACR1 and PACR2 global configuration registers and the per-output OCxPH register.

Phase alignment and phase adjustment are done in the medium-speed dividers. Resoution is 0.5 periods (also known as unit intervals or UI) of the high-speed divider (HSDIV) output clock. For example, for an HSDIV output frequency of 800MHz, resolution is 625ps.

#### 5.9.4.1 Phase Adjustment

A phase adjustment is a phase change for an output relative to that output's most recent phase. To cause the device to perform phase adjustment of an output clock, set PACR1.MODE=1, set OCxCR1.PHEN=1 to enable the output for phase adjustment, and write the phase adjustment amount to the output's OCxPH register. Then an arm/trigger methodology is used to cause the phase adjustment to happen.

The arm step tells the device that it is enabled to perform the phase adjustment when it sees the trigger stimulus. The source of the arm signal is specified by PACR2.ARMSRC. Options include the 0-to-1 transition of the PACR1.ARM bit, APLL transition from unlocked to locked, DPLL transition from unlocked to locked, or a transition on one of the GPIO pins.



The source of the trigger signal is specified by PACR2.TRGSRC. Options include 0-to-1 transition of the PACR1.TRIG bit, APLL transition from unlocked to locked, DPLL transition from unlocked to locked, a rising edge of the DPLL input clock, or a transition on one of the GPIO pins. The trigger signal can be inverted by setting PACR1.TINV. With TINV=1, the same GPIO signal can arm on one edge and trigger on the opposite edge.

Any combination of outputs can be phase adjusted by the same trigger, and each output can be adjusted by a different amount. Only outputs with OCxCR1.PHEN=1 and OCxPH.PHADJ $\neq$ 0 have their phases adjusted.

There are a few constraints on the range of possible phase adjustments. These have to do with the output's medium-speed divider value.

- 1) Phase adjustment is not available unless OCxCR1.MSDIV>0.
- The largest negative phase adjustment magnitude in HSDIV periods is: If OCxCR1.MSDIV is odd: (OCxCR1.MSDIV – 1) / 2 If OCxCR1.MSDIV is even: (OCxCR1.MSDIV – 2) / 2
- The largest positive phase adjustment in HSDIV periods is: If OCxCR1.MSDIV is odd: (127 – OCxCR1.MSDIV) / 2 If OCxCR1.MSDIV is even: (128 – OCxCR1.MSDIV) / 2

The implications of constraints 2) and 3) are shown in this table:

| OCxCR1.MSDIV | Largest Negative<br>Phase Adjust,<br>HSDIV periods | Largest Positive<br>Phase Adjust,<br>HSDIV periods | Notes                  |
|--------------|--|--|------------------------|
| 1 or 2       | 0  | 63   | no negative adjustment |
| 3 or 4       | 1  | 62   |                        |
| 5 or 6       | 2  | 61   |                        |
|              |  |  |                        |
| 123 or 124   | 61   | 2  |                        |
| 125 or 126   | 62   | 1  |                        |
| 127          | 63   | 0  | no positive adjustment |

During a phase adjustment the MSDIV output period is changed for one period. The MSDIV output signal during that period will have longer high time (unless inverted) during a positive phase adjustment and shorter high time (unless inverted) during a negative phase adjustment. With negative phase adjustments care must be taken to not shorten the high time of the output clock signal to be too short for the components that receive the clock. There are several possible ways to avoid this issue including: (1) using small negative adjustments such as -0.5UI repeatedly instead of one larger negative adjustment, (2) using positive adjustments to "wrap around" to the desired negative adjustment, or (3) holding the components that receive the clock in reset during the phase adjustment.

An armed phase adjustment can be canceled before the trigger occurs by setting the PACR1.RST bit.

The PASR register has real-time status bits indicating whether a phase adjustment is armed and waiting for a trigger (ARMED bit) or in progress (BUSY bit). It also has a latched status bit (ADJL bit) to indicate the adjustment has completed.

Example: +1.0 HSDIV period phase adjustment for output OC1 using ARM and TRIG register bits:

| OC1CR1.PHEN=1                         | (Enable phase adjust on OC1)                                   |  |
|---------------------------------------|--|--|
| OC1PH.PHADJ=00000010                  | (Specify +1.0 HSDIV period phase adjustment)                   |  |
| PACR1.MODE=1                          | (Phase adjustment mode)  |  |
| PACR2.ARMSRC=0001                     | (arm signal is PACR1.ARM bit)                                  |  |
| PACR2.TRGSRC=0000                     | (trigger signal is PACR1.TRIG bit)                             |  |
| PACR1.RST=1                           | (reset phase adjust/align state machine after changing ARMSRC) |  |
| PACR1.ARM=1                           | (arm for phase adjust)   |  |
| PACR1.TRIG=1                          | (do the phase adjust: add +1.0 UI to output phase)             |  |
| repeat the next two writes as needed: |  |  |



PACR1.ARM=1 .TRIG=0(arm again; clearing the TRIG bit is required when MSDIV period < master<br/>clock period because TRIG is not self-clearing in this situation)<br/>(add +1.0 UI to output phase again)

#### 5.9.4.2 Phase Alignment, Output-to-Output

A phase alignment is a special case of phase adjustment where the MSDIV and LSDIV dividers for all participating outputs are reset just before the phase adjustment occurs. For output-to-output alignment the trigger can be the PACR1.TRIG bit or the APLL or DPLL lock signals.

To avoid glitches (i.e. "runt pulses") on the output clock it is possible to manually stop the output(s) before triggering the phase alignment and then restart the output(s) after the alignment (See section 5.9.5).

When aligning outputs, it is important to note that, by default, the phase of outputs configured as HSTL format or "two CMOS, OCxP inverted vs. OCxN" format is opposite that of CML outputs. For example, consider the case where OC1 is 100MHz CML format and OC2 is 100MHz HSTL format. When OC1 and OC2 are aligned then OC2N is high when OC1P is high. The polarity bit OCxCR2.POL can be used to change this as needed.

There are several rules when alignment is enabled for multiple outputs:

- All participating outputs must come from the same high-speed divider
- All outputs that use both medium-speed and low-speed divider must have the same MSDIV value, the same LSDIV value and PHADJ=0. Subsequent phase adjustment(s) can be used to move the output(s) to other phase(s).
- All outputs that only use medium-speed divider can have PHADJ values smaller than the period of the highest output frequency among them.
- When some outputs use only medium-speed divider and other outputs use both medium-speed and lowspeed divider, all MSDIV values must be the same, and those output using low-speed divider must have PHADJ=0.

Contact Microsemi Timing Applications Support for help with alignment scenarios that don't meet the rules listed above.

**Example:** OC1-to-OC2 alignment (+3.5 HSDIV UI offset) after the APLL locks:

| OC1CR1.PHEN=1                | (Enable phase adjust on OC1)   |
|------------------------------|--|
| OC2CR1.PHEN=1                | (Enable phase adjust on OC2)   |
| OC1PH.PHADJ=00000000         | (0.0UI)  |
| OC2PH.PHADJ=00000111         | (+3.5UI)   |
| PACR1.MODE=0                 | (Phase alignment mode)   |
| PACR2.ARMSRC=0001            | (arm signal is PACR1.ARM bit)  |
| PACR2.TRGSRC=0001            | (trigger signal is APLL transition from unlocked to locked)            |
| PACR1.RST=1                  | (reset phase adjust/align state machine after changing ARMSRC, TRGSRC) |
| PACR1.ARM=1                  | (arm for phase alignment)  |
| (Aligns/realigns outputs whe | en the APLL locks or relocks)  |

#### 5.9.4.3 Phase Alignment, Input-to-Output

The phase alignment tool described in section 5.9.4.2 can use a GPIO pin as the alignment trigger. However there is some uncertainty associated with sampling the GPIO signal. Therefore the phase alignment tool *by itself* is is not sufficient to achieve input-to-output phase alignment.

#### 5.9.4.3.1 Automatic with External Feedback

To align output signals to an input signal, the best approach is to use external feedback in which an OCx output is externally connected to an ICx input. To enable external feedback, set ICSCR1.FBSEL to specify the ICx input to use for external feedback and disable DPLL hitless switching. In this configuration the DPLL, in a closed-loop manner, automatically phase-aligns OCx outputs to the DPLL's selected reference. Any small error in this



alignment due to wire delays can be compensated in the DPLL's DPHOFF registers. Also, phase adjustment as described in section 5.9.4.1 can be used to change the phases of output clocks vs. the input clock phase as needed.

#### 5.9.4.3.2 Manual with Phase Alignment, Phase Measurment and Phase Adjustment

If for some reason external feedback cannot be used, open-loop input-to-output phase alignment can be accomplished under software control. The procedure is to first do a phase alignment as described in section 5.9.4.2 but with a GPIO input as the trigger. Then the phase measurement tool described in section 5.9.6 can be used to determine the phase difference between an output signal and the input signal. Then phase adjustment as described in section 5.9.4.1 can be used to change the phase of one or more output signals to align with input signal phase.

It is important to note that, by default, outputs that only use the medium-speed divider have their rising edge aligned with the rising edge of the trigger signal. Meanwhile,outputs that use both the medium-speed and low-speed dividers have their rising edge aligned with the falling edge of the trigger signal. Per-output polarity bits (OCxCR2.POL) can be used to invert the polarity of output signals as needed so that all are rising-edge aligned or falling-edge aligned or any combination as needed.

#### 5.9.5 Output Clock Start and Stop

Output clocks can be stopped high or low. One use for this behavior is to ensure "glitchless" output clock operation while the output is reconfigured or phase aligned with some other signal.

Each output has an OCxSTOP register with fields to control this behavior. The OCxSTOP.MODE field specifies whether the output clock signal stops high, stops low, or or does not stop. The OCxSTOP.SRC field specifies the source of the stop signal. Options include the OCxSTOP.STOP bit, assertion of one of the GPIO pins, and the arming of a phase adjustment (which is indicated by PASR.ARMED).

When the stop mode is Stop High (OCxSTOP.MODE=01) and the stop signal is asserted, the output clock is stopped after the next rising edge of the output clock. When the stop mode is Stop Low (OCxSTOP.MODE=10) and the stop signal is asserted, the output clock is stopped after the next falling edge of the output clock. Internally the clock signal continues to toggle while the output is stopped. When the stop signal is deasserted, the output clock resumes on the opposite edge that it stopped on. Low-speed output clocks can take long intervals before being stopped after the stop signal goes active. For example, a 1 Hz output could take up to 1 second to stop.

OCxCR1.MSDIV must be > 0 for this function to operate since MSDIV=0 bypasses the start-stop circuits. Note that when OCxCR3.NEGLSD=1 the start-stop logic is bypassed for the OCxN pin, and OCxN may not start/stop without glitches.

When OCxCR2.POL=1 the output stops on the opposite polarity that is specified by the OCxSTOP.MODE field.

When OCxCR2.STOPDIS=1 the output driver is disabled (high impedance) while the output clock is stopped.

Each output has a status register (OCxSR) with several stop/start status bits. The STOPD bit is a real-time status bit indicating stopped or not stopped. The STOPL bit is a latched status bit that is set when the output clock has stopped. The STARTL bit is a latched status bit that is set when the output clock has started.

#### 5.9.6 A-to-B Phase Offset Measurement

The phase or time offset between two signals (A and B) can be measured in units of a timebase clock. This capability can be used for several purposes, including:

 Keeping output clocks and low-speed output phase/time signals—such as frame sync, multiframe sync, or 1 pulse per second (1PPS) signals—aligned with input phase/time signals. The A-to-B measurement circuitry can detect phase changes in the input signal. Then the DPLL's phase adjustment capability and/or the output phase adjustment circuitry described in section 5.9.4 can be used to move phase(s) of output(s) to follow the input phase change.

• Keeping output clock signals and/or low-speed output phase/time signals aligned with one another. The Ato-B measurement circuitry can detect relative phase changes, and the phase adjustment circuitry described in section 5.9.4 can be used to move phase(s) of output(s) as needed.

The A and B signals can be any ICx input, any OCx output, or any GPIO, as specified by MABCR2.ASRC and MABCR3.BSRC. The timebase signal can be the external oscillator signal (or the output of the crystal driver circuit, optionally doubled by the clock doubler) or the output clock of any of the three medium-speed dividers (MSDIV1, MSDIV2, MSDIV3). The timebase signal is specified by MABCR1.TBSRC.

A new measurement is started by writing MABCR1.START=1. Any previously started measurement must be completed before a new measurement is started. If a measurement has not finished it can be aborted by writing MABCR1.RST=1 before starting a new measurement. The measurement is complete when MABSR1.RDYL is set.

**Example**: consider an SDH/SONET application where OC1 is a 19.44MHz output clock and OC2 is an 8kHz frame sync signal. The goal is to measure the phase offset of OC1 vs. OC2. If they are found to have a phase offset then the phase adjustment circuitry in section 5.9.4 can be used to slowly change the phase of OC1 to match the phase of OC2.

MABCR1.TBSRC=001 MABCR2.ASRC=10001 MABCR3.BSRC=10000 MABCR1.START=1 Wait for MABSR1.RDYL=1 Read MABSR1.OVFL MABSR1.RDYL=1, MABSR1.OVFL=1 Read MEAS bits from MABSR1 and MABSR2 (MSDIV1 output clock is 311.04MHz = 3.2 ns period) (OC2 8kHz sync signal) (OC1 19.44MHz clock) (Start measurement) (Measurement ready) (to see if the measurement is valid) (clear latched status bits)

If, for example, MEAS = 111 1111 1000 (-8) then the rising edge of OC1 (the 'B' signal) precedes the rising edge of OC2 (the 'A' signal) by 8 MSDIV1 outut clock periods (25.7ns).

An A-to-B measurement is performed by sampling the A and B signals with the selected timebase clock and detecting the rising or falling edges to measure. The number of timebase clocks between the A and B edges is counted. If the counter doesn't overflow then the phase difference is reported in the MEAS field in MABSR1 and MABSR2. If the counter does overflow then MABSR1.OVFL is set and the value of MEAS is invalid.

While the measurement is in progress the MABSR1.BUSY bit is set to 1. When the measurement is complete MABSR1.BUSY is set to 0 and MABSR1.RDYL is set to 1. Since the A and B signals are sampled by the timebase signal, this measurement tool is only useful when the timebase signal is much higher frequency than the A and B signals (at least 8-10x). Also, when possible, the timebase signal frequency should be less than or equal to 1023 times faster than the the frequencies of the A and B frequencies to avoid measurement counter overflow.

Constraints on A-to-B measurement:

•  $f_B = f_A \times N$  where  $f_A$  is the frequency of signal A,  $f_B$  is the frequency of signal B and N is a positive integer

When measuring from an ICx input or a GPIO (signal A) to an ICx or a GPIO (signal B) and when measuring from an OCx output to an OCx output, the measured value is MEAS \* timebase\_period. This measurement has a variability of 0 to +1 timebase clock period.

When measuring from an ICx input or a GPIO (signal A) to an OCx output (signal B), the measurement in time units is MEAS \* timebase\_period + 6 \* HSCLK\_period, where HSCLK\_period is the period of the output of the high-

speed divider from which OCx signal is derived. This measurement has a variability of 0 to +1 timebase clock period plus 0 to +1 HSCLK periods.

When measuring from an OCx output (signal A) to an ICx input or a GPIO (signal B), the the measurement in time units is MEAS \* timebase\_period – 6 \* HSCLK\_period, where HSCLK\_period is the period of the output of the high-speed divider from which OCx signal is derived. This measurement has a variability of 0 to +1 timebase clock period plus 0 to +1 HSCLK periods.

#### Guidance for Use

When the A and B signals are aligned to within one timebase clock cycle, the measurement hardware does not report 0. Instead it reports a measurement value that is equivalent to +1 cycle of signal B.

If the timebase clock is  $\leq$  1023 times faster than signal B (so that the MEAS field cannot overflow, unless signal B is grossly too slow or not toggling at all) then system software should check the measured phase value. If the measured value is equal to the period of signal B then the A and B signals are aligned.

If the timebase clock is 1024 to 2047 times faster than signal B (and therefore the measurement counter can overflow) then the measurement hardware reports overflow when the A and B signals are aligned to within one timebase clock cycle. This report of overflow can be distinguished from other overflow cases by setting MABCR3.BINV=1 and then remeasuring from signal A to the opposite edge of signal B. If the new measured value is equal to half the period of signal B then the A and B signals are aligned.

If the timebase clock is > 2047 times faster than signal B then the measurement hardware reports overflow when the A and B signals are aligned to within one timebase clock cycle. This report of overflow is not distinguishable from other overflow cases. One way system software could work around this to determine that A and B are aligned is to use phase adjustment to move one of the signals by 2 or more timebase clocks then remeasure. If the new measured value matches the phase adjustment then the signals were aligned before the phase adjustment. Software can then adjust the phase of the signal back to its original position. Not all applications can tolerate such phase adjustments; for those applications it is recommended that the timebase clock be  $\leq$  2047 times faster than signal B.



#### 5.10 Microprocessor Interface

The device can communicate over a SPI interface or an I<sup>2</sup>C interface.

Section 5.3 describes reset pin settings required to configure the device for these interfaces.

## 5.10.1 SPI Slave

The device can present a SPI slave port on the CSN, SCLK, MOSI, and MISO pins. SPI is a widely used master/slave bus protocol that allows a master and one or more slaves to communicate over a serial bus. SPI masters are typically microprocessors, ASICs or FPGAs. Data transfers are always initiated by the master, which also generates the SCLK signal. The device receives serial data on the MOSI (<u>Master Qut Slave In</u>) pin and transmits serial data on the MISO (<u>Master In Slave Qut</u>) pin. MISO is high impedance except when the device is transmitting data to the bus master.

**Bit Order.** The register address and all data bytes are transmitted most significant bit first on both MOSI and MISO.

**Clock Polarity and Phase.** The device latches data on MOSI on the rising edge of SCLK and updates data on MISO on the falling edge of SCLK. SCLK does not have to toggle between accesses, i.e., when CSN is high.

**Device Selection.** Each SPI device has its own chip-select line. To select the device, the bus master drives its CSN pin low.

**Command and Address.** After driving CSN low, the bus master transmits an 8-bit command followed by a 16-bit register address. The available commands are shown below.

# Table 4 – SPI Commands

| Command      | Hex  | Bit Order, Left to Right |
|--------------|------|--------------------------|
| Write Enable | 0x06 | 0000 0110                |
| Write        | 0x02 | 0000 0010                |
| Read         | 0x03 | 0000 0011                |
| Read Status  | 0x05 | 0000 0101                |

**Read Transactions.** The device registers are accessible when EESEL=0. The internal EEPROM memory is accessible when EESEL=1. After driving CSN low, the bus master transmits the read command followed by the 16-bit address. The device then responds with the requested data byte on MISO, increments its address counter, and prefetches the next data byte. If the bus master continues to demand data, the device continues to provide the data on MISO, increment its address counter, and prefetch the following byte. The read transaction is completed when the bus master drives CSN high. See Figure 12.

**Register Write Transactions.** The device registers are accessible when EESEL=0. After driving CSN low, the bus master transmits the write command followed by the 16-bit register address followed by the first data byte to be written. The device receives the first data byte on MOSI, writes it to the specified register, increments its internal address register, and prepares to receive the next data byte. If the master continues to transmit, the device continues to write the data received and increment its address counter. The write transaction is completed when the bus master drives CSN high. See Figure 14.

**EEPROM Writes.** The EEPROM memory is accessible when EESEL=1. After driving CSN low, the bus master transmits the write enable command and then drives CSN high to set the internal write enable latch. The bus master then drives CSN low again and transmits the write command followed by the 16-bit address followed by the first data byte to be written. The device first copies the page to be written from EEPROM to its page buffer. The device then receives the first data byte on MOSI, writes it to its page buffer, increments its internal address register, and prepares to receive the next data byte. If the master continues to transmit, the device continues to write the data received to its page buffer and continues to increment its address counter. The address counter rolls over at the 32-byte page boundary (i.e. when the five least-significant address bits are 11111). When the bus master

drives CSN high, the device transfers the data in the page buffer to the appropriate page in the EEPROM memory. See Figure 13 and Figure 14.

**EEPROM Read Status**. After the bus master drives CSN high to end an EEPROM write command, the EEPROM memory is not accessible for up to 5ms while the data is transferred from the page buffer. To determine when this transfer is complete, the bus master can use the Read Status command. After driving CSN low, the bus master transmits the Read Status command. The device then responds with the status byte on MISO. In this byte, the least significant bit is set to 1 if the transfer is still in progress and 0 if the transfer has completed.

**Early Termination of Bus Transactions.** The bus master can terminate SPI bus transactions at any time by pulling CSN high. In response to early terminations, the device resets its SPI interface logic and waits for the start of the next transaction. If a register write transaction is terminated prior to the SCLK edge that latches the least significant bit of a data byte, the data byte is not written. If an EEPROM write transaction is terminated prior to the SCLK edge that latches the least SCLK edge that latches the least significant bit of a data byte, none of the bytes in that write transaction are written.

**Design Option: Wiring MOSI and MISO Together.** Because communication between the bus master and the device is half-duplex, the MOSI and MISO pins can be wired together externally to reduce wire count. To support this option, the bus master must not drive the MOSI/MISO line when the device is transmitting.

**AC Timing.** See Table 19 and Figure 25 for AC timing specifications for the SPI interface.

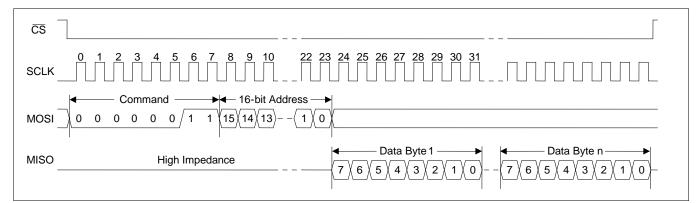


Figure 12 - SPI Read Transaction Functional Timing

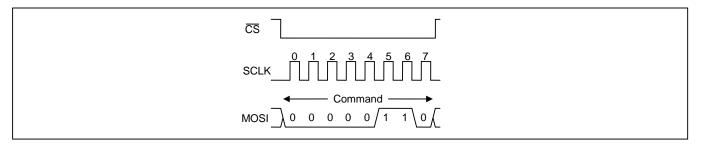


Figure 13 - SPI Write Enable Transaction Functional Timing



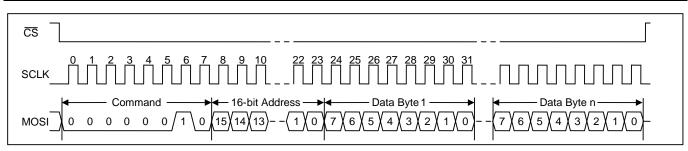


Figure 14 - SPI Write Transaction Functional Timing

## 5.10.2 I<sup>2</sup>C Slave

The device can present a fast-mode (400kbit/s) I<sup>2</sup>C slave port on the SCL and SDA pins. I<sup>2</sup>C is a widely used master/slave bus protocol that allows one or more masters and one or more slaves to communicate over a twowire serial bus. I<sup>2</sup>C masters are typically microprocessors, ASICs or FPGAs. Data transfers are always initiated by the master, which also generates the SCL signal. The device is compliant with version 2.1 of the I<sup>2</sup>C specification.

The I<sup>2</sup>C interface on the device is a protocol translator from external I<sup>2</sup>C transactions to internal SPI transactions. This explains the slightly increased protocol complexity described in the paragraphs that follow.

**Read Transactions.** The device registers are accessible when EESEL=0. The internal EEPROM memory is accessible when EESEL=1. The bus master first does an I<sup>2</sup>C write to the device. In this transaction three bytes are written: the SPI Read command (see Table 4), the upper byte of the register address, and the lower byte of the register address. The bus master then does an I<sup>2</sup>C read. During each acknowledge (A) bit the device fetches data from the read address and then increments the read address. The device then transmits the data to the bus master during the next 8 SCL cycles. The bus master terminates the read with a not-acknowledge (NA) followed by a STOP condition (P). See Figure 15. Note: If the I<sup>2</sup>C write is separated in time from the I<sup>2</sup>C read by other I<sup>2</sup>C transactions then the device only outputs the data value from the first address and repeats that same data value after each acknowledge (A) generated by the bus master.

**Register Write Transactions.** The device registers are accessible when EESEL=0. The bus master does an I<sup>2</sup>C write to the device. The first three bytes of this transaction are the SPI Write command (see Table 4), the upper byte of the register address, and the lower byte of the register address. Subsequent bytes are data bytes to be written. After each data byte is received, the device writes the byte to the write address and then increments the write address. The bus master terminates the write with a STOP condition (P). See Figure 16.

**EEPROM Writes.** The EEPROM memory is accessible when EESEL=1. The bus master first does an I<sup>2</sup>C write to transmit the SPI Write Enable command (see Table 4) to the device. The bus master then does an I<sup>2</sup>C write to transmit data to the device as described in the Register Write Transactions paragraph above. See Figure 17.

**EEPROM Read Status**. The bus master first does an I<sup>2</sup>C write to transmit the SPI Read Status command (see Table 4) to the device. The bus master then does an I<sup>2</sup>C read to get the status byte. In this byte, the least significant bit is set to 1 if the transfer is still in progress and 0 if the transfer has completed. See Figure 18.

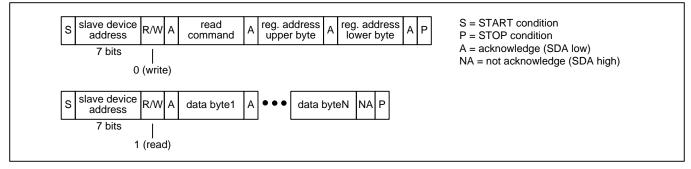
I<sup>2</sup>C Features Not Supported by the Device. The I<sup>2</sup>C specification has several optional features that are not supported by the device. These are: 3.4Mbit/s high-speed mode (Hs-mode), 10-bit device addressing, general call address, software reset, and device ID. The device does not hold SCL low to force the master to wait.

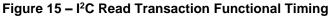
I<sup>2</sup>C Slave Address. The device's 7-bit slave address can be pin-configured for any of three values. These values are show in the table in section 5.3.

**Bit Order.** The I<sup>2</sup>C specification requires device address, register address and all data bytes to be transmitted most significant bit first on the SDA signal.

Note: as required by the I<sup>2</sup>C specification, when power is removed from the device, the SDA and SCL pins are left floating so they don't obstruct the bus lines.







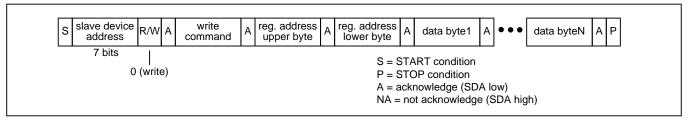


Figure 16 – I<sup>2</sup>C Register Write Transaction Functional Timing

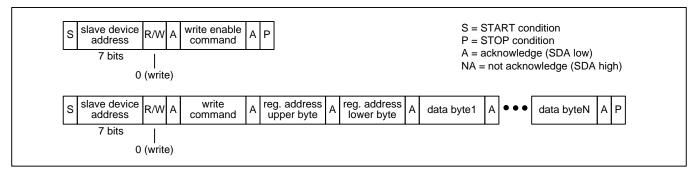


Figure 17 – I<sup>2</sup>C EEPROM Write Transaction Functional Timing

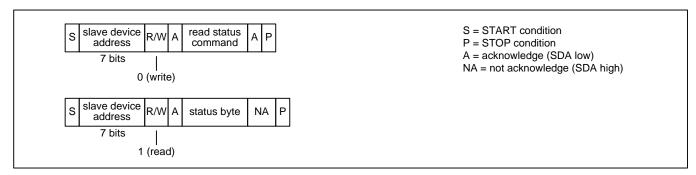


Figure 18 – I<sup>2</sup>C EEPROM Read Status Transaction Functional Timing

Note: In Figure 15 through Figure 18, a STOP condition (P) immediately followed by a START condition (S) can be replaced by a repeated START condition (Sr) as described in the I<sup>2</sup>C specification.



#### 5.11 Interrupt Logic

Any of the GPIO pins can be configured as an interrupt-request output by setting the appropriate GPIOxC field in the GPIOCR registers to one of the status output options (01xx) and configuring the appropriate GPIOxSS register to follow the INTSR.INT bit. If system software is written to poll rather than receive interrupt requests, then software can read the INTSR.INT bit first to determine if any interrupt requests are active in the device.

Many of the latched status bits in the device can be the source of an interrupt request if their corresponding interrupt enable bits are set. The device's interrupt logic is shown in Figure 19. See the register map (Table 5) and the status register descriptions in section 6.3.2 for descriptions of the register bits shown in the figure.

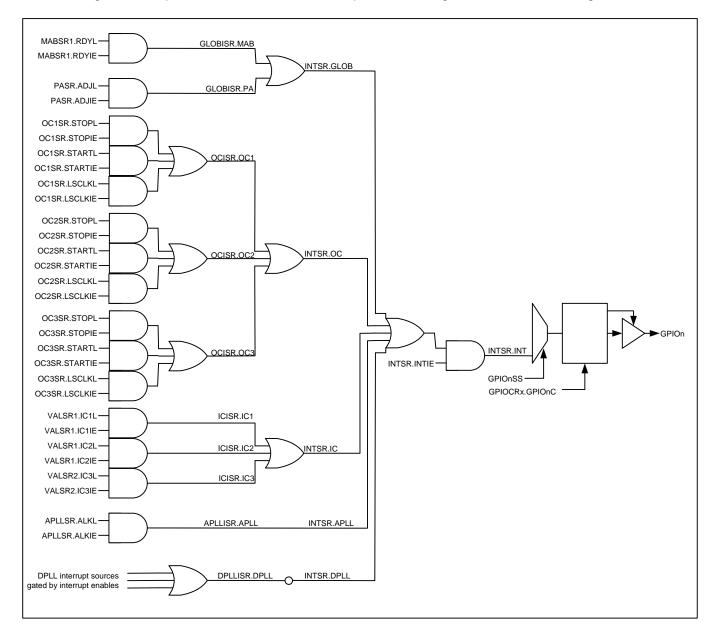


Figure 19 – Interrupt Structure



### 5.12 Reset Logic

The device has two reset controls: the RSTN pin and the RST bit in MCR1. The RSTN pin asynchronously resets the entire device. When the RSTN pin is low all internal registers are reset to their default values. **The RSTN pin must have one rising edge after power-up.** At initial power-up reset should be asserted for at least 1µs. During operation, the RSTN assertion time can be as short as 1µs with one important exception:

Consider each of these four pins: AC0/GPIO0, AC1/GPIO1, TEST/GPIO2 and IF1/MISO. If (1) the pin could be an output driving high when RSTN is asserted, and (2) an external pulldown resistor is used to set the at-reset value of the pin, then RSTN should be asserted for 100 milliseconds.

The MCR1.RST bit resets the entire device (except for the microprocessor interface and the RST bit itself), but when the RST bit is active, the register fields with pin-programmed defaults do not latch their values from, or based on, the corresponding input pins. Instead these fields are reset to the default values that were latched when the RSTN pin was last active.

Microsemi recommends holding RSTN low while the internal ring oscillator starts up and stabilizes. An incorrect reset condition could result if RSTN is released before the oscillator has started up completely. After the external oscillator or internal crystal driver circuit has been enabled and stabilized, the master clock can be switched from the ring oscillator to the external oscillator using the MCR1.MCSEL bit.

**Important:** System software must wait at least 100µs after RSTN is deasserted and wait for GLOBISR.BCDONE=1 before configuring the device.

#### 5.13 Power-Supply Considerations

Due to the multi-power-supply nature of the device, some I/Os have parasitic diodes between a <3.3V supply and a 3.3V supply. When ramping power supplies up or down, care must be taken to avoid forward-biasing these diodes because it could cause latchup. Two methods are available to prevent this. The first method is to place a Schottky diode external to the device between the <3.3V supply and the 3.3V supply to force the 3.3V supply to be within one parasitic diode drop of the <3.3V supply. The second method is to ramp up the 3.3V supply first and then ramp up the <3.3V supply. In some applications VDDOx power supply pins can be at other voltages, such as 2.5V or 1.5V. In these applications the general solution is to ramp up the supplies in order from highest nominal to lowest nominal voltage.

#### 5.14 Auto-Configuration from EEPROM

#### 5.14.1 Generating Device Configurations

Device configurations must be generated using the evaluation software. This is true for auto-configurations stored in internal or external EEPROM and for configurations that are written to the device by a system processor. The reason for this requirement is that writes to undocumented registers must be done to tune analog circuitry for optimal performance. The writes to be done depend on integer vs. fractional multiplication, device mode and other factors. The registers involved control very low-level device parameters that are difficult to describe and difficult to understand how to use. Instead the evaluation software has all of the expert knowledge built-in to keep configuration easy for the user.

#### 5.14.2 Direct EEPROM Write Mode

To simplify writing the internal EEPROM during manufacturing, the device has a test mode known as direct EEPROM write mode. The device enters this mode when TEST=1 and AC[1:0]=00 on the rising edge of RSTN. In this mode the EEPROM memory is mapped into the address map and can be written as needed to store configuration scripts in the device. Device registers are not accessible in this mode. The device exits this mode when TEST=0 on the rising edge of RSTN. Note: the device drives the MISO pin continually during this mode. Therefore this mode cannot be used when MOSI and MISO are tied together (as described in the *Design Option: Wiring MOSI and MISO Together* paragraph in section 5.10.1).



## 5.14.3 Holding Other Devices in Reset During Auto-Configuration

Using the appropriate GPIOCR and GPIO0SS registers, a GPIO pin can be configured to follow the GLOBISR.BCDONE status bit. This GPIO can then be used as a reset signal to hold other devices (that use clocks from this device) in reset while the device configures itself. As an example, to configure GPIO0 to follow BCDONE with 0=reset add the following writes at the beginning of the configuration file: write 0x1F to GPIO0SS and write 0x04 to GPIOCR1.

## 5.15 Power Supply Decoupling and Layout Recommendations

Application Note ZLAN-490 describes recommended power supply decoupling and layout practices.

# 6. Register Descriptions

The device has an overall address range from 000h to 6FFh. Table 5 shows the register map. In each register, bit 7 is the MSb and bit 0 is the LSb. <u>Register addresses not listed and bits marked "—" are reserved and must be written with 0.</u> Writing other values to these registers may put the device in a factory test mode resulting in undefined operation. Bits labeled "0" or "1" must be written with that value for proper operation. Register fields with <u>underlined</u> names are read-only fields; writes to these fields have no effect. All other fields are read-write. Register fields are described in detail in the register descriptions that follow Table 5.

## 6.1 Register Types

#### 6.1.1 Status Bits

The device has two types of status bits. Real-time status bits are read-only and indicate the state of a signal at the time it is read. Latched status bits are set when a signal changes state (low-to-high, high-to-low, or both, depending on the bit) and cleared when written with a logic 1 value. Writing a 0 has no effect. When set, some latched status bits can cause an interrupt request if enabled to do so by corresponding interrupt enable bits. Status bits marked "—" are reserved and must be ignored.

## 6.1.2 Configuration Fields

Configuration fields are read-write. During reset, each configuration field reverts to the default value shown in the register definition. <u>Configuration register bits marked "—" are reserved and must be written with 0.</u>

## 6.1.3 Multiregister Fields

Multiregister fields—such as FREQZ[39:0] in registers DFREQZ1 through DFREQZ5—must be handled carefully to ensure that the bytes of the field remain consistent. A write access to a multiregister field is accomplished by writing all the registers of the field in order from smallest address to largest. Writes to registers other than the last register in the field (i.e. the register with the largest address) are stored in a transfer register. When the last register of the field is written, the entire multiregister field is updated simultaneously from the transfer register. If the last register of the field is not written, the field is not updated. Any reads from the multiregister field that occur during the middle of the multiregister write will read the existing value of the field not the new value in the transfer register.

A read access from a multiregister field is accomplished by reading the registers of the field in order from smallest address to largest. When the first register in the field (i.e. the register with the lowest address) is read, the entire multiregister field is copied to the transfer register. During subsequent reads from the other registers in the multiregister field, the data comes from the transfer register. Any writes to the multiregister field that occur during the middle of the multiregister read will overwrite values in the transfer register.

The device has one write transfer register and one read transfer register that it reuses for all multiregister fields. For proper operation system software should be organized such that only one software process accesses the device's registers. If two or more processes are allowed to make uncoordinated accesses to the device's registers, their



accesses to multiregister fields could interrupt one another leading to incorrect writes and reads of the multiregister fields.

The multiregister fields are:

| Field       | Registers          | Туре       |
|-------------|--------------------|------------|
| FREQZ[39:0] | DFREQZ1 to DFREQZ5 | Read/Write |
| PHOFF[31:0] | DPHOFF1 to DPHOFF4 | Read/Write |
| FREQ[31:0]  | DFREQ1 to DFREQ4   | Read-Only  |
| PHASE[31:0] | DPHASE1 to DPHASE4 | Read-Only  |

## 6.1.4 Bank-Switched Registers

The EESEL register is a bank-select control field that maps the device registers into the memory map at address 0x1 and above when EESEL=0 and maps the EEPROM memory into the memory map at address 0x1 and above when EESEL=1. The EESEL register itself is always in the memory map at address 0x0 for both EESEL=0 and EESEL=1.

## 6.1.5 DPLL Registers

See section 5.7.1 for important discussion about DPLL registers.

## 6.2 Register Map

#### Table 5 - Register Map

| ADDR   | REGISTER       | BIT 7       | BIT 6         | BIT 5        | BIT 4      | BIT 3        | BIT 2        | BIT 1        | BIT 0        |  |
|--------|----------------|-------------|---------------|--------------|------------|--------------|--------------|--------------|--------------|--|
|        | Configuratio   |             |               | Biro         |            | Biro         | 511 2        | 511 1        | Dire         |  |
| 00h    | EESEL          | _           |               |              | _          | _            | _            | _            | EESEL        |  |
| 09     | MCR1           | RST         | _             | MCSEL1       | MCSEL      | ROSCD        | DBL          | XAB          | [1:0]        |  |
| 0A     | MCR2           | _           | EXTS          | S[1:0]       | AINCDIS    | —            |              | MCLK[2:0]    |              |  |
| 0B     | PLLEN          | —           | —             | —            | DPLLEN     | —            |              | —            | APLLEN       |  |
| 0C     | ICEN           | —           | _             | _            | _          | _            | IC3EN        | IC2EN        | IC1EN        |  |
| 0D     | OCEN           | —           | —             | —            | —          | —            | OC3EN        | OC2EN        | OC1EN        |  |
| 0E     | GPIOCR1        |             | GPIO          | 1C[3:0]      |            |              | GPIOC        | GPIO0C[3:0]  |              |  |
| 0F     | GPIOCR2        |             | GPIO:         | 3C[3:0]      |            |              | GPIO2        | 2C[3:0]      |              |  |
| 12     | <b>GPIO0SS</b> |             |               | REG[4:0]     |            |              |              | BIT[2:0]     |              |  |
| 13     | GPIO1SS        |             |               | REG[4:0]     |            |              |              | BIT[2:0]     |              |  |
| 14     | GPIO2SS        |             |               | REG[4:0]     |            |              |              | BIT[2:0]     |              |  |
| 15     | GPIO3SS        |             |               | REG[4:0]     |            |              |              | BIT[2:0]     |              |  |
| 1B     | PACR1          | RST         | TRIG          | ARM          | _          | _            |              | TINV         | MODE         |  |
| 1C     | PACR2          |             | ARMS          | RC[3:0]      |            |              | TRGSF        | RC[3:0]      |              |  |
| 1D     | MABCR1         | RST         | START         |              |            | _            | -            | TBSRC[2:0]   |              |  |
| 1E     | MABCR2         | AINV        | —             | —            |            |              | ASRC[4:0]    |              |              |  |
| 1F     | MABCR3         | BINV        | _             | _            |            |              | BSRC[4:0]    |              |              |  |
| Status | Registers      |             |               |              |            |              |              |              |              |  |
| 30     | ID1            |             |               |              | <u>IDU</u> | J[7:0]       |              |              |              |  |
| 31     | ID2            |             | <u>IDL</u>    | <u>[3:0]</u> |            |              | <u>REV</u>   | [3:0]        |              |  |
| 40     | CFGSR          | <u>TEST</u> | <u>XOFAIL</u> |              | —          | <u>IF[</u>   | <u>1:0]</u>  | <u>AC[</u>   | 1:0]         |  |
| 41     | GPIOSR         |             |               |              |            | <u>GPIO3</u> | <u>GPIO2</u> | <u>GPIO1</u> | <u>GPIO0</u> |  |
| 42     | INTSR          | _           | <u>GLOB</u>   | <u>0C</u>    | <u>IC</u>  | DPLL         | <u>APLL</u>  | INTIE        | <u>INT</u>   |  |



| ADDR | REGISTER      | BIT 7         | BIT 6       | BIT 5        | BIT 4         | BIT 3           | BIT 2        | BIT 1         | BIT 0          |
|------|---------------|---------------|-------------|--------------|---------------|-----------------|--------------|---------------|----------------|
| 43   | GLOBISR       | <b>BCDONE</b> | _           | —            | —             | _               | _            | <u>PA</u>     | MAB            |
| 44   | ICISR         | —             |             |              | —             | —               | <u>IC3</u>   | <u>IC2</u>    | <u>IC1</u>     |
| 45   | OCISR         | —             |             |              | —             | —               | <u>OC3</u>   | <u>OC2</u>    | <u>OC1</u>     |
| 46   | APLLISR       | —             | _           | —            | —             | —               | _            | <u> </u>      | <u>APLL</u>    |
| 47   | DPLLISR       | —             | _           | —            | —             | —               | _            | <u> </u>      | <u>DPLL</u>    |
| 48   | APLLSR        | —             | ALK2IE      | ALK2L        | ALK2          | <u>ADLK</u>     | ALKIE        | ALKL          | <u>ALK</u>     |
| 49   | PTAB1         | —             |             |              | 1[1:0]        | _               | _            | SELRE         |                |
| 4A   | PTAB2         | —             | —           |              | <u>3[1:0]</u> | —               | _            | REF2          | 2[1:0]         |
| 4B   | MABSR1        | —             | OVFL        | RDYIE        | RDYL          | <u>BUSY</u>     |              | MEAS[10:8]    |                |
| 4C   | MABSR2        |               |             | r            | MEA           | S[7:0]          |              | 1             |                |
| 4D   | PASR          | —             |             |              | —             | ADJIE           | ADJL         | <u>BUSY</u>   | <u>ARMED</u>   |
| 4E   | VALSR1        | —             | IC2IE       | IC2L         | <u>IC2</u>    | —               | IC1IE        | IC1L          | <u>IC1</u>     |
| 4F   | VALSR2        | —             |             |              | —             |                 | IC3IE        | IC3L          | <u>IC3</u>     |
| 50   | IC1SR         | LKCLR         | <u>LKTO</u> | LOS          | <u>ACVAL</u>  | <u>PCVAL</u>    | <u>PPVAL</u> | VAL           | VALT           |
| 51   | IC2SR         | LKCLR         | <u>LKTO</u> | LOS          | <u>ACVAL</u>  | <u>PCVAL</u>    | <u>PPVAL</u> | VAL           | VALT           |
| 52   | IC3SR         | LKCLR         | <u>LKTO</u> | LOS          | <u>ACVAL</u>  | <u>PCVAL</u>    | <u>PPVAL</u> | VAL           | <u>VALT</u>    |
| 53   | OC1SR         | LSCLKIE       | LSCLKL      | <u>LSCLK</u> | STARTIE       | STARTL          | STOPIE       | STOPL         | <u>STOPD</u>   |
| 54   | OC2SR         | LSCLKIE       | LSCLKL      | <u>LSCLK</u> | STARTIE       | STARTL          | STOPIE       | STOPL         | <u>STOPD</u>   |
| 55   | OC3SR         | LSCLKIE       | LSCLKL      | <u>LSCLK</u> | STARTIE       | STARTL          | STOPIE       | STOPL         | <u>STOPD</u>   |
| 56   | DSRR1         | —             |             | LOL          | <u>TRK</u>    | <u>HO</u>       | _            | —             | —              |
| 57   | DSRR2         | —             | —           | —            | <u>NORUN</u>  | —               | <u>FLIM</u>  | <u>FCHLIM</u> | <u>PSLIM</u>   |
| 59   | DSRL1         | —             |             | LOLL         | TRKL          | HOL             |              | —             | —              |
| 5A   | DSRL2         | —             |             | —            | —             | —               | FLIML        | FCHLIML       | PSLIML         |
| 5B   | DSRIE1        | —             |             | LOLIE        | TRKIE         | HOIE            |              | —             | —              |
| 5C   | DSRIE2        | —             | —           |              | —             |                 | FLIMIE       | FCHLIMIE      | PSLIMIE        |
| 65   | DFREQ1        |               |             |              |               | Q[7:0]          |              |               |                |
| 66   | DFREQ2        |               |             |              |               | <u>[17:8]</u>   |              |               |                |
| 67   | DFREQ3        |               |             |              |               | [23:16]         |              |               |                |
| 68   | DFREQ4        |               |             |              |               | [31:24]         |              |               |                |
| 7D   | DPHASE1       |               |             |              |               | SE[7:0]         |              |               |                |
| 7E   | DPHASE2       |               |             |              |               | E[15:8]         |              |               |                |
| 7F   | DPHASE3       |               |             |              |               | <u>=[23:16]</u> |              |               |                |
| 80   | DPHASE4       |               |             |              | PHASE         | <u>=[31:24]</u> |              |               |                |
|      | Configuration | n Registers   |             |              |               |                 | ENU-CO       | D)/DU/OC      |                |
| 100  | APLLCR1       |               |             |              |               |                 | ENHS2        | BYPHS2        |                |
| 101  | APLLCR2       |               |             | V2[3:0]      |               | -               |              | /1[3:0]       |                |
| 102  | APLLCR3       |               | EXTSW       |              | ALTMUX[2:0    | •               | A            | PLLMUX[2:0    | ון             |
| 103  | APLLCR4       | DECPH         |             | PDSS[2:0]    |               | INCPH           |              | PISS[2:0]     |                |
| 106  | AFBDIV1       |               |             |              |               | 01V[7:0]        |              |               |                |
| 107  | AFBDIV2       |               |             |              |               | V[15:8]         |              |               |                |
| 108  | AFBDIV3       |               |             |              |               | V[23:16]        |              |               |                |
| 109  | AFBDIV4       |               |             |              |               | V[31:24]        |              |               |                |
| 10A  | AFBDIV5       |               |             |              | AFBDI         | V[39:32]        |              |               | (T. A. A. C. ] |
| 10B  | AFBDIV6       |               |             |              | ·             |                 | _            | AFBDIV        | [41:40]        |
| 10C  | AFBDEN1       |               |             |              |               | EN[7:0]         |              |               |                |
| 10D  | AFBDEN2       |               |             |              |               | EN[15:8]        |              |               |                |
| 10E  | AFBDEN3       |               |             |              | AFBDE         | N[23:16]        |              |               |                |



| T 1                   | BIT 0    |  |  |  |  |  |  |  |
|-----------------------|----------|--|--|--|--|--|--|--|
| -  l                  |          |  |  |  |  |  |  |  |
| -  l                  |          |  |  |  |  |  |  |  |
| -  l                  |          |  |  |  |  |  |  |  |
| -  l                  |          |  |  |  |  |  |  |  |
| -  l                  |          |  |  |  |  |  |  |  |
| -  l                  |          |  |  |  |  |  |  |  |
| -  l                  |          |  |  |  |  |  |  |  |
| -  l                  |          |  |  |  |  |  |  |  |
| -  l                  |          |  |  |  |  |  |  |  |
| -  l                  |          |  |  |  |  |  |  |  |
|                       |          |  |  |  |  |  |  |  |
| MODE                  | [1:0]    |  |  |  |  |  |  |  |
| MODE                  | [1:0]    |  |  |  |  |  |  |  |
| MODE                  | [1:0]    |  |  |  |  |  |  |  |
| MODE                  | [1:0]    |  |  |  |  |  |  |  |
| MODE                  | [1:0]    |  |  |  |  |  |  |  |
| NODE                  | [1.0]    |  |  |  |  |  |  |  |
|                       |          |  |  |  |  |  |  |  |
|                       |          |  |  |  |  |  |  |  |
|                       |          |  |  |  |  |  |  |  |
|                       |          |  |  |  |  |  |  |  |
|                       |          |  |  |  |  |  |  |  |
| S                     |          |  |  |  |  |  |  |  |
| same as OC1 registers |          |  |  |  |  |  |  |  |
|                       |          |  |  |  |  |  |  |  |
|                       |          |  |  |  |  |  |  |  |
|                       |          |  |  |  |  |  |  |  |
| HSDIV                 | /[1:0]   |  |  |  |  |  |  |  |
| CEN                   | PPEN     |  |  |  |  |  |  |  |
|                       |          |  |  |  |  |  |  |  |
|                       |          |  |  |  |  |  |  |  |
|                       |          |  |  |  |  |  |  |  |
|                       |          |  |  |  |  |  |  |  |
|                       |          |  |  |  |  |  |  |  |
|                       |          |  |  |  |  |  |  |  |
|                       |          |  |  |  |  |  |  |  |
|                       | —        |  |  |  |  |  |  |  |
| C2                    | IC1      |  |  |  |  |  |  |  |
| PRI1[                 | [1:0]    |  |  |  |  |  |  |  |
|                       |          |  |  |  |  |  |  |  |
| PRI3[                 |          |  |  |  |  |  |  |  |
| PRI3[                 |          |  |  |  |  |  |  |  |
| PRI3[                 |          |  |  |  |  |  |  |  |
|                       | [1:0]    |  |  |  |  |  |  |  |
|                       | <u> </u> |  |  |  |  |  |  |  |
|                       | [1:0]    |  |  |  |  |  |  |  |
|                       | [1:0]    |  |  |  |  |  |  |  |
|                       | PRI3     |  |  |  |  |  |  |  |



| ADDR | REGISTER | BIT 7 |              |  |      |          |  |  |  |  |
|------|----------|-------|--------------|--|------|----------|--|--|--|--|
| 423  | DFREQZ4  |       | FREQZ[31:24] |  |      |          |  |  |  |  |
| 424  | DFREQZ5  |       |              |  | FREQ | Z[39:32] |  |  |  |  |
| 428  | DPHOFF1  |       |              |  | PHO  | FF[7:0]  |  |  |  |  |
| 429  | DPHOFF2  |       |              |  | PHOF | F[15:8]  |  |  |  |  |
| 42A  | DPHOFF3  |       | PHOFF[23:16] |  |      |          |  |  |  |  |
| 42B  | DPHOFF4  |       |              |  | PHOF | F[31:24] |  |  |  |  |



## 6.3 Register Definitions

#### 6.3.1 Global Configuration Registers

| Register Name:        | EESEL                            |
|-----------------------|----------------------------------|
| Register Description: | EEPROM Memory Selection Register |
| Register Address:     | 00h                              |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|-------|-------|-------|-------|
| Name    | _     | —     | _     | _     | —     | —     | _     | EESEL |
| Default | 0     | 0     | 0     | 0     | 0     | 0     | 0     | 0     |

**Bit 0: EEPROM Memory Select (EESEL).** This bit is a bank-select that specifies whether device register space or EEPROM memory is mapped into addresses 0x1 and above. See sections 5.10 and 6.1.4. Note that this bit is write-only; the value read is not reliable.

0 = Device registers

1= EEPROM memory

| Register Name:        | MCR1                            |
|-----------------------|---------------------------------|
| Register Description: | Master Configuration Register 1 |
| Register Address:     | 09h                             |

|             | Bit 7 | Bit 6 | Bit 5  | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|-------------|-------|-------|--------|-------|-------|-------|-------|-------|
| <u>Name</u> | RST   | _     | MCSEL1 | MCSEL | ROSCD | DBL   | XAB   | [1:0] |
| Default     | 0     | 0     | 0      | 0     | 0     | 0     | 0     | 0     |

**Bit 7: Device Reset (RST).** When this bit is high the entire device is held in reset, and all register fields, except the RST bit itself, are reset to their default states. When RST is high, the register fields with pin-programmed defaults do not latch their values from the corresponding input pins. Instead these fields are reset to the default values that were latched from the pins when the RSTN pin was last active. See section 5.12.

0 = Normal operation

1 = Reset

Note: For proper sequencing of internal logic, write MCR1 to clear the MCSEL1, MCSEL and ROSCD bits first (without changing the value of the RST bit) then perform a second write to set the RST bit. (Note: on rev A devices (ID2.REV=0) do not set this bit to 1.)

Bit 5: DPLL Master Clock Select IC1 (MCSEL1). This bit overrides the MCSEL bit to specify IC1 as the source of the DPLL master clock.

0 = DPLL master clock selected by MCSEL bit

1 = DPLL master clock sourced from IC1, which has a divider and a polarity control bit

**Bit 4: DPLL Master Clock Select (MCSEL).** This bit selects the source of the DPLL master clock. At reset the internal ring oscillator is enabled and selected. When operating the device in DPLL+APLL mode, this bit must be set to 1 after the external oscillator connected to the XA pin has stabilized and is ready to use. See section 5.4.4.

0 = DPLL master clock sourced from internal ring oscillator

1 = DPLL master clock sourced from the XA pin (optionally through the clock doubler)

**Bit 3: Ring Oscillator Disable (ROSCD).** This bit disables the ring oscillator. It can be set to 1 when either MCSEL or MCSEL1 is set 1 so that the ring oscillator does not cause unwanted phase noise spurs in output clock signals. See section 5.4.4.

0 = Enable

1 = Disable (power-down)



**Bit 2: Clock Doubler Enable (DBL).** This bit enables the clock doubler for the output of the crystal driver circuitry or the signal on the XA pin. During power-up, system software must wait at least 5ms for the crystal driver circuit to stabilize before enabling the clock doubler. See section 5.4.3.

0 = Disable (power down)

1 = Enable

Bits 1 to 0: XA/XB Pin Mode (XAB[1:0]). This field specifies the behavior of the XA and XB pins. See section 5.4.

00 = Crystal driver and input disabled / powered down

01 = Crystal driver and input enabled on XA/XB

10 = XA enabled as single-ended input for external oscillator signal; XB must be left floating

11 = {unused value}

| Register Name:        | MCR2                            |
|-----------------------|---------------------------------|
| Register Description: | Master Configuration Register 2 |
| Register Address:     | 0Ah                             |

|         | Bit 7 | Bit 6 | Bit 5  | Bit 4   | Bit 3 | Bit 2 | Bit 1     | Bit 0 |
|---------|-------|-------|--------|---------|-------|-------|-----------|-------|
| Name    | _     | EXTSS | S[1:0] | AINCDIS | _     |       | MCLK[2:0] |       |
| Default | 0     | 0     | 0      | 0       | 0     | 0     | 0         | 0     |

**Bits 6 to 5: External Switch Source Select (EXTSS[1:0]).** This field selects the GPIO source for both the APLL and DPLL external switch control signal. It is only valid when either APLLCR3.EXTSW=1 or ICSCR1.EXTSW=1. See sections 5.6.3.4 and 5.8.1.1.

00 = GPIO0 01 = GPIO1 10 = GPIO2 11 = GPIO3

**Bit 4: Automatic Increment Disable (AINCDIS).** This bit disables the automatic register address increment during SPI or I2C reads and writes. Disabling automatic increment significantly increases the efficiency of writing and reading DSP code, which requires repeated writes to address 0x040E or repeated reads from address 0x040F.

0 = Enable automatic address increment

1 = Disable automatic address increment

**Bits 2 to 0: Master Clock Frequency Select (MCLK[2:0]).** These bits specify the frequency range of the DPLL master clock. Several vendors including Vectron, Rakon and TXC offer low-cost, low-jitter XOs with output frequencies in this range. When the internal clock doubler is enabled: (a) this MCLK field must specify 2x the XA frequency, (b) if a clock signal is applied to the XA pin, the signal must be in the 46.5MHz to 65MHz range, and (c) if a crystal is connected to the XA and XB pins, the crystal must be in the 46.5MHz to 60MHz range. See section 5.2.2.

00x = 93MHz to 104MHz 01x = 104MHz to 115MHz 10x = 115MHz to 130MHz 11x = {unused values}

Note that the master clock frequency range widens to 80MHz to 130MHz (with no gaps in the range) for applications where the DPLL is not expected to lock to input clock signals but rather is only operated in NCO (numerically controlled oscillator) mode. In these applications this MCLK field is ignored.



Register Name: Register Description: Register Address: PLLEN APLL and DPLL Enable Register 0Bh

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4  | Bit 3 | Bit 2 | Bit 1 | Bit 0  |
|---------|-------|-------|-------|--------|-------|-------|-------|--------|
| Name    | _     | —     | —     | DPLLEN | _     | —     | _     | APLLEN |
| Default | 0     | 0     | 0     | 0      | 0     | 0     | 0     | 0      |

**Bit 4: DPLL Enable (DPLLEN).** This field enables or disables the DPLL and input clock monitors. See section 5.2.2. The XA clock source must be properly configured and selected to operate the DPLL and input clock monitors.

0 = Disable (powered down)

1 = Enable

**Bit 0: APLL Enable (APLLEN).** This bit enables or disables the APLL. For normal operation the APLL must be enabled. See section 5.8.2.

0 = Disabled

1 = Enabled

Register Name:ICENRegister Description:Input Clock Enable RegisterRegister Address:0Ch

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|-------|-------|-------|-------|
| Name    |       | _     | _     |       | _     | IC3EN | IC2EN | IC1EN |
| Default | 0     | 0     | 0     | 0     | 0     | 0     | 0     | 0     |

Bit 2: Input Clock 3 Enable (IC3EN). This bit enables and disables the input clock 3 differential receiver and input divider. See section 5.5.

0 = Disabled

1 = Enabled

Bit 1: Input Clock 2 Enable (IC2EN). This bit enables and disables the input clock 2 differential receiver and input divider. See section 5.5.

0 = Disabled

1 = Enabled

Bit 0: Input Clock 1 Enable (IC1EN). This bit enables and disables the input clock 1 differential receiver and input divider. See section 5.5.

0 = Disabled

1 = Enabled



Register Name: Register Description: Register Address: OCEN Output Clock Enable Register 0Dh

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|-------|-------|-------|-------|
| Name    | _     | —     | _     | _     | _     | OC3EN | OC2EN | OC1EN |
| Default | 0     | 0     | 0     | 0     | 0     | 0     | 0     | 0     |

**Bit 2: Output Clock 3 Enable (OC3EN).** This bit enables and disables the output clock 3 drivers, output dividers, phase adjustment/alignment circuitry and start/stop circuitry. See section 5.9.1.

0 = Disabled

1 = Enabled

**Bit 1: Output Clock 2 Enable (OC2EN).** This bit enables and disables the output clock 2 drivers, output dividers, phase adjustment/alignment circuitry and start/stop circuitry. See section 5.9.1.

0 = Disabled

1 = Enabled

**Bit 0: Output Clock 1 Enable (OC1EN).** This bit enables and disables the output clock 1 drivers, output dividers, phase adjustment/alignment circuitry and start/stop circuitry. See section 5.9.1.

0 = Disabled

1 = Enabled



| Register Name:        | GPIOCR1                       |
|-----------------------|-------------------------------|
| Register Description: | GPIO Configuration Register 1 |
| Register Address:     | 0Eh                           |

|         | Bit 7       | Bit 6 | Bit 5 | Bit 4 | Bit 3       | Bit 2 | Bit 1 | Bit 0 |
|---------|-------------|-------|-------|-------|-------------|-------|-------|-------|
| Name    | GPIO1C[3:0] |       |       |       | GPIO0C[3:0] |       |       |       |
| Default | 0           | 0     | 0     | 0     | 0           | 0     | 0     | 0     |

**Bits 7 to 4: GPIO1 Configuration (GPIO1C[3:0]).** This field configures the GPIO1 pin as a general-purpose input, a general-purpose output driving low or high, or a status output. The current state of the pin can be read from GPIOSR.GPIO1. When GPIO1 is a status output, the GPIO1SS register specifies which status bit is output.

0000 = General-purpose input

0001 = General-purpose input - inverted polarity

0010 = General-purpose output driving low

0011 = General-purpose output driving high

0100 = Status output - non-inverted polarity

0101 = Status output - inverted polarity of the status bit it follows

0110 = Status output - 0 drives low, 1 high impedance

0111 = Status output – 0 high impedance, 1 drives low

 $1000 \text{ to } 1111 = \{\text{unused values}\}$ 

**Bits 3 to 0: GPIO0 Configuration (GPIO0C[3:0]).** This field configures the GPIO0 pin as a general-purpose input, a general-purpose output driving low or high, or a status output. The current state of the pin can be read from GPIOSR.GPIO0. When GPIO0 is a status output, the GPIO0SS register specifies which status bit is output.

0000 = General-purpose input

0001 = General-purpose input - inverted polarity

0010 = General-purpose output driving low

0011 = General-purpose output driving high

0100 = Status output – non-inverted polarity

0101 = Status output – inverted polarity of the status bit it follows

0110 =Status output - 0 drives low, 1 high impedance

0111 = Status output - 0 high impedance, 1 drives low

 $1000 \text{ to } 1111 = \{\text{unused values}\}$ 

| Register Name:        | GPIOCR2                       |
|-----------------------|-------------------------------|
| Register Description: | GPIO Configuration Register 2 |
| Register Address:     | 0Fh                           |

|         | Bit 7       | Bit 6 | Bit 5 | Bit 4 | Bit 3       | Bit 2 | Bit 1 | Bit 0 |
|---------|-------------|-------|-------|-------|-------------|-------|-------|-------|
| Name    | GPIO3C[3:0] |       |       |       | GPIO2C[3:0] |       |       |       |
| Default | 0           | 0     | 0     | 0     | 0           | 0     | 0     | 0     |

These fields are identical to those in GPIOCR1 except they control GPIO2 and GPIO3.



Register Name: Register Description: Register Address: GPIO0SS GPIO0 Status Select Register 12h

|         | Bit 7 | Bit 6 | Bit 5    | Bit 4 | Bit 3 | Bit 2 | Bit 1    | Bit 0 |
|---------|-------|-------|----------|-------|-------|-------|----------|-------|
| Name    |       |       | REG[4:0] |       |       |       | BIT[2:0] |       |
| Default | 0     | 0     | 0        | 0     | 0     | 0     | 0        | 0     |

**Bits 7 to 3: Status Register (REG[4:0]).** When GPIOCR1.GPIO0C=01xx, this field specifies the register of the status bit that GPIO0 will follow while the BIT field below specifies the status bit within the register. Setting the combination of this field and the BIT field below to follow a bit that isn't implemented as a real-time or latched status register bit results in GPIO0 being driven low. The address of the status bit that GPIO0 follows is 0x40 + REG[4:0]

**Bits 2 to 0: Status Bit (BIT[2:0]).** When GPIOCR1.GPIO0C=01xx, the REG field above specifies the register of the status bit that GPIO0 will follow while this field specifies the status bit within the register. Setting the combination of the REG field and this field to point to a bit that isn't implemented as a real-time or latched status register bit results in GPIO1 being driven low. 000=bit 0 of the register. 111=bit 7 of the register.

Note: The device does not allow status register bit ICxSR.LOS to be followed by a GPIO because the source of this bit could be the same GPIO. Also, the device does not allow the GPIO status register bits in GPIOSR to be followed by a GPIO.

| Register Name:        | GPIO1SS                      |
|-----------------------|------------------------------|
| Register Description: | GPIO1 Status Select Register |
| Register Address:     | 13h                          |

|         | Bit 7    | Bit 6 | Bit 5 | Bit 4 | Bit 3    | Bit 2 | Bit 1 | Bit 0 |
|---------|----------|-------|-------|-------|----------|-------|-------|-------|
| Name    | REG[4:0] |       |       |       | BIT[2:0] |       |       |       |
| Default | 0        | 0     | 0     | 0     | 0        | 0     | 0     | 0     |

These fields are identical to those in GPIO0SS except they control GPIO1.

| Register Name:        | GPIO2SS                             |
|-----------------------|-------------------------------------|
| Register Description: | <b>GPIO2 Status Select Register</b> |
| Register Address:     | 14h                                 |

|         | Bit 7    | Bit 6 | Bit 5 | Bit 4 | Bit 3    | Bit 2 | Bit 1 | Bit 0 |
|---------|----------|-------|-------|-------|----------|-------|-------|-------|
| Name    | REG[4:0] |       |       |       | BIT[2:0] |       |       |       |
| Default | 0        | 0     | 0     | 0     | 0        | 0     | 0     | 0     |

These fields are identical to those in GPIO0SS except they control GPIO2.

| Register Name:        | GPIO3SS                      |
|-----------------------|------------------------------|
| Register Description: | GPIO3 Status Select Register |
| Register Address:     | 15h                          |

|         | Bit 7 | Bit 6 | Bit 5    | Bit 4    | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|----------|----------|-------|-------|-------|-------|
| Name    |       |       | REG[4:0] | BIT[2:0] |       |       |       |       |
| Default | 0     | 0     | 0        | 0        | 0     | 0     | 0     | 0     |

These fields are identical to those in GPIO0SS except they control GPIO3.



Register Name: Register Description: Register Address: PACR1 Phase Adjust Configuration Register 1 1Bh

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|-------|-------|-------|-------|
| Name    | RST   | TRIG  | ARM   | _     | _     | _     | TINV  | MODE  |
| Default | 0     | 0     | 0     | 0     | 0     | 0     | 0     | 0     |

**Bit 7: Phase Adjustment Reset Bit (RST).** This bit is used to reset the phase adjustment state machine. This is used to abort a phase adjustment after arming but before the trigger occurs. Resetting puts the state machine back to waiting for an arm signal. This bit is self-clearing. See section 5.9.4.

1 = Reset a phase adjustment event in progress, self clearing

**Bit 6: Phase Adjustment Trigger Bit (TRIG).** This bit is used to trigger the phase adjustment event when PACR2.TRGSRC=0000 and the phase adjustment has been armed. This bit is self-clearing and must be written again to cause another trigger. When the ARM bit and TRIG bit are selected as the sources for arming and triggering, respectively, the ARM bit must be set first then the TRIG bit can be set in a subsequent register write to initiate a trigger event. See section 5.9.4.

1 = Trigger a phase adjustment, self clearing

Note: For (1) phase adjustment when any OCx output's MSDIV period is less than master clock period, or (2) phase alignment when device is in APLL-only mode and any OCx output has MSDIV period + 7 x HSDIV period < 15.38ns, this bit may or may not self-clear depending on exact device configuration and therefore must be cleared by system software for proper operation.

**Bit 5: Phase Adjustment Arm Bit (ARM).** When PACR2.ARMSRC=0001, setting this bit to 1 while PASR.ARMED=0 arms the phase adjustment. Writing a 0 to this bit has no effect. Changing the value of this bit from 0 to 1 while PASR.ARMED=1 has no effect. See section 5.9.4.

1 = Arm the phase adjustment, self clearing

**Bit 1: Phase Adjustment Trigger Invert (TINV).** This bit specifies the polarity of the trigger signal. See section 5.9.4.

0 = Trigger signal normal polarity

1 = Trigger signal inverted

**Bit 0: Phase Adjust/Alignment Mode (MODE).** This field sets the mode of the phase change. In output phase *alignment* mode, the device resets the MSDIV and LSDIV dividers for all participating outputs so that they are all aligned and then adjusts the phase of each participating output as specified in the OCxPH register. In output phase *adjustment* mode the device does not reset the MSDIV and LSDIV dividers and therefore causes each participating output to have the phase adjustment specified in the OCxPH register relative to that output's previous phase. See section 5.9.4.

0 = Phase alignment mode

1 = Phase adjustment mode



| Register | Name:        |
|----------|--------------|
| Register | Description: |
| Register | Address:     |

PACR2 Phase Adjust Configuration Register 2 1Ch

|         | Bit 7       | Bit 6 | Bit 5 | Bit 4       | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------------|-------|-------|-------------|-------|-------|-------|-------|
| Name    | ARMSRC[3:0] |       |       | TRGSRC[3:0] |       |       |       |       |
| Default | 0           | 0     | 0     | 0           | 0     | 0     | 0     | 0     |

Bits 7 to 4: Output Phase Adjustment Arm Source (ARMSRC[3:0]). This field selects the source of the phase adjustment arming signal. See section 5.9.4.

 $0000 = \{\text{do not use}\}$ 

0001 = PACR1.ARM bit (one-shot)

0010 = APLL transition from unlocked to locked

0011 = DPLL transition from unlocked to locked

0100 to 0111 = {unused values}

1000 = GPIO0 transition (see note below)

1001 = GPIO1 transition

1010 = GPIO2 transition

1011 = GPIO3 transition

1100 to 1111 = {unused values}

Bits 3 to 0: Output Phase Adjustment Trigger Source (TRGSRC[3:0]). This field selects the source of the phase adjustment trigger signal. The phase adjustment must be armed or the trigger signal is ignored. The trigger source transition initiates the phase adjustment event. See section 5.9.4.

0000 = PACR1.TRIG bit 0001 = APLL transition from unlocked to locked 0010 = DPLL transition from unlocked to locked 0011 = DPLL input clock rising edge (after PFD divider) 0100 to 0111 = {unused values} 1000 = GPIO0 transition (see note below) 1001 = GPIO1 transition 1010 = GPIO2 transition 1011 = GPIO3 transition 1100 to 1111 = {unused values}

**Note**: In both fields above the GPIO transitions are 0-to-1 when GPIOCR1.GPIOxC=0000 and 1-to-0 when GPIOCR1.GPIOxC=0001.



MABCR1 Measure A-to-B Configuration Register 1 1Dh

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1      | Bit 0 |
|---------|-------|-------|-------|-------|-------|-------|------------|-------|
| Name    | RST   | START | _     | _     | _     |       | TBSRC[2:0] |       |
| Default | 0     | 0     | 0     | 0     | 0     | 0     | 0          | 0     |

**Bit 7: Measurement Reset (RST).** This field stops the current A-to-B phase measurement. This bit is self clearing. See section 5.9.6.

1 = Stop measurement (self-clearing)

**Bit 6: Measurement Start (START).** This field starts a new A-to-B phase measurement. This bit is self clearing. See section 5.9.6.

1 = Start new measurement (self-clearing)

Bits 2 to 0: Measurement Time Base Source (TBSRC[2:0]). This field selects the source of the measurement time base. See section 5.9.6.

000 = External oscillator

In DPLL+APLL mode this is the signal on XA (if an external XO is used) or the crystal frequency doubled (if a crystal is used). In APLL-only mode this option should not be used.

001 = Medium-speed divider 1 (MSDIV1) output clock

010 = Medium-speed divider 2 (MSDIV2) output clock

011 = Medium-speed divider 3 (MSDIV3) output clock

| Register Name:                             | MABCR2                                  |
|--|---|
| Register Description:<br>Register Address: | Measure A-to-B Configuration Register 2 |
| Register / dal beer                        |   |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2     | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|-------|-----------|-------|-------|
| Name    | AINV  | _     | _     |       |       | ASRC[4:0] |       |       |
| Default | 0     | 0     | 0     | 0     | 0     | 0         | 0     | 0     |

**Bit 7: Measurement Input A Invert (AINV).** This field inverts the signal of measurement input A. See section 5.9.6.

0 = Measure to and from rising edge of input A

1 = Measure to and from falling edge of input A

Bits 4 to 0: Measurement Input A Source (ASRC[4:0]). This field selects the source of measurement input A. See section 5.9.6.

00000=IC1 00001=IC2 00010=IC3 01000 = GPIO0 01001 = GPIO1 01010 = GPIO2 01011 = GPIO3 10000=OC1 10001=OC2 10010=OC3



MABCR3 Measure A to B Configuration Register 3 1Fh

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2     | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|-------|-----------|-------|-------|
| Name    | BINV  | _     | _     |       |       | BSRC[4:0] |       |       |
| Default | 0     | 0     | 0     | 0     | 0     | 0         | 0     | 0     |

Bit 7: Measurement Input B Invert (BINV). This field inverts the signal of measurement input B. See section 5.9.6.

0 = Measure to and from rising edge of input B

1 = Measure to and from falling edge of input B

Bits 4 to 0: Measurement Input B Source (BSRC[4:0]). This field selects the source of measurement input B. See section 5.9.6.

00000=IC1 0001=IC2 00010=IC3 01000 = GPIO0 01001 = GPIO1 01010 = GPIO2 01011 = GPIO3 10000=OC1 10001=OC2 10010=OC3

## 6.3.2 Status Registers

Register Name:ID1Register Description:Device Identification Register, MSBRegister Address:30h

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|-------|-------|-------|-------|
| Name    |       |       |       | IDU   | [7:0] |       |       |       |
| Default | 0     | 0     | 0     | 1     | 1     | 0     | 0     | 1     |

Bits 7 to 0: Device ID Upper (IDU[7:0]). This field is the upper eight bits of the device ID.

| Register Name:<br>Register Description:<br>Register Address: |       | Dev        | ID2<br>Device Identification Register, LSB and Revision<br>31h |       |          |       |       |       |  |  |
|--|-------|------------|--|-------|----------|-------|-------|-------|--|--|
|  | Bit 7 | Bit 6      | Bit 5  | Bit 4 | Bit 3    | Bit 2 | Bit 1 | Bit 0 |  |  |
| Name   |       | <u>IDL</u> | 3:0]   |       | REV[3:0] |       |       |       |  |  |
| Default  | 0     | 1          | 0  | 1     | 0        | 0     | 0     | 1     |  |  |

Bits 7 to 4: Device ID Lower (IDL[3:0]). This field is the lower four bits of the device ID.

Bits 3 to 0: Device Revision (REV[3:0]). These bits are the device hardware revision starting at 0.



Register Name: Register Description: Register Address: CFGSR Configuration Status Register 40h

|         | Bit 7     | Bit 6  | Bit 5 | Bit 4 | Bit 3      | Bit 2     | Bit 1     | Bit 0     |
|---------|-----------|--------|-------|-------|------------|-----------|-----------|-----------|
| Name    | TEST      | XOFAIL | —     | —     | <u>IF[</u> | 1:0]      | AC        | 1:0]      |
| Default | see below | 0      | 0     | 0     | see below  | see below | see below | see below |

**Bit 7: Test Mode (TEST).** This read-only bit is the latched state of the TEST/GPIO2 pin when the RSTN pin transitions high. For proper operation it should be 0. See section 5.3.

**Bit 6: XO Fail (XOFAIL).** This read-only bit is set when the external oscillator signal on the XA pin fails or when the crystal connected to the XA/XB pins fails to oscillate. When the ring oscillator is disabled (MCR1.ROSCD=1) this bit is always 0.

Bits 3 to 2: Interface Mode (IF[1:0]). These read-only bits are the latched state of the IF1/MISO and IF0/CSN pins when the RSTN pin transitions high. See section 5.3.

**Bits 1 to 0: Auto-Configuration (AC[1:0]).** These read-only bits are the latched state of the AC1/GPIO1 and AC0/GPIO0 pins when the RSTN pin transitions high. See section 5.3.

| Register Name:        | GPIOSR               |
|-----------------------|----------------------|
| Register Description: | GPIO Status Register |
| Register Address:     | 41h                  |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3        | Bit 2        | Bit 1        | Bit 0        |
|---------|-------|-------|-------|-------|--------------|--------------|--------------|--------------|
| Name    | —     | —     | _     | —     | <u>GPIO3</u> | <u>GPIO2</u> | <u>GPI01</u> | <u>GPIO0</u> |
| Default | 0     | 0     | 0     | 0     | 0            | 0            | 0            | 0            |

**Bit 3: GPIO3 State (GPIO3).** This real-time status bit indicates the current state of the GPIO3 pin, not influenced by any inversion that may be specified by GPIOCR2.GPIO3C.

0 = low

1 = high

Bit 2: GPIO2 State (GPIO2). This real-time status bit indicates the current state of the GPIO2 pin, not influenced by inversion that may be specified by GPIOCR2.GPIO2C.

0 = low

1 = high

Bit 1: GPIO1 State (GPIO1). This real-time status bit indicates the current state of the GPIO1 pin, not influenced by inversion that may be specified by GPIOCR1.GPIO1C.

0 = low

1 = high

Bit 0: GPIO0 State (GPIO0). This real-time status bit indicates the current state of the GPIO0 pin, not influenced by inversion that may be specified by GPIOCR1.GPIO0C.

0 = low

1 = high



| Register Name:        | INTSR                     |
|-----------------------|---------------------------|
| Register Description: | Interrupt Status Register |
| Register Address:     | 42h                       |

|         | Bit 7 | Bit 6 | Bit 5     | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-----------|-------|-------|-------|-------|-------|
| Name    | _     | GLOB  | <u>00</u> | IC    | DPLL  | APLL  | INTIE | INT   |
| Default | 0     | 0     | 0         | 0     | 0     | 0     | 0     | 0     |

Bit 6: Global Interrupt Status (GLOB). This read-only bit is set if any of the global interrupt status bits are set in the GLOBISR register. See section 5.11.

**Bit 5: Output Clock Interrupt Status (OC).** This read-only bit is set if any of the output clock interrupt status bits are set in the OCISR register. See section 5.11.

**Bit 4: Input Clock Interrupt Status (IC).** This read-only bit is set if any of the input clock interrupt status bits are set in the ICISR register. See section 5.11.

**Bit 3: DPLL Interrupt Status (DPLL).** This read-only bit is set if any of the DPLL interrupt status bits are set in the DPLLISR register. See section 5.11.

**Bit 2: APLL Interrupt Status (APLL).** This read-only bit is set if any of the APLL interrupt status bits are set in the APLLISR register. See section 5.11.

**Bit 1: Interrupt Enable Bit (INTIE).** This is the global interrupt enable bit. When this bit is 0 all interrupt sources are prevented from setting the INT global interrupt status bit (below). See section 5.11.

0 = Interrupts are disabled at the global level

1 = Interrupts are enabled at the global level

**Bit 0: Interrupt Status (INT).** This read-only bit is set when any of the GLOB, OC, IC, DPLL or APLL bits in this INTSR register are set A the INTIE bit is set. This bit can cause an interrupt request when set by configuring one of the GPIO pins to follow it. See section 5.11.

0 = No interrupt

1 = An unmasked interrupt source is active

| Register Name:        | GLOBISR                                    |
|-----------------------|--|
| Register Description: | Global Functions Interrupt Status Register |
| Register Address:     | 43h  |

|         | Bit 7     | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-----------|-------|-------|-------|-------|-------|-------|-------|
| Name    | BCDONE    | —     | _     | _     | _     | _     | PA    | MAB   |
| Default | see below | 0     | 0     | 0     | 0     | 0     | 0     | 0     |

**Bit 7: Boot Controller Done (BCDONE).** This bit indicates the status of the on-chip boot controller, which performs auto-configuration from EEPROM. It is cleared when the device is reset and set after the boot controller finishes auto-configuration of the device. See section 5.14.

**Bit 1: Phase Adjust Interrupt Status (PA).** This bit indicates the current status of the interrupt sources from the phase adjust function (see section 5.9.4). It is set when any latched status bit in the PASR register is set and the associated interrupt enable bit is also set. See section 5.11.

**Bit 0: Measure AB Interrupt Status (MAB).** This bit indicates the current status of the interrupt sources from the A-to-B phase offset measurement function (see section 5.9.6). It is set when any latched status bit in the MABSR1 register is set and the associated interrupt enable bit is also set. See section 5.11.



| Register Name:        | ICISR                                 |
|-----------------------|---------------------------------------|
| Register Description: | Input Clock Interrupt Status Register |
| Register Address:     | 44h                                   |
|                       |                                       |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1      | Bit 0      |
|---------|-------|-------|-------|-------|-------|-------|------------|------------|
| Name    | _     | _     | —     | —     | —     | IC3   | <u>IC2</u> | <u>IC1</u> |
| Default | 0     | 0     | 0     | 0     | 0     | 0     | 0          | 0          |

**Bit 2: Input Clock 3 Interrupt Status (IC3).** This bit indicates the current status of the interrupt sources for IC3. This bit is set when latched status VALSR2.IC3L is set and the associated interrupt enable bit is also set. See section 5.11.

**Bit 1: Input Clock 2 Interrupt Status (IC2).** This bit indicates the current status of the interrupt sources for IC2. This bit is set when latched status VALSR1.IC2L is set and the associated interrupt enable bit is also set. See section 5.11.

**Bit 0: Input Clock 1 Interrupt Status (IC1).** This bit indicates the current status of the interrupt sources for IC1. This bit is set when latched status VALSR1.IC1L is set and the associated interrupt enable bit is also set. See section 5.11.

| Register Name:        | OCISR                                  |
|-----------------------|--|
| Register Description: | Output Clock Interrupt Status Register |
| Register Address:     | 45h                                    |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2      | Bit 1      | Bit 0      |
|---------|-------|-------|-------|-------|-------|------------|------------|------------|
| Name    | —     | _     | _     | _     | —     | <u>OC3</u> | <u>OC2</u> | <u>OC1</u> |
| Default | 0     | 0     | 0     | 0     | 0     | 0          | 0          | 0          |

**Bit 2: Output Clock 3 Interrupt Status (OC3).** This bit indicates the current status of the interrupt sources for OC3. It is set when any latched status bit in the OC3SR register is set and the associated interrupt enable bit is also set. See section 5.11.

Bit 1: Output Clock 2 Interrupt Status (OC2). This bit indicates the current status of the interrupt sources for OC2. It is set when any latched status bit in the OC2SR register is set and the associated interrupt enable bit is also set. See section 5.11.

**Bit 0: Output Clock 1 Interrupt Status (OC1).** This bit indicates the current status of the interrupt sources for OC1. It is set when any latched status bit in the OC1SR register is set and the associated interrupt enable bit is also set. See section 5.11.

| Register Name:        | APLLISR                        |
|-----------------------|--------------------------------|
| Register Description: | APLL Interrupt Status Register |
| Register Address:     | 46h                            |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|-------|-------|-------|-------|
| Name    |       | —     | _     | _     | _     | _     | _     | APLL  |
| Default | 0     | 0     | 0     | 0     | 0     | 0     | 0     | 0     |

**Bit 0: APLL Interrupt Status (APLL).** This bit indicates the current status of the interrupt sources for the APLL. It is set when any latched status bit in the APLLSR register is set and the associated interrupt enable bit is also set. See section 5.11.



| Register Name:        | DPLLISR                        |
|-----------------------|--------------------------------|
| Register Description: | DPLL Interrupt Status Register |
| Register Address:     | 47h                            |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|-------|-------|-------|-------|
| Name    | —     | _     | _     | _     | —     | —     | —     | DPLL  |
| Default | 0     | 0     | 0     | 0     | 0     | 0     | 0     | 0     |

**Bit 0: DPLL Interrupt Status (DPLL).** This bit indicates the current status of the interrupt sources for the DPLL. It is set when any latched status bit in the DSRL1 or DSRL2 register is set and the associated interrupt enable bit in the DSRIE1 or DSRIE2 register is also set. See section 5.11.

| Register Name:        | APLLSR               |
|-----------------------|----------------------|
| Register Description: | APLL Status Register |
| Register Address:     | 48h                  |

|         | Bit 7 | Bit 6  | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0      |
|---------|-------|--------|-------|-------|-------|-------|-------|------------|
| Name    | _     | ALK2IE | ALK2L | ALK2  | ADLK  | ALKIE | ALKL  | <u>ALK</u> |
| Default | 0     | 0      | 0     | 0     | 0     | 0     | 0     | 0          |

Bit 6: APLL Lock 2 Interrupt Enable (ALK2IE). This bit enables the ALK2L latched status bit to send an interrupt request into device's interrupt logic.

0 = Interrupt is disabled

1 = Interrupt is enabled

**Bit 5: APLL Lock 2 Latched Status (ALK2L).** This latched status bit is set to 1 when the ALK2 status bit changes state (set or cleared). ALK2L is cleared when written with a 1. When ALK2L is set it can cause an interrupt request if the ALK2IE interrupt enable bit is set.

**Bit 4: APLL Lock Status 2 (ALK2).** This real-time status bit provides one type of APLL lock status. System software should consider the APLL locked when ALK (bit 0) is set to 1 AND ALK2=1. See section 5.8.2.

Bit 3: Both APLL and DPLL Locked (ADLK). This real-time status bit indicates when both the APLL and the DPLL are locked.

1 = APLL is locked and DPLL is locked

**Bit 2: APLL Lock Interrupt Enable (ALKIE).** This bit enables the ALKL latched status bit to send an interrupt request into device's interrupt logic.

- 0 = Interrupt is disabled
- 1 = Interrupt is enabled

**Bit 1: APLL Lock Latched Status (ALKL).** This latched status bit is set to 1 when the ALK status bit changes state (set or cleared). ALKL is cleared when written with a 1. When ALKL is set it can cause an interrupt request if the ALKIE interrupt enable bit is set.

**Bit 0: APLL Lock Status (ALK).** This real-time status bit indicates one type of APLL lock status. System software should consider the APLL locked when ALK=1 AND ALK2 (bit 4) is set to 1. See section 5.8.2.

0 = Not locked

1 = Locked



| <b>Register Name</b> | :        |
|----------------------|----------|
| <b>Register Desc</b> | ription: |
| <b>Register Addr</b> | ess:     |

PTAB1 Priority Table Register 1 49h

|         | Bit 7 | Bit 6 | Bit 5     | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0   |
|---------|-------|-------|-----------|-------|-------|-------|-------|---------|
| Name    | _     | _     | REF1[1:0] |       | _     | _     | SELRE | EF[1:0] |
| Default | 0     | 0     | 0         | 0     | 0     | 0     | 0     | 0       |

Bits 5 to 4: Highest Priority Valid Reference (REF1[1:0]). This real-time status field indicates the DPLL's highest-priority valid input reference. Note that an input reference cannot be indicated in this field if it has been marked invalid in the VALCR1 register. When input switching is nonrevertive (ICSCR1.REVERT=0) this field may not have the same value as the SELREF field. See section 5.6.3.2.

00 = No valid input reference available

- 01 = IC1 input
- 10 = IC2 input
- 11 = IC3 input

Bits 1 to 0: Selected Reference (SELREF[1:0]). This real-time status field indicates the DPLL's current selected reference. Note that an input clock cannot be indicated in this field if it has been marked invalid in the VALCR1. When input switching is nonrevertive (ICSCR1.REVERT=0) this field may not have the same value as the REF1[3:0] field. See section 5.6.3.2.

00 = No valid input reference available 01 = IC1 input

- 10 = IC2 input
- 11 = IC3 input

| Register Name:        | PTAB2                     |
|-----------------------|---------------------------|
| Register Description: | Priority Table Register 2 |
| Register Address:     | 4Ah                       |

|         | Bit 7 | Bit 6 | Bit 5      | Bit 4  | Bit 3 | Bit 2 | Bit 1 | Bit 0  |
|---------|-------|-------|------------|--------|-------|-------|-------|--------|
| Name    | —     | —     | <u>REF</u> | 3[1:0] | —     | —     | REF2  | 2[1:0] |
| Default | 0     | 0     | 0          | 0      | 0     | 0     | 0     | 0      |

Bits 5 to 4: Third Highest Priority Valid Reference (REF3[1:0]). This real-time status field indicates the DPLL's third highest-priority valid input reference. Note that an input reference cannot be indicated in this field if it has been marked invalid in the VALCR1 register. See section 5.6.3.2.

00 = No valid input reference available

- 01 = IC1 input
- 10 = IC2 input
- 11 = IC3 input

Bits 1 to 0: Second Highest Priority Valid Reference (REF2[1:0]). This real-time status field indicates the DPLL's second highest priority validated input reference. Note that an input reference cannot be indicated in this field if it has been marked invalid in the VALCR1 register. See section 5.6.3.2.

00 = No valid input reference available

- 01 = IC1 input
- 10 = IC2 input
- 11 = IC3 input



Default

MABSR1 Measure A to B Status Register 1 4Bh

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1      | Bit 0 |
|---------|-------|-------|-------|-------|-------|-------|------------|-------|
| Name    | —     | OVFL  | RDYIE | RDYL  | BUSY  |       | MEAS[10:8] |       |
| Default | 0     | 0     | 0     | 0     | 0     | 0     | 0          | 0     |

**Bit 6: Measurement Overflow (OVFL).** This latched status bit is set when the phase measurement is ready and an overflow has occurred. See section 5.9.6.

0 = No measurement overflow, MEAS is a valid value

1 = A measurement overflow occured, MEAS is not a valid value

Bit 5: Measurement Ready Interrupt Enable (RDYIE). This bit enables the RDYL latched status bit to send an interrupt request into device's interrupt logic.

0 = Interrupt is disabled

1 = Interrupt is enabled

**Bit 4: Measurement Ready (RDYL).** This latched status bit is set when a new phase measurement is ready. See section 5.9.6.

0 = New measurement not ready

1 = A new measurement in MEAS is ready

Bit 3: Measurement Busy (BUSY). This real-time status bit is set when a new phase measurement is being performed. See section 5.9.6.

0 = A measurement is not being performed

0

1 = A measurement is being performed

0

Bits 2 to 0: Measurement Value (MEAS[10:8]). See the MABSR2 register description.

0

| Register Name<br>Register Desc<br>Register Addre | ription: | MAB<br>Meas<br>4Ch |       | Status Regist | er 2    |       |       |       |
|--|----------|--------------------|-------|---------------|---------|-------|-------|-------|
|  | Bit 7    | Bit 6              | Bit 5 | Bit 4         | Bit 3   | Bit 2 | Bit 1 | Bit 0 |
| Name   |          |                    |       | ME            | AS[7:0] |       |       |       |

0

0

0

0

0

**Bits 7 to 0: Measurement Value (MEAS[7:0]).** The full 11-bit MEAS[10:0] field spans this register and the lower bits of MABSR1. The format is 2's-complement. This field indicates the result of the A-to-B measurement when BUSY=0, RDYL=1 and OVFL=0. Its value is in units of the selected time-base period and has a range of +1023 to -1024 periods. See section 5.9.6.



PASR Phase Adjust Status Register 4Dh

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|-------|-------|-------|-------|
| Name    | _     |       | _     | _     | ADJIE | ADJL  | BUSY  | ARMED |
| Default | 1     | 0     | 0     | 0     | 0     | 1     | 0     | 0     |

Bit 3: Phase Adjustment Finished Interrupt Enable (ADJIE). This bit enables the ADJL latched status bit to send an interrupt request into the device's interrupt logic.

0 =Interrupt is disabled

1 =Interrupt is enabled

**Bit 2: Phase Adjustment Finished (ADJL).** This latched status bit is set when the output phase adjustment is completed for all participating outputs. Writing a 1 to this bit clears it. See section 5.9.4.

0 = Output phase adjustment has not completed

1 = Output phase adjustment has completed

Note: For (1) phase adjustment when any OCx output's MSDIV period is less than master clock period, or (2) phase alignment when device is in APLL-only mode and any OCx output has MSDIV period + 7 x HSDIV period < 15.38ns, this bit may or may not be set depending on exact device configuration and therefore should not be checked by system software. Instead the state of the BUSY real-time bit (bit 1) should be checked.

**Bit 1: Phase Adjustment Busy (BUSY).** This bit is a real time status that indicates that the output phase adjustment has been triggered and is in progress on the participating outputs. See section 5.9.4.

0 = Output phase adjustment is not in progress

1 = Output phase adjustment is in progress

**Bit 0: Phase Adjustment Armed (ARMED).** This bit is a real time status that indicates that the output phase adjustment is armed and waiting for a trigger. It is cleared when the trigger event occurs. See section 5.9.4.

0 = Output phase adjustment is not armed

1 = Output phase adjustment is armed

| Register Name:        | VALSR1                              |
|-----------------------|-------------------------------------|
| Register Description: | Input Clock Valid Status Register 1 |
| Register Address:     | 4Eh                                 |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4      | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|------------|-------|-------|-------|-------|
| Name    | _     | IC2IE | IC2L  | <u>IC2</u> | —     | IC1IE | IC1L  | IC1   |
| Default | 0     | 0     | 1     | 0          | 0     | 0     | 1     | 0     |

Bit 6: Input Clock 2 Valid Interrupt Enable (IC2IE). This bit enables the VALSR1.IC2L latched status bit to send an interrupt request into device's interrupt logic.

0 =Interrupt is disabled

1 = Interrupt is enabled

**Bit 5: Input Clock 2 Valid Latched Status (IC2L).** This latched status bit is set to 1 when the VALSR1.IC2 status bit changes state (set or cleared). This bit is cleared when written with a 1 and not set again until the VALSR1.IC2 bit changes state again. This bit can be the source of an interrupt request. See section 5.6.2.

- 0 = IC2 bit has not changed state since last cleared
- 1 = IC2 bit has changed state since last cleared



**Bit 4: Input Clock 2 Valid (IC2).** This real-time status bit is set to 1 when IC2 is valid (ICxSR.VALT=1 and ICxSR.LKTO=0). See section 5.6.2.

0 = Invalid

1 = Valid

Bit 2: Input Clock 1 Valid Interrupt Enable (IC1IE). This bit enables the VALSR1.IC1L latched status bit to send an interrupt request into device's interrupt logic.

0 =Interrupt is disabled

1 = Interrupt is enabled

**Bit 1: Input Clock 1 Valid Latched (IC1L).** This latched status bit is set to 1 when the VALSR1.IC1 status bit changes state (set or cleared). This bit is cleared when written with a 1 and not set again until the VALSR1.IC1 bit changes state again. This bit can be the source of an interrupt request. See section 5.6.2.

0 = IC1 bit has not changed state since last cleared

1 = IC1 bit has changed state since last cleared

**Bit 0: Input Clock 1 Valid (IC1).** This real-time status bit is set to 1 when IC1 is valid (ICxSR.VALT=1 and ICxSR.LKTO=0). See section 5.6.2.

0 = Invalid1 = Valid

| Register Name:        | VALSR2                              |
|-----------------------|-------------------------------------|
| Register Description: | Input Clock Valid Status Register 2 |
| Register Address:     | 4Fh                                 |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|-------|-------|-------|-------|
| Name    | _     | _     | _     | _     | _     | IC3IE | IC3L  | IC3   |
| Default | 0     | 0     | 0     | 0     | 0     | 0     | 1     | 0     |

**Bit 2: Input Clock 3 Valid Interrupt Enable (IC3IE).** This bit enables the VALSR2.IC3L latched status bit to send an interrupt request into device's interrupt logic.

0 = Interrupt is disabled

1 = Interrupt is enabled

**Bit 1: Input Clock 3 Valid Latched (IC3L).** This latched status bit is set to 1 when the VALSR2.IC3 status bit changes state (set or cleared). This bit is cleared when written with a 1 and not set again until the VALSR2.IC3 bit changes state again. This bit can be the source of an interrupt request. See section 5.6.2.

0 = IC3 bit has not changed state since last cleared

1 = IC3 bit has changed state since last cleared

**Bit 0: Input Clock 3 Valid (IC3).** This real-time status bit is set to 1 when IC3 is valid (ICxSR.VALT=1 and ICxSR.LKTO=0). See section 5.6.2.

0 = Invalid

1 = Valid



ICxSR Input Clock Status Register IC1: 50h, IC2: 51h, IC3: 52h

|         | Bit 7 | Bit 6       | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |  |
|---------|-------|-------------|-------|-------|-------|-------|-------|-------|--|
| Name    | LKCLR | <u>LKTO</u> | LOS   | ACVAL | PCVAL | PPVAL | VAL   | VALT  |  |
| Default | 0     | 0           | 0     | 1     | 1     | 1     | 0     | 0     |  |

Bit 7: Input Clock Lock Timeout Clear (LKCLR). This bit clears the LKTO bit when a 1 is written to it. LKCLR is self-clearing.

1 = Clear the LKTO status bit

**Bit 6: Input Clock Lock Timeout (LKTO).** This bit is set when ICx is the selected reference to the DPLL and the DPLL has not locked within the lock time-out duration. When LKTO=1 ICx is invalidated by forcing VALSR.ICx low. LKTO can be cleared by writing the LKCLR bit or automatically after a configurable period of time. See section 5.6.2.

0 = The input clock lock timeout has not occurred

1 = The input clock lock timeout has occurred

Bit 5: Input Clock Loss Of Signal (LOS). This real-time status bit follows the value of the LOS source selected by MONxCR2.LOSSS. See section 5.6.2.1.

0 = No loss of signal indicated from an external source

1 = Loss of signal indicated from an external source

**Bit 4: Input Clock Activity Monitor Valid (ACVAL).** This real-time status bit is high when the activity monitor indicates the input clock is valid and LOS=0. See section 5.6.2.

0 = Not valid

1 = Valid

**Bit 3: Input Clock Percent Frequency Offset Monitor Valid (PCVAL).** This real-time status bit is high when the percent frequency monitor indicates the input clock is valid and LOS=0 and ACVAL=1. See section 5.6.2.

0 = Not valid

1 = Valid

**Bit 2: Input Clock PPM Frequency Offset Monitor Valid (PPVAL).** This real-time status bit is high when the PPM frequency offset monitor indicates the input clock is valid and LOS=0 and ACVAL=1 and PCVAL=1. See section 5.6.2.

0 = Not valid 1 = Valid

**Bit 1: Input Clock Valid (VAL).** This real-time status bit is high when all of the input status bits indicate the input clock is valid (LKTO=0, LOS=0, ACVAL=1, PCVAL=1 and PPVAL=1). It is low when any of the status bits indicate the input clock is not valid. See section 5.6.2.2.

0 = The input clock is not valid

1 = The input clock is valid

**Bit 0: Input Clock Valid Timed (VALT).** This bit is set when the VAL bit has been set for the duration of the validation timer. It is cleared when the VAL bit clears. See section 5.6.2.2.

0 = The input clock has not been valid for the specified duration

1 = The input clock has been valid for the specified duration





OCxSR

Register Name: Register Description: Register Address:

Output Clock x Status Register OC1: 53h, OC2: 54h, OC3: 55h

|         | Bit 7   | Bit 6  | Bit 5 | Bit 4   | Bit 3  | Bit 2  | Bit 1    | Bit 0        |
|---------|---------|--------|-------|---------|--------|--------|----------|--------------|
| Name    | LSCLKIE | LSCLKL | LSCLK | STARTIE | STARTL | STOPIE | STOPL    | <u>STOPD</u> |
| Default | 0       | 0      | 0     | 0       | 0      | 0      | see note | see note     |

Bit 7: (LSCLKIE). This bit enables the LSCLKL latched status bit to send an interrupt request into device's interrupt logic.

0 = Interrupt is disabled

1 =Interrupt is enabled

**Bit 6: (LSCLKL).** This latched status bit is set when the low-speed divider output clock transitions low-to-high. Writing a 1 to this bit clears it.

0 = Low speed output clock has not transitioned low to high

1 = Low speed output clock has transitioned low to high

**Bit 5:** (LSCLK). This real-time status bit follows the level of the low-speed divider output clock when the OCxCR3.SRLSEN bit is set.

0 = LSCLK is high

1 = LSCLK is low

Bit 4: (STARTIE). This bit enables the STARTL latched status bit to send an interrupt request into device's interrupt logic.

0 = Interrupt is disabled

1 = Interrupt is enabled

**Bit 3: (STARTL).** This latched status bit is set when the output clock signal has been started after being stopped. Writing a 1 to this bit clears it. See section 5.9.5.

0 = Output clock signal has not resumed from being stopped

1 = Output clock signal has resumed from being stopped

Bit 2: (STOPIE). This bit enables the STOPL latched status bit to send an interrupt request into device's interrupt logic.

0 = Interrupt is disabled

1 = Interrupt is enabled

**Bit 1: (STOPL).** This latched status bit is set when the output clock signal has been stopped. Writing a 1 to this bit clears it. See section 5.9.5

0 = Output clock signal has not stopped

1 = Output clock signal has stopped

**Bit 0: (STOPD).** This real-time status bit is high when the output clock signal is stopped and low when the output clock is not stopped. See section 5.9.5

0 = Output clock signal is not stopped

1 = Output clock signal is stopped

**Note:** STOPL and STOPD are controlled by logic that does not have a clock at reset. Therefore their reset values are indeterminate. They will become 0 when the output clock path is configured and one of the high-speed clocks from the APLL is connected to the logic.



DSRR1 DPLL Status Register Real-Time 1 56h

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|-------|-------|-------|-------|
| Name    | _     | —     | LOL   | TRK   | HO    | —     | —     | —     |
| Default | 0     | 0     | 0     | 0     | 0     | 0     | 0     | 0     |

**Bit 5: DPLL Loss of Lock (LOL).** When the TRK bit is 1, this real-time status bit indicates whether the DPLL is locked to the selected reference or not locked (i.e. "loss of lock"). When TRK=0 this LOL bit has no meaning. See section 5.7.2.

0 = Locked

1 = Loss of lock

Bit 4: DPLL Tracking State (TRK). This real-time status bit indicates when the DPLL is in the tracking state. See section 5.7.2.

0 = Not tracking (see HO bit for additional state)

1 = Tracking (see LOL bit for additional state)

**Bit 3: DPLL Holdover State (HO).** When the TRK bit is 0, this real-time status bit indicates whether the DPLL is in the freerun state or the holdover state. When TRK=1 this HO bit has no meaning. See section 5.7.2.

0 = Freerun

1 = Holdover

| Register Name:        | DSRR2                            |
|-----------------------|----------------------------------|
| Register Description: | DPLL Status Register Real-Time 2 |
| Register Address:     | 57h                              |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1  | Bit 0 |
|---------|-------|-------|-------|-------|-------|-------|--------|-------|
| Name    | —     | _     | _     | NORUN | _     | FLIM  | FCHLIM | PSLIM |
| Default | 0     | 0     | 0     | 0     | 0     | 0     | 0      | 0     |

**Bit 4: DPLL Won't Run (NORUN).** The DPLL sets this bit to indicate that it refuses to run because the DSP code loaded into it is for another Microsemi part number. The DPLL stays in free-run mode until the device is reset and loaded with ZL30151 DSP code.

**Bit 2: DPLL Frequency Limited (FLIM).** This real-time status bit indicates when the DPLL is operating at its configured frequency offset limit. See section 5.7.3.

**Bit 1: DPLL Frequency Rate-of-Change Limiting Active (FCHLIM).** This real-time status bit indicates when the DPLL is actively limiting its frequency rate-of-change per its configured limit. See section 5.7.3.

**Bit 0: DPLL Phase-Slope Limiting Active (PSLIM).** This real-time status bit indicates when the DPLL is actively limiting its phase rate-of-change per its configured limit. See section 5.7.3.



DSRL1 DPLL Status Register Latched 1 59h

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|-------|-------|-------|-------|
| Name    | _     | —     | LOLL  | TRKL  | HOL   | _     | —     | _     |
| Default | 0     | 0     | 0     | 0     | 0     | 0     | 0     | 0     |

**Bit 5: DPLL Loss of Lock Latched Status (LOLL).** This latched status bit is set when DSRR1.LOL bit changes state. Writing a 1 to this bit clears it.

0 = LOL has not changed state

1 = LOL has changed state

**Bit 4: DPLL Tracking State Latched Status (TRKL).** This latched status bit is set when DSRR1.TRK bit changes state. Writing a 1 to this bit clears it.

0 = TRK has not changed state

1 = TRK has changed state

**Bit 3: DPLL Holdover State Latched Status (HOL).** This latched status bit is set when DSRR1.HO bit changes state. Writing a 1 to this bit clears it.

0 = HO has not changed state

1 = HO has changed state

| Register Name:        | DSRL2                          |
|-----------------------|--------------------------------|
| Register Description: | DPLL Status Register Latched 2 |
| Register Address:     | 5Ah                            |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1   | Bit 0  |
|---------|-------|-------|-------|-------|-------|-------|---------|--------|
| Name    | —     | —     | —     | _     | —     | FLIML | FCHLIML | PSLIML |
| Default | 0     | 0     | 0     | 0     | 0     | 0     | 0       | 0      |

**Bit 2: DPLL Frequency Limited (FLIML).** This latched status bit is set when DSRR2.FLIM bit changes state. Writing a 1 to this bit clears it.

0 = FLIM has not changed state

1 = FLIM has changed state

**Bit 1: DPLL Frequency Rate-of-Change Limiting Active (FCHLIML).** This latched status bit is set when DSRR2.FCHLIM bit changes state. Writing a 1 to this bit clears it.

0 = FCHLIM has not changed state

1 = FCHLIM has changed state

**Bit 0: DPLL Phase-Slope Limiting Active (PSLIML).** This latched status bit is set when DSRR2.PSLIM bit changes state. Writing a 1 to this bit clears it.

0 = PSLIM has not changed state

1 = PSLIM has changed state



Register Name: Register Description: Register Address: DSRIE1 DPLL Status Register Interrupt Enable 1 5Bh

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|-------|-------|-------|-------|
| Name    | _     | —     | LOLIE | TRKIE | HOIE  | _     | _     | —     |
| Default | 0     | 0     | 0     | 0     | 0     | 0     | 0     | 0     |

**Bit 5: DPLL Loss of Lock Interrupt Enable (LOLIE).** This interrupt enable bit enables the latched status bit DSRL1.LOLL to set the interrupt status bit DPLLISR.DPLL.

**Bit 4: DPLL Tracking State Interrupt Enable (TRKIE).** This interrupt enable bit enables the latched status bit DSRL1.TRKL to set the interrupt status bit DPLLISR.DPLL.

**Bit 3: DPLL Holdover State Interrupt Enable (HOIE).** This interrupt enable bit enables the latched status bit DSRL1.HOL to set the interrupt status bit DPLLISR.DPLL.

| Register Name:        | DSRIE2                                  |
|-----------------------|---|
| Register Description: | DPLL Status Register Interrupt Enable 2 |
| Register Address:     | 5Ch                                     |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2  | Bit 1    | Bit 0   |
|---------|-------|-------|-------|-------|-------|--------|----------|---------|
| Name    | —     | _     | _     | _     | _     | FLIMIE | FCHLIMIE | PSLIMIE |
| Default | 0     | 0     | 0     | 0     | 0     | 0      | 0        | 0       |

**Bit 2: DPLL Frequency Limited Interrupt Enable (FLIMIE).** This interrupt enable bit enables the latched status bit DSRL2.FLIML to set the interrupt status bit DPLLISR.DPLL.

**Bit 1: DPLL Frequency Rate-of-Change Limiting Active Interrupt Enable (FCHLIMIE).** This interrupt enable bit enables the latched status bit DSRL2.FCHLIML to set the interrupt status bit DPLLISR.DPLL.

Bit 0: DPLL Phase-Slope Limiting Active Interrupt Enable (PSLIMIE). This interrupt enable bit enables the latched status bit DSRL2.PSLIML to set the interrupt status bit DPLLISR.DPLL.



Register Name: Register Description: Register Address: DFREQ1 DPLL Frequency Status Register 1 65h

|         | Bit 7 | Bit 6     | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-----------|-------|-------|-------|-------|-------|-------|
| Name    |       | FREQ[7:0] |       |       |       |       |       |       |
| Default | 0     | 0         | 0     | 0     | 0     | 0     | 0     | 0     |

**Bits 7 to 0: DPLL Frequency Status (FREQ[7:0]).** The full 32-bit FREQ[31:0] field spans this register and the DFREQ2 to DFREQ4 registers and is a multiregister field (see section 6.1.3). This read-only field is a 2's-complement signed integer that expresses the offset the DPLL adds to FREQZ to get the DPLL's frequency tuning word.

The fractional frequency offset of the DPLL in ppm is 10<sup>6</sup> x FREQ / FREQZ.

Note that FREQ must be converted from 2's-complement to signed integer for use in the above expression. FREQZ is the 40-bit nominal frequency tuning word value in the DFREQZ registers.

**Register Name:** DFREQ2 **Register Description: DPLL Frequency Status Register 2 Register Address:** 66h Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 Bit 1 Bit 0 Bit 7 Name FREQ[15:8] 0 Default 0 0 0 0 0 0 0 Bits 7 to 0: DPLL Frequency Status (FREQ[15:8]). See the DFREQ1 register description. **Register Name:** DFREQ3 **Register Description: DPLL Frequency Status Register 3 Register Address:** 67h Bit 7 Bit 6 Bit 5 Bit 4 Bit 2 Bit 1 Bit 0 Bit 3 FREQ[23:16] Name Default 0 0 0 0 0 0 0 0 Bits 7 to 0: DPLL Frequency Status (FREQ[23:16]). See the DFREQ1 register description.

| Register Name:        | DFREQ4                           |
|-----------------------|----------------------------------|
| Register Description: | DPLL Frequency Status Register 4 |
| Register Address:     | 68h                              |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3   | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|---------|-------|-------|-------|
| Name    |       |       |       | FREQ  | [31:24] |       |       |       |
| Default | 0     | 0     | 0     | 0     | 0       | 0     | 0     | 0     |

Bits 7 to 0: DPLL Frequency Status (FREQ[31:24]). See the DFREQ1 register description.



Register Name:DPHASE1Register Description:DPLL Phase Status Register 1Register Address:7Dh

|         | Bit 7 | Bit 6      | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|------------|-------|-------|-------|-------|-------|-------|
| Name    |       | PHASE[7:0] |       |       |       |       |       |       |
| Default | 0     | 0          | 0     | 0     | 0     | 0     | 0     | 0     |

**Bits 7 to 0: DPLL Phase Status (PHASE[7:0]).** The full 32-bit PHASE[31:0] field spans this register and the DPHASE2 to DPHASE4 registers and is a multi-register field (see section 6.1.3). PHASE is a 2's-complement signed integer value that indicates the current value of the phase detector (i.e. the phase difference between DPLL output and DPLL input). This field expresses the phase difference in units of 2<sup>-10</sup>ns. Positive values represent input clock leading feedback clock (to the left on a scope).

| Register Name:        | DPHA |
|-----------------------|------|
| Register Description: | DPLL |
| Register Address:     | 7Eh  |

PHASE2 PLL Phase Status Register 2 Eh

|         | Bit 7       | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------------|-------|-------|-------|-------|-------|-------|-------|
| Name    | PHASE[15:8] |       |       |       |       |       |       |       |
| Default | 0           | 0     | 0     | 0     | 0     | 0     | 0     | 0     |

Bits 7 to 0: DPLL Phase Status (PHASE[15:8]). See the DPHASE1 register description.

| Register Name:        | DPHASE3                      |
|-----------------------|------------------------------|
| Register Description: | DPLL Phase Status Register 3 |
| Register Address:     | 7Fh                          |

|         | Bit 7        | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|--------------|-------|-------|-------|-------|-------|-------|-------|
| Name    | PHASE[23:16] |       |       |       |       |       |       |       |
| Default | 0            | 0     | 0     | 0     | 0     | 0     | 0     | 0     |

Bits 7 to 0: DPLL Phase Status (PHASE[23:16]). See DPHASE1 register description

| Register Name:        | DPHASE4                      |
|-----------------------|------------------------------|
| Register Description: | DPLL Phase Status Register 4 |
| Register Address:     | 80h                          |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3   | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|---------|-------|-------|-------|
| Name    |       |       |       | PHASE | [31:24] |       |       |       |
| Default | 0     | 0     | 0     | 0     | 0       | 0     | 0     | 0     |

Bits 7 to 0: DPLL Phase Status (PHASE[31:24]). See DPHASE1 register description



#### 6.3.3 APLL Configuration Registers

| Register Name:        | APLLCR1                       |
|-----------------------|-------------------------------|
| Register Description: | APLL Configuration Register 1 |
| Register Address:     | 100h                          |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1  | Bit 0 |
|---------|-------|-------|-------|-------|-------|-------|--------|-------|
| Name    | _     | —     | _     | _     | _     | ENHS2 | BYPHS2 | —     |
| Default | 0     | 0     | 0     | 0     | 0     | 0     | 0      | 0     |

Bit 2: Enable High-Speed Divider 2 (ENHS2). This bit is an enable/disable control for HSDIV2. When HSDIV2 is disabled, device power consumption is reduced as shown in Table 7. HSDIV2 is enabled when PLLEN.APLLEN=1, ENHS2=1 and APLLCR1.BYPHS2=0.

0 = Disable

1 = Enable

Bit 1: Bypass APLL and High-Speed Divider 2 (BYPHS2). This bit controls the mux immediately to the right of HSDIV2 in Figure 1. The mux that provides the bypass signal to this mux is controlled by APLLMUX and related fields in APLLCR3.

0 = No bypass

1 = Bypass

| Register Name:        | APLLCR2                       |
|-----------------------|-------------------------------|
| Register Description: | APLL Configuration Register 2 |
| Register Address:     | 101h                          |

|         | Bit 7 | Bit 6 | Bit 5   | Bit 4 | Bit 3 | Bit 2 | Bit 1   | Bit 0 |
|---------|-------|-------|---------|-------|-------|-------|---------|-------|
| Name    |       | HSDI\ | /2[3:0] |       |       | HSDI\ | /1[3:0] |       |
| Default | 0     | 0     | 0       | 0     | 0     | 0     | 0       | 0     |

Bits 7 to 4: APLL High-Speed Divider 2 (HSDIV2[3:0]). This field controls the APLL's high-speed divider 2 block (see Figure 11). See section 5.8.2.

| 0000 = Divide by 4   | 1000 = Divide by 8  |
|----------------------|---------------------|
| 0001 = Divide by 4.5 | 1001 = Divide by 9  |
| 0010 = Divide by 5   | 1010 = Divide by 10 |
| 0011 = Divide by 5.5 | 1011 = Divide by 11 |
| 0100 = Divide by 6   | 1100 = Divide by 12 |
| 0101 = Divide by 6.5 | 1101 = Divide by 13 |
| 0110 = Divide by 7   | 1110 = Divide by 14 |
| 0111 = Divide by 7.5 | 1111 = Divide by 15 |
| 0111 = Divide by 7.5 | 1111 = Divide by 15 |

Bits 3 to 0: APLL High-Speed Divider 1 (HSDIV1[3:0]). This field controls the APLL's high-speed divider 1 block (see Figure 11). See section 5.8.2.

| 0000 = Divide by 4   | 1000 = Divide by 8  |
|----------------------|---------------------|
| 0001 = Divide by 4.5 | 1001 = Divide by 9  |
| 0010 = Divide by 5   | 1010 = Divide by 10 |
| 0011 = Divide by 5.5 | 1011 = Divide by 11 |
| 0100 = Divide by  6  | 1100 = Divide by 12 |
| 0101 = Divide by 6.5 | 1101 = Divide by 13 |
| 0110 = Divide by 7   | 1110 = Divide by 14 |
| 0111 = Divide by 7.5 | 1111 = Divide by 15 |
|                      |                     |



APLLCR3 APLL Configuration Register 3 102h

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4                 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-----------------------|-------|-------|-------|-------|
| Name    | _     | EXTSW |       | ALTMUX[2:0] APLLMUX[2 |       |       |       |       |
| Default | 0     | 0     | 0     | 0                     | 0     | 0     | 0     | 0     |

**Bit 6: APLL External Switching Mode (EXTSW).** This bit enables APLL external reference switching mode. In this mode, if the selected GPIO signal is low the APLL input mux is controlled by APLLCR3.APLLMUX. If the selected GPIO signal is high the APLL input mux is controlled by APLLCR3.ALTMUX. MCR2.EXTSS specifies which GPIO pin controls this behavior. See section 5.8.1.1

**Bits 5 to 3: APLL Alternate Mux Control (ALTMUX[2:0]).** When APLLCR3.EXTSW=0 this field is ignored. When APLLCR3.EXTSW=1 and the selected GPIO signal is high, this field controls the APLL input muxes. In Figure 1 these are the mux below the DPLL and the mux to the right of the DPLL. See section 5.8.1.1.

000 = Crystal driver circuit if crystal is connected, otherwise XA input

- (clock frequency can be 2x if clock doubler enabled by MCR1.DBL=1)
- 001 = IC1 input
- 010 = IC2 input
- 011 = IC3 input

 $100-111 = \{unused values\}$ 

**Bits 2 to 0: APLL Mux Control (APLLMUX[2:0]).** By default this field controls the APLL input muxes. In Figure 1 these are the mux below the DPLL and the mux to the right of the DPLL. When APLLCR3.EXTSW=1 and the selected GPIO signal is high, this field is ignored, and the APLL's clock source is specified by APLLCR3.ALTMUX. See section 5.8.1.1. When APLLMUX=0xx the APLL input comes directly from an input clock pin and the DPLL can be powered down. See section 5.2. This field also controls the signal sent to the bypass mux, which is the mux immediately to the right of HSDIV2 in Figure 1.

000 = Crystal driver circuit if crystal is connected, otherwise XA input

(clock frequency can be 2x if clock doubler enabled by MCR1.DBL=1)

001 = IC1 input to the APLL and to the bypass mux

010 = IC2 input to the APLL and to the bypass mux

011 = IC3 input to the APLL and to the bypass mux

110 = DPLL output to the APLL, XA (optionally doubled) sent to the bypass mux

111 = DPLL output to the APLL, no signal sent to the bypass mux (set APLLCR1.BYPHS2=0)

The following decodes are for applications where the master clock comes from IC1 rather than XA (MCR1.MCSEL1=1).

100 = DPLL output to the APLL, IC1 sent to the bypass mux

101 = DPLL output to the APLL, no signal sent to the bypass mux(set APLLCR1.BYPHS2=0)



APLLCR4 APLL Configuration Register 4 103h

|         | Bit 7 | Bit 6 | Bit 5     | Bit 4 | Bit 3 | Bit 2 | Bit 1     | Bit 0 |
|---------|-------|-------|-----------|-------|-------|-------|-----------|-------|
| Name    | DECPH |       | PDSS[2:0] |       | INCPH |       | PISS[2:0] |       |
| Default | 0     | 0     | 0         | 0     | 0     | 0     | 0         | 0     |

**Bit 7: Decrement Phase (DECPH).** When PDSS=000, this bit is the APLL phase decrement control signal. See section 5.8.3. Decrement moves the signal earlier in time (to the left on a scope).

**Bits 6 to 4: Phase Decrement Source Select (PDSS[2:0]).** This field specifies the APLL phase decrement control signal. Every low-to-high transition and every high-to-low transition of the signal decrements the APLL's output phase. See section 5.8.3.

000 = DECPH bit 001 = GPI00 010 = GPI01 011 = GPI02 100 = GPI03 101 to 111 = {unused values}

**Bit 3: Increment Phase (INCPH).** When PISS=000, this bit is the APLL phase increment control signal. See section 5.8.3. Increment moved the signal later in time (to the right on a scope).

**Bits 2 to 0: Phase Increment Source Select (PISS[2:0]).** This field specifies the APLL phase increment control signal. Every low-to-high transition and every high-to-low transition of the signal increments the APLL's output phase. See section 5.8.3.

See section 5.8.3. 000 = INCPH bit 001 = GPIO0 010 = GPIO1 011 = GPIO2 100 = GPIO3 $101 to 111 = \{unused values\}$ 

| Register Name:        | AFBDIV1                          |
|-----------------------|----------------------------------|
| Register Description: | APLL Feedback Divider Register 1 |
| Register Address:     | 106h                             |

|         | Bit 7 | Bit 6       | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |  |
|---------|-------|-------------|-------|-------|-------|-------|-------|-------|--|
| Name    |       | AFBDIV[7:0] |       |       |       |       |       |       |  |
| Default | 0     | 0           | 0     | 0     | 0     | 0     | 0     | 0     |  |

**Bits 7 to 0:** APLL Feedback Divider Register (AFBDIV[7:0]). The full 42-bit AFBDIV[41:0] field spans the AFBDIV1 through AFBDIV6 registers. AFBDIV is an unsigned number with 9 integer bits (AFBDIV[41:33]) and up to 33 fractional bits. AFBDIV specifies the fixed-point term of the APLL's fractional feedback divide value. The value AFBDIV=0 is undefined. Unused least significant bits must be written with 0. AFBDIV[41:40] must be set to 00 in DPLL+APLL mode. See section 5.8.2.

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|---|---|-------------|---|---------------|---------------|---------------|------------------|------------|
| Register Na<br>Register De<br>Register Ac                 | Description: APLL Feedback Divider Register 2 |             |   |               |               |               |                  |            |
|   | Bit 7   | Bit 6       | Bit 5   | Bit 4         | Bit 3         | Bit 2         | Bit 1            | Bit 0      |
| Name  |   | 1           |   | AFBDI         | V[15:8]       |               |                  |            |
| Default   | 0   | 0           | 0   | 0             | 0             | 0             | 0                | 0          |
| Bits 7 to 0:  | APLL Feedb                                    | ack Divider | Register (AF                                      | BDIV[15:8])   | . See the AF  | BDIV1 regist  | er description   | n.         |
|   |   |             |   |               |               |               |                  |            |
| Register Na<br>Register De<br>Register Ac                 | escription:                                   |             | BDIV3<br>L Feedback D<br>h                        | Divider Regis | iter 3        |               |                  |            |
|   | Bit 7   | Bit 6       | Bit 5   | Bit 4         | Bit 3         | Bit 2         | Bit 1            | Bit 0      |
| Name  |   |             |   | AFBDI\        | /[23:16]      |               |                  |            |
| Default   | 0   | 0           | 0   | 0             | 0             | 0             | 0                | 0          |
| Bits 7 to 0:  | APLL Feedb                                    | ack Divider | Register (AF                                      | BDIV[23:16    | ]).See the A  | FBDIV1 regis  | ster description | on.        |
| Register Na<br>Register De<br>Register Ac                 | escription:                                   |             | BDIV4<br>.L Feedback D<br>h                       | Divider Regis | ster 4        |               |                  |            |
|   | Bit 7   | Bit 6       | Bit 5   | Bit 4         | Bit 3         | Bit 2         | Bit 1            | Bit 0      |
| Name  |   | T           |   | AFBDI\        | /[31:24]      |               |                  |            |
| Default   | 0   | 0           | 0   | 0             | 0             | 0             | 0                | 0          |
| Bits 7 to 0:<br>Register Na<br>Register De<br>Register Ac | ame:<br>escription:                           | AFE         | Register (AF<br>BDIV5<br>L Feedback D<br>h        | -             |               | AFBDIV1 regis | ster descriptio  | on.        |
|   | Bit 7   | Bit 6       | Bit 5   | Bit 4         | Bit 3         | Bit 2         | Bit 1            | Bit 0      |
| Name  |   | T           |   | AFBDI\        |               |               |                  |            |
| Default   | 0   | 0           | 0   | 0             | 0             | 0             | 0                | 0          |
| Bits 7 to 0:<br>Register Na<br>Register De<br>Register Ac | ame:<br>escription:                           | AFE         | <b>Register (AF</b><br>BDIV6<br>L Feedback D<br>h | _             |               | AFBDIV1 regis | ster descriptio  | on.        |
|   | Bit 7   | Bit 6       | Bit 5   | Bit 4         | Bit 3         | Bit 2         | Bit 1            | Bit 0      |
| Name  |   |             |   |               |               |               | AFBDIV           |            |
| Default   | 0   | 0           | 0   | 0             | 0             | 0             | 0                | 0          |
| Bits 7 to 0:  | APLL Feedb                                    | ack Divider | Register (AF                                      | BDIV[41:40    | ]). See the A | FBDIV1 reais  | ster descriptio  | on.        |

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Register Name: Register Description: Register Address: AFBDEN1 APLL Feedback Divider Denominator Register 1 10Ch

|         | Bit 7 | Bit 6       | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |  |
|---------|-------|-------------|-------|-------|-------|-------|-------|-------|--|
| Name    |       | AFBDEN[7:0] |       |       |       |       |       |       |  |
| Default | 0     | 0           | 0     | 0     | 0     | 0     | 0     | 1     |  |

**Bits 7 to 0: APLL Feedback Divider Denominator Register (AFBDEN[7:0]).** The full 32-bit AFBDEN[31:0] field spans AFBDEN1 through AFBDEN4 registers. AFBDEN is an unsigned integer that specifies the denominator of the APLL's fractional feedback divide value. The value AFBDEN=0 is undefined. When AFBBP=0, AFBDEN must be set to 1. See section 5.8.2.

| AFBDEN2                                      |
|--|
| APLL Feedback Divider Denominator Register 2 |
| 10Dh   |
|  |

|         | Bit 7        | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|--------------|-------|-------|-------|-------|-------|-------|-------|
| Name    | AFBDEN[15:8] |       |       |       |       |       |       |       |
| Default | 0            | 0     | 0     | 0     | 0     | 0     | 0     | 0     |

Bits 7 to 0: APLL Feedback Divider Denominator Register (AFBDEN[15:8]). See the AFBDEN1 register description.

| Register Name:        | AFBDEN3                                      |
|-----------------------|--|
| Register Description: | APLL Feedback Divider Denominator Register 3 |
| Register Address:     | 10Eh   |

|         | Bit 7         | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |  |
|---------|---------------|-------|-------|-------|-------|-------|-------|-------|--|
| Name    | AFBDEN[23:16] |       |       |       |       |       |       |       |  |
| Default | 0             | 0     | 0     | 0     | 0     | 0     | 0     | 0     |  |

Bits 7 to 0: APLL Feedback Divider Denominator Register (AFBDEN[23:16]). See the AFBDEN1 register description.

| Register Name:        | AFBDEN4                                      |
|-----------------------|--|
| Register Description: | APLL Feedback Divider Denominator Register 4 |
| Register Address:     | 10Fh   |

|         | Bit 7         | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |  |
|---------|---------------|-------|-------|-------|-------|-------|-------|-------|--|
| Name    | AFBDEN[31:24] |       |       |       |       |       |       |       |  |
| Default | 0             | 0     | 0     | 0     | 0     | 0     | 0     | 0     |  |

Bits 7 to 0: APLL Feedback Divider Denominator Register (AFBDEN[31:24]). See the AFBDEN1 register description.

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|---|--|-------------------------------|--------------|----------------------|------------------------|-----------------------|----------------|---------------|
| Register I<br>Register I<br>Register <i>I</i> | Description:                                     | AFBR<br>APLL<br>110h          |              | ivider Rema          | ainder Regist          | er 1                  |                |               |
|   | Bit 7  | Bit 6                         | Bit 5        | Bit 4                | Bit 3                  | Bit 2                 | Bit 1          | Bit 0         |
| Name  | _  | -                             |              |                      | EM[7:0]                |                       |                |               |
| Default                                       | 0  | 0                             | 0            | 0                    | 0                      | 0                     | 0              | 0             |
| spans AFE                                     | 0: APLL Feed<br>BREM1 through<br>ctional feedbac | AFBREM4 re                    | gisters. AFB | REM is an            | unsigned inte          | eger that spec        | cifies the rem | ainder of the |
| Register I<br>Register I<br>Register <i>I</i> | Description:                                     | AFBR<br>APLL<br>111h          |              | ivider Rema          | ainder Regist          | er 2                  |                |               |
|   | Bit 7  | Bit 6                         | Bit 5        | Bit 4                | Bit 3                  | Bit 2                 | Bit 1          | Bit 0         |
| Name  |  |                               |              |                      | M[15:8]                |                       |                |               |
| Default                                       | 0  | 0                             | 0            | 0                    | 0                      | 0                     | 0              | 0             |
| Register N<br>Register I<br>Register A        | Description:                                     | AFBR<br>APLL<br>112h<br>Bit 6 |              | ivider Rema<br>Bit 4 | ainder Regist<br>Bit 3 | er 3<br>Bit 2         | Bit 1          | Bit 0         |
| Name  |  |                               |              |                      | M[23:16]               |                       |                |               |
| Default                                       | 0  | 0                             | 0            | 0                    | 0                      | 0                     | 0              | 0             |
| Bits 7 to<br>description<br>Register N        |  | dback Divide                  |              | er Registe           | r (AFBREM              | [ <b>23:16]).</b> See | e the AFBRI    | EM1 register  |
| Register I<br>Register /                      | Description:<br>Address:                         | APLL<br>113h                  | Feedback D   | ivider Rema          | ainder Regist          | er 4                  |                |               |
|   | Bit 7  | Bit 6                         | Bit 5        | Bit 4                | Bit 3                  | Bit 2                 | Bit 1          | Bit 0         |
| Name  |  |                               | 0            |                      | M[31:24]               |                       |                |               |
| Default                                       | 0  | 0                             | 0            | 0                    | 0                      | 0                     | 0              | 0             |
| Bits 7 to<br>description                      | 0: APLL Fee                                      | dback Divid                   | er Remaind   | er Registe           | r (AFBREM              | [ <b>31:24]).</b> See | e the AFBRI    | EM1 register  |

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Register Name: Register Description: Register Address: AFBBP APLL Feedback Divider Truncate Bit Position 114h

|         | Bit 7 | Bit 6      | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|------------|-------|-------|-------|-------|-------|-------|
| Name    |       | AFBBP[7:0] |       |       |       |       |       |       |
| Default | 0     | 0          | 0     | 0     | 0     | 0     | 0     | 0     |

**Bits 7 to 0:** APLL Feedback Divider Truncate Bit Position (AFBBP[7:0]). This unsigned integer specifies the number of fractional bits that are valid in the AFBDIV value. There are 33 fractional bits in AFBDIV. The value in this AFBBP field specifies 33 – number\_of\_valid\_AFBDIV\_fractional\_bits. When AFBBP=0 all 33 AFBDIV fractional bits are valid. When AFBBP=9, the most significant 24 AFBDIV fractional bits are valid and the least significant 9 bits must be set to 0. This register field is only used when the feedback divider value is expressed in the form AFBDIV + AFBREM / AFBDEN. AFBBP values greater than 33 are invalid. When AFBBP=0, AFBREM must be set to 0 and AFBDEN must be set to 1. See section 5.8.2.

## 6.3.4 Output Clock Configuration Registers

| Register Name:        | OCxCR1                                  |
|-----------------------|---|
| Register Description: | Output Clock x Configuration Register 1 |
| Register Address:     | OC1: 200h, OC2: 210h, OC3: 220h         |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3      | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|------------|-------|-------|-------|
| Name    | PHEN  |       |       |       | MSDIV[6:0] |       |       |       |
| Default | 0     | 0     | 0     | 0     | 0          | 0     | 0     | 0     |

**Bit 7: Phase Adjust Enable (PHEN).** This bit enables this output to participate in phase adjustment/alignment. See section 5.9.4.

0 = Phase adjustment/alignment disabled for this output

1 = Phase adjustment/alignment enabled for this output

**Bits 6 to 0: Medium-Speed Divider Value (MSDIV[6:0]).** This field specifies the setting for the output clock's medium-speed divider. The divisor is MSDIV+1. Note that if MSDIV is not set to 0 (bypass) then MSDIV must be set to a value that causes the output clock of the medium-speed divider to be 425MHz or less. When MSDIV=0, the medium-speed divider, phase adjust, low-speed divider, start/stop and output duty cycle adjustment circuits are bypassed and the high-frequency clock signal is directly sent to the output driver. See section 5.9.2.





Register Name: Register Description: Register Address: OCxCR2 Output Clock x Configuration Register 2 OC1: 201h, OC2: 211h, OC3: 221h

|         | Bit 7  | Bit 6 | Bit 5 | Bit 4  | Bit 3   | Bit 2 | Bit 1     | Bit 0 |
|---------|--------|-------|-------|--------|---------|-------|-----------|-------|
| Name    | ASQUEL | POL   | DRIV  | E[1:0] | STOPDIS |       | OCSF[2:0] |       |
| Default | 0      | 0     | 0     | 0      | 0       | 0     | 0         | 0     |

**Bit 7: Auto-Squelch Enable (ASQUEL).** This bit enables automatic squelching of the output clock whenever the DPLL has no selected reference (PTAB1.SELREF=0). When OCxSTOP.MODE=01 or 10 the output is squelched at the next positive or negative edge using the START/STOP function. When the output is configured as a CML output or a CMOS complementary output is squelched, its OCxN pin is opposite polarity of the OCxP pin.

0 = Auto-squelch disabled

1 = Auto-squelch enabled

**Bit 6: Clock Path Polarity (POL).** The clock path to the CML, HSTL and CMOS outputs is inverted when this bit is set. This does not invert the LSDIV path to the CMOS OCxN pin if that path is enabled. See section 5.9.1.

**Bits 5 to 4: CMOS/HSTL Output Drive Strength (DRIVE[1:0]).** The CMOS/HSTL output drivers have four equal sections that can be enabled or disabled to achieve four different drive strengths from 1x to 4x. When the output power supply VDDOx is 3.3V or 2.5V, the user should start with 1x and only increase drive strength if the output is highly loaded and signal transition time is unacceptable. When VDDOx is 1.8V or 1.5V the user should start with 4x and only decrease drive strength if the output signal has unacceptable overshoot. See section 5.9.1.

- 00 = 1x
- 01 = 2x
- 10 = 3x
- 11 = 4x

**Bit 3: Stop Disable (STOPDIS).** This bit causes the output to become disabled (high impedance) while the output clock is stopped. See section 5.9.5.

- 0 = Do not disable the output while stopped
- 1 = Disable the output while stopped

Bits 2 to 0: Output Clock Signal Format (OCSF[2:0]). Note that OCEN.OCxEN=0 forces the output driver to be high-impedance regardless of the value of the OCSF register field. See section 5.9.1.

- 000 = Disabled (high-impedance, low power mode)
- 001 = CML, standard swing ( $V_{OD}$  =800m $V_{P-P}$  typical)
- 010 = CML, narrow swing ( $V_{OD}$  =400m $V_{P-P}$  typical)
- 011 = HSTL (Set OCxCR2.DRIVE=11 (4x) to meet JESD8-6)
- 100 = Two CMOS: OCxP in phase with OCxN
- 101 = One CMOS: OCxP high impedance, OCxN enabled
- 110 = One CMOS: OCxP enabled, OCxN high impedance
- 111 = Two CMOS: OCxP inverted vs. OCxN



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Register Name: Register Description: Register Address: OCxCR3 Output Clock x Configuration Register 3 OC1: 202h, OC2: 212h, OC3: 222h

|         | Bit 7  | Bit 6  | Bit 5  | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0     |
|---------|--------|--------|--------|-------|-------|-------|-------|-----------|
| Name    | SRLSEN | DIVSEL | NEGLSD | LSSEL | _     | _     | _     | LSDIV[24] |
| Default | 0      | 0      | 0      | 0     | 0     | 0     | 0     | 0         |

**Bit 7 Enable LSDIV Statuses (SRLSEN).** This bit enables the OCxSR.LSCLK real-time status bit and its associated latched status bit OCxSR.LSCLKL.

0 = LSCLK status bit is not enabled (low)

1 = LSCLK status bit is enabled

Bit 6: High Speed Divider Select (DIVSEL). This bit selects which high-speed divider is the source of the clock for the output. See section 5.9.2.

0 = HSDIV1

1 = HSDIV2

Bit 5: OCxN Low Speed Divider (NEGLSD). This bit selects the source of the clock on the OCxN pin in CMOS mode. See section 5.9.2.

0 = Same as OCxP

1 = Output of the LSDIV divider

Note: NEGLSD should only be set to 1 in two-CMOS mode (OCxCR2.OCSF=100 or 111) and when OCxCR2.POL=0.

**Bit 4: LSDIV Select (LSSEL).** This bit selects the source of the output clock. When the MSDIV divider is selected (LSSEL=0) the LSDIV divider output can be independently selected as the source for the OCxN pin (in CMOS output mode) or monitored by the OCxSR.LSCLK status bit. This bit is only valid when OCxCR1.MSDIV > 0. See section 5.9.2.

0 = The output clock is sourced from the MSDIV divider.

1 = The output clock is sourced from the LSDIV divider.

Bit 0: Low-Speed Divider Value (LSDIV[24]). See the OCxDIV1 register description.



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Register Name: Register Description: Register Address: OCxDIV1 Output Clock x Divider Register 1 OC1: 203h, OC2: 213h, OC3: 223h

|         | Bit 7 | Bit 6      | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|------------|-------|-------|-------|-------|-------|-------|
| Name    |       | LSDIV[7:0] |       |       |       |       |       |       |
| Default | 0     | 0          | 0     | 0     | 0     | 0     | 0     | 0     |

**Bits 7 to 0: Low-Speed Divider Value (LSDIV[7:0]).** The full 25-bit LSDIV[24:0] field spans this register, OCxDIV2, OCxDIV3. and bit 0 of OCxCR3. LSDIV is an unsigned integer. The frequency of the clock from the medium-speed divider is divided by LSDIV+1. The OCxCR3.LSSEL and NEGLSD bits control when the output of the low-speed divider is present on the OCxP and OCxN output pins. OCxCR1.MSDIV must be > 0 for the low-speed divider to operate. See section 5.9.2.

| Register | Name:        |
|----------|--------------|
| Register | Description: |
| Register | Address:     |

OCxDIV2 Output Clock x Divider Register 2 OC1: 204h, OC2: 214h, OC3: 224h

|         | Bit 7 | Bit 6       | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------------|-------|-------|-------|-------|-------|-------|
| Name    |       | LSDIV[15:8] |       |       |       |       |       |       |
| Default | 0     | 0           | 0     | 0     | 0     | 0     | 0     | 0     |

Bits 7 to 0: Low-Speed Divider Value (LSDIV[15:8]). See the OCxDIV1 register description.

| Register Name:        | OCxDIV3                           |
|-----------------------|-----------------------------------|
| Register Description: | Output Clock x Divider Register 3 |
| Register Address:     | OC1: 205h, OC2: 215h, OC3: 225h   |

|         | Bit 7 | Bit 6        | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|--------------|-------|-------|-------|-------|-------|-------|
| Name    |       | LSDIV[23:16] |       |       |       |       |       |       |
| Default | 0     | 0            | 0     | 0     | 0     | 0     | 0     | 0     |

Bits 7 to 0: Low-Speed Divider Value (LSDIV[23:16]). See the OCxDIV1 register description.

| Register Name:        | OCxDC                              |
|-----------------------|------------------------------------|
| Register Description: | Output Clock x Duty Cycle Register |
| Register Address:     | OC1: 206h, OC2: 216h, OC3: 226h    |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3  | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|--------|-------|-------|-------|
| Name    |       |       |       | OCDO  | C[7:0] |       |       |       |
| Default | 0     | 0     | 0     | 0     | 0      | 0     | 0     | 0     |

**Bits 7 to 0: Output Clock Duty Cycle (OCDC[7:0]).** This field controls the output clock signal duty cycle when MSDIV>0 and LSDIV>1. When OCDC = 0 the output clock is 50%. Otherwise the clock signal is a pulse with a width of OCDC number of MSDIV output clock periods. The range of OCDC can create pulse widths from 1 to 255 MSDIV output clock periods. When OCxCR2.POL=0, the pulse is high and the signal is low the remainder of the cycle. When POL=1, the pulse is low and the signal is high the remainder of the cycle. See section 5.9.3.

Note: Rev A devices require MSDIV>5.



Register Name: Register Description: Register Address: OCxPH Output Clock x Phase Adjust Register OC1: 207h, OC2: 217h, OC3: 227h

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3   | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|---------|-------|-------|-------|
| Name    |       |       |       | PHAD  | )J[7:0] |       |       |       |
| Default | 0     | 0     | 0     | 0     | 0       | 0     | 0     | 0     |

**Bits 7 to 0: Phase Adjust Value (PHADJ[7:0]).** When OCxCR1.PHEN=1, this field specifies the phase adjustment of the output clock during a phase adjustment event. When OCxCR1.PHEN=0, this field is ignored. The specified phase adjustment occurs once during a phase adjustment event. The format of the field is 2's-complement with the LSB being one half of an HSDIV output clock period. Positive values move the signal later in time (to the right on a scope). See section 5.9.4.

00000000 = 0.0 UI 00000001 = +0.5 UI 00000010 = +1.0 UI 00000011 = +1.5 UI ... 01111110 = +63.0 UI 01111111 = +63.5 UI 10000000 = -64.0 UI 10000001 = -63.5 UI ... 11111101 = -1.5 UI 11111110 = -1.0 UI 11111111 = -0.5 UI



Register Name: Register Description: Register Address: OCxSTOP

Output Clock x Start Stop Register OC1: 208h, OC2: 218h, OC3: 228h

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0  |  |
|---------|-------|-------|-------|-------|-------|-------|-------|--------|--|
| Name    | STOP  | _     |       | SRC   | [3:0] |       | MOD   | E[1:0] |  |
| Default | 0     | 0     | 0     | 0     | 0     | 0     | 0     | 0      |  |

**Bit 7: Output Clock Stop (STOP).** When SRC=0000, this bit is used to stop the output clock high or low. The output stays stopped while this bit is high. See section 5.9.5.

0 = Do not stop the output clock

1 =Stop the output clock

Bits 5 to 2: Output Clock Stop Source (SRC[3:0]). This field specifies the source of the stop signal. See section 5.9.5.

0000 = STOP bit

0001 = The arming of a phase adjustment (signal stopped when PASR.ARMED is asserted; signal started when PASR.ADJL is asserted)

0010 to 0111 = {unused values} 1000 = GPIO0 1001 = GPIO1 1010 = GPIO2 1011 = GPIO3 1100 to 1111 = {unused values}

Bits 1 to 0: Output Clock Stop Mode (MODE[1:0]). This field selects the mode of the start-stop function. See section 5.9.5.

00 = Never stop

01 = Stop High: stop after rising edge of output clock, start after falling edge of output clock

10 = Stop Low: stop after falling edge of output clock, start after rising edge of output clock

11 = {unused value}

The following table shows which pin(s) stop high or low as specified above for each output signal format:

| Signal Format                     | OCxCR2.0CSF | Pin that Stops As Specified |
|-----------------------------------|-------------|-----------------------------|
| CML                               | 001 or 010  | OCxP                        |
| HSTL                              | 011         | OCxN                        |
| Two CMOS, OCxP in phase with OCxN | 100         | OCxP and OCxN               |
| One CMOS, OCxN enabled            | 101         | OCxN                        |
| One CMOS, OCxP enabled            | 110         | OCxP                        |
| Two CMOS, OCxP inverted vs. OCxN  | 111         | OCxN                        |

Notes:

- 1. The highest priority condition for an output is when it is stopped and OCxCR2.STOPDIS=1. When this condition occurs both OCxP and OCxN become high-impedance regardless of the state of the control bits mentioned below.
- 2. When the output is not stopped or when OCxCR2.STOPDIS=0, OCxCR3.NEGLSD=1 causes the OCxN pin to follow the output clock of the low-speed divider uninverted regardless of the signal format, regardless of the state of OCxCR2.POL, and regardless of whether the output is stopped.
- 3. When the above situations do not apply, OCxCR2.POL=1 changes Stop High to Stop Low and vice versa.



#### 6.3.5 Input Clock Configuration Registers

| Register Name:        | ICxCR1                                 |
|-----------------------|--|
| Register Description: | Input Clock x Configuration Register 1 |
| Register Address:     | IC1: 300h, IC2: 320h, IC3: 340h        |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0  |
|---------|-------|-------|-------|-------|-------|-------|-------|--------|
| Name    | _     | POL   | _     | _     | _     | _     | HSDI  | V[1:0] |
| Default | 0     | 0     | 0     | 0     | 0     | 0     | 0     | 0      |

**Bit 6: Locking Polarity (POL).** This field specifies which input clock signal edge the DPLL or APLL will lock to. See section 5.6.1.

0 = Rising edge

1 = Falling edge

**Bits 1 to 0: Input Clock High-Speed Divider (HSDIV[1:0]).** This field specifies the divide value for the input clock high-speed divider. For clock to the input block and DPLL see section 5.6.1. For clock to the APLL see section 5.8.1.1.

00 = Divide by 1 01 = Divide by 2 10 = Divide by 4 11 = Divide by 8

| Register Name:        | MONxCR2  |
|-----------------------|--|
| Register Description: | Input Clock Monitor x Configuration Register 2 |
| Register Address:     | IC1: 311h, IC2: 331h, IC3: 351h                |

|         | Bit 7 | Bit 6 | Bit 5      | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|------------|-------|-------|-------|-------|-------|
| Name    | _     |       | LOSSS[2:0] |       | —     | ACEN  | PCEN  | PPEN  |
| Default | 0     | 0     | 0          | 0     | 0     | 0     | 0     | 0     |

Bits 6 to 4: Loss-of-Signal Source Select (LOSSS[2:0]). This field selects the source of the loss-of-signal indicator. The selected source drives the ICxSR.LOS bit and invalidates the input clock. See section 5.6.2.1. 000 = No source. ICxSR.LOS is set to 0.

000 = N0 source 000 = 000 source 000 = 000 source 0000 source 000 source 000 source 000 source 00

001 = GP100010 = GP101

010 = GPIO1011 = GPIO2

100 = GPIO2

100 = GP103

101 to 111 = {unused values}

Bit 2: Activity Monitor Enable (ACEN). This bit enables the input clock activity monitor. See section 5.6.2.

- 0 = Disable
- 1 = Enable

Bit 1: Percent Frequency Monitor Enable (PCEN). This bit enables the input clock percent frequency monitor. See section 5.6.2.

- 0 = Disable
- 1 = Enable

Bit 0: Parts-per-Million Frequency Monitor Enable (PPEN). This bit enables the input clock PPM frequency monitor. See section 5.6.2.

0 = Disable

1 = Enable



## 6.3.6 DPLL Configuration Registers

Note: When the DPLL is disabled (PLLEN.DPLLEN=0) all DPLL register fields are ignored by the device and should be ignored by system software.

| Register Name:        | ICSCR1                                      |
|-----------------------|---|
| Register Description: | Input Clock Select Configuration Register 1 |
| Register Address:     | 400h  |

|         | Bit 7 | Bit 6  | Bit 5 | Bit 4 | Bit 3  | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|--------|-------|-------|--------|-------|-------|-------|
| Name    | EXTSW | REVERT | _     | FBSE  | L[1:0] | _     | _     | —     |
| Default | 0     | 0      | 0     | 0     | 0      | 0     | 0     | 0     |

**Bit 7: External Reference Switching Mode (EXTSW).** This bit enables the input block's external reference switching mode. See section 5.6.3.4.

0 = Normal operation

1 = External switching mode

**Bit 6: Revertive Mode (REVERT).** This bit configures the DPLL for revertive or nonrevertive operation. In revertive mode, if an input clock with a higher priority than the selected reference becomes valid, the higher priority reference immediately becomes the selected reference. In nonrevertive mode the higher priority reference does not immediately become the selected reference but does become the highest-priority reference in the priority table (REF1 field in the PTAB1 register). See section 5.6.3.2.

- 0 = Nonrevertive
- 1 = Revertive

**Bits 4 to 3: DPLL Feedback Select (FBSEL[1:0]).** This field specifies the source of the DPLL's feedback clock. External feedback supports zero-delay applications (i.e. zero phase difference between input clock and output clock). When an input is chosen as the DPLL's feedback clock, that input should have its priority set to 0 (unavailable) in the IPR registers.

- 00: Internal feedback: Use DPLL DCO output for feedback
- 01: External Feedback through IC1
- 10: External Feedback through IC2
- 11: External Feedback through IC3

| Register Name:        | VALCR1                               |
|-----------------------|--------------------------------------|
| Register Description: | Input Clock Valid Control Register 1 |
| Register Address:     | 401h                                 |

| _       | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|-------|-------|-------|-------|
| Name    |       | _     |       | _     | _     | IC3   | IC2   | IC1   |
| Default | 0     | 0     | 0     | 0     | 0     | 1     | 1     | 1     |

**Bits 2 to 0: Input Clock Valid Control (IC3, IC2, IC1).** These control bits can be used to force input clocks to be considered invalid. If a clock is invalidated by one of these control bits it will not appear in the priority table in the PTAB1 and PTAB2 registers, even if the input monitor indicates the input is valid. These bits are useful when system software needs to force clocks to be "not available for use". Note that setting a VALCR bit low has no effect on the input monitor status bits for that input clock. See section 5.6.3.

0 = Force invalid

1 = Don't force invalid; input monitor determines validity



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| Register Name:        | IPR1                      |
|-----------------------|---------------------------|
| Register Description: | Input Priority Register 1 |
| Register Address:     | 402h                      |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4     | Bit 3 | Bit 2 | Bit 1 | Bit 0     |   |
|---------|-------|-------|-------|-----------|-------|-------|-------|-----------|---|
| Name    | _     | _     |       | PRI2[1:0] |       | _     | PRI   | PRI1[1:0] |   |
| Default | 0     | 0     | 1     | 0         | 0     | 0     | 0     | 1         | ] |

**Bits 5 to 4: Priority for Input Clock 2 (PRI2[1:0]).** This field specifies the priority of IC2. Priority 01 is highest; priority 11 is lowest. See section 5.6.3.1.

00 = IC2 unavailable for selection.

01-11 = IC2 relative priority

Bits 1 to 0: Priority for Input Clock 1 (PRI1[1:0]). This field specifies the priority of IC1. Priority 01 is highest; priority 11 is lowest. See section 5.6.3.1.

00 = IC1 unavailable for selection.

01-11 = IC1 relative priority

| Register Name:        | IPR2                      |
|-----------------------|---------------------------|
| Register Description: | Input Priority Register 2 |
| Register Address:     | 403h                      |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1     | Bit 0 |
|---------|-------|-------|-------|-------|-------|-------|-----------|-------|
| Name    | _     | _     | _     | _     | —     | —     | PRI3[3:0] |       |
| Default | 0     | 0     | 0     | 0     | 0     | 0     | 1         | 1     |

Bits 1 to 0: Priority for Input Clock 3 (PRI3[1:0]). This field specifies the priority of IC3. Priority 01 is highest; priority 11 is lowest. See section 5.6.3.1.

00 = IC3 unavailable for selection.

01-11 = IC3 relative priority



Register Name: Register Description: Register Address: PHLKTO DPLL Phase Lock Timeout Register 404h

|         | Bit 7 | Bit 6    | Bit 5       | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|----------|-------------|-------|-------|-------|-------|-------|
| Name    | PHLK  | FOM[1:0] | PHLKTO[5:0] |       |       |       |       |       |
| Default | 0     | 0        | 1           | 1     | 0     | 0     | 1     | 0     |

**Bits 7 to 6: Phase Lock Timeout Multiplier (PHLKTOM[1:0]).** This field is an unsigned integer that specifies the resolution of the PHLKTO field below. The DSP rate is calculated by the GUI and displayed at the bottom of the GUI's DPLL window.

00 = 1 x DSP rate

 $01 = 16 \times DSP$  rate

10 = 256 x DSP rate

11 = 4096 x DSP rate

**Bits 5 to 0: Phase Lock Timeout (PHLKTO[5:0]).** This field is an unsigned integer that, together with the PHLKTOM field above, specifies the length of time that the DPLL attempts to lock to an input clock before declaring a phase lock alarm (by setting the corresponding ICxSR.LKTO bit). The timeout period in seconds is PHLKTO[5:0] x 16^(PHLKTOM[1:0]) \* (1/DSP\_RATE). When unable to declare lock, the DPLL remains in the tracking state for the specified time before declaring a phase lock alarm on the selected input. When PHLKTO=0, the timeout is disabled, and the DPLL can remain indefinitely in the tracking state. The DSP rate is calculated by the GUI and displayed at the bottom of the GUI's DPLL window.

| Register Name:        | LKATO                            |
|-----------------------|----------------------------------|
| Register Description: | DPLL Lock Alarm Timeout Register |
| Register Address:     | 405h                             |

|         | Bit 7 | Bit 6   | Bit 5 | Bit 4 | Bit 3      | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|---------|-------|-------|------------|-------|-------|-------|
| Name    | LKAT  | OM[1:0] |       |       | LKATO[5:0] |       |       |       |
| Default | 0     | 0       | 1     | 1     | 0          | 0     | 1     | 0     |

**Bits 7 to 6: Lock Alarm Timeout Multiplier (LKATOM[1:0]).** This field is an unsigned integer that specifies the resolution of the LKATO field below. The DSP rate is calculated by the GUI and displayed at the bottom of the GUI's DPLL window.

00 = 1 x DSP rate 01 = 16 x DSP rate 10 = 256 x DSP rate 11 = 4096 x DSP rate

**Bits 5 to 0: Lock Alarm Timeout (LKATO[5:0]).** This field is an unsigned integer that, together with the LKATOM field above, specifies the length of time that a phase lock alarm remains active before being automatically deasserted (by clearing the corresponding ICxSR.LKTO bit). The timeout period in seconds is LKATO[5:0] x 16^(LKATOM[1:0]) \* (1/DSP RATE).. When LKATO=0, the timeout is disabled, the phase lock alarm remains active until cleared by software writing a 1 to the ICxSR.LKCLR bit. The DSP rate is calculated by the GUI and displayed at the bottom of the GUI's DPLL window.



| Register Name:        | DPLLCR1                       |
|-----------------------|-------------------------------|
| Register Description: | DPLL Configuration Register 1 |
| Register Address:     | 40Bh                          |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4       | Bit 3 | Bit 2     | Bit 1 | Bit 0 |  |
|---------|-------|-------|-------|-------------|-------|-----------|-------|-------|--|
| Name    | —     | —     | HOMO  | HOMODE[1:0] |       | MODE[3:0] |       |       |  |
| Default | 0     | 0     | 0     | 0           | 0     | 0         | 0     | 0     |  |

#### Bits 5 to 4: Holdover Mode (HOMODE[1:0]).

00: Averaged Holdover - do not reset HO average when new input selected

01: Averaged Holdover – reset HO average when new input selected

10: Freerun - do not use HO average but rather nominal frequency tuning word value

11: {unused value}

Bits 3 to 0: DPLL Mode (MODE[3:0]). This field selects the operational mode of the DPLL.

0000: Reset 0001: NCO 0100: Freerun 0101: Holdover 0110: Tracking all other values are invalid

| Register Name:        | DPLLCR2                       |
|-----------------------|-------------------------------|
| Register Description: | DPLL Configuration Register 2 |
| Register Address:     | 40Ch                          |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0  |
|---------|-------|-------|-------|-------|-------|-------|-------|--------|
| Name    |       |       | _     | _     |       |       | HSEN  | l[1:0] |
| Default | 0     | 0     | 0     | 0     | 0     | 0     | 0     | 0      |

**Bits 1 to 0: Hitless Switching Enable (HSEN[1:0]).** When hitless switching is disabled the DPLL pulls in to the phase of the new input reference. A hitless switch measures the phase difference between previous input and next input and builds that phase difference into the loop so that DPLL output phase does not change during the input reference change. See section 5.7.3.

00 = Hitless switching disabled

01 = Switch only: hitless behavior only when switching from one input reference to another

10 = Switch or Valid: hitless behavior when switching from one input reference to another or when switching back to the same input reference due to short input dropout or input invalidation



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Register Name: Register Description: Register Address: DFREQZ1 DPLL Frequency Tuning Word Register 1 420h

|         | Bit 7 | Bit 6      | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |  |
|---------|-------|------------|-------|-------|-------|-------|-------|-------|--|
| Name    |       | FREQZ[7:0] |       |       |       |       |       |       |  |
| Default | 0     | 0          | 0     | 0     | 0     | 0     | 0     | 0     |  |

**Bits 7 to 0: DPLL Frequency Tuning Word (FREQZ[7:0]).** The full 40-bit DFREQZ[39:0] field spans this register and the DFREQZ2 to DFREQZ5 registers and is a multi-register field (see section 6.1.3). This unsigned coefficient is the frequency tuning word value that sets the frequency the DPLL generates during freerun and in NCO mode. It is also the base frequency to which the DPLL adds a dynamic offset during tracking. The nominal value of this field is set by the evaluation software. In NCO mode, system software can change this value by any fraction (less than 1 ppb to multiple ppm) to cause a fractional change in the DPLL's output frequency. See section 5.7.7.

| Register Na<br>Register De<br>Register Ac | escription: | DF          | DFREQZ2<br>DPLL Frequency Tuning Word Register 2<br>421h |       |       |       |       |       |  |
|---|-------------|-------------|--|-------|-------|-------|-------|-------|--|
|   | Bit 7       | Bit 6       | Bit 5  | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |  |
| Name                                      |             | FREQZ[15:8] |  |       |       |       |       |       |  |
| Default                                   | 0           | 0           | 0  | 0     | 0     | 0     | 0     | 0     |  |

Bits 7 to 0: DPLL Frequency Tuning Word (FREQZ[15:8]). See the DFREQZ1 register description.

| Register Na<br>Register De<br>Register Ac | escription:  | DF    | DFREQZ3<br>DPLL Frequency Tuning Word Register 3<br>422h |       |       |       |       |       |  |
|---|--------------|-------|--|-------|-------|-------|-------|-------|--|
|   | Bit 7        | Bit 6 | Bit 5  | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |  |
| Name                                      | FREQZ[23:16] |       |  |       |       |       |       |       |  |
| Default                                   | 0            |       |  |       |       |       |       |       |  |

Bits 7 to 0: DPLL Frequency Tuning Word (FREQZ[23:16]). See the DFREQZ1 register description.

| Register Na<br>Register De<br>Register Ac | escription: | DF           | DFREQZ4<br>DPLL Frequency Tuning Word Register 4<br>423h |       |       |       |       |       |  |
|---|-------------|--------------|--|-------|-------|-------|-------|-------|--|
|   | Bit 7       | Bit 6        | Bit 5  | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |  |
| Name                                      |             | FREQZ[31:24] |  |       |       |       |       |       |  |
| Default                                   | 0           | 0            | 0 0 0 0 0 0 0  |       |       |       |       |       |  |

Bits 7 to 0: DPLL Frequency Tuning Word (FREQZ[31:24]). See the DFREQZ1 register description.

| Register Na<br>Register De<br>Register Ac | escription:  | DF    | DFREQZ5<br>DPLL Frequency Tuning Word Register 5<br>424h |       |       |       |       |       |  |
|---|--------------|-------|--|-------|-------|-------|-------|-------|--|
|   | Bit 7        | Bit 6 | Bit 5  | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |  |
| Name                                      | FREQZ[39:32] |       |  |       |       |       |       |       |  |
| Default                                   | 0            | 0     | 0  | 0     | 0     | 0     | 0     | 0     |  |

Bits 7 to 0: DPLL Frequency Tuning Word (FREQZ[39:32]). See the DFREQZ1 register description.



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Register Name: Register Description: Register Address: DPHOFF1 DPLL Phase Offset Register 1 428h

|         | Bit 7 | Bit 6      | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |  |
|---------|-------|------------|-------|-------|-------|-------|-------|-------|--|
| Name    |       | PHOFF[7:0] |       |       |       |       |       |       |  |
| Default | 0     | 0          | 0     | 0     | 0     | 0     | 0     | 0     |  |

**Bits 7 to 0: DPLL Phase Offset (PHOFF[7:0]).** The full 32-bit PHOFF[31:0] field spans this register and the DPHOFF2 to DPHOFF4 registers and is a multi-register field (see section 6.1.3). This 2s-complement coefficient is used to cause a positive or negative phase offset in the output of the DPLL relative to the input. This field expresses the phase offset in units of 2<sup>-10</sup>ns. Positive values represent input clock leading feedback clock (to the left on a scope).

Register Name: Register Description: Register Address: DPHOFF2 DPLL Phase Offset Register 2 429h

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3   | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|---------|-------|-------|-------|
| Name    |       |       |       | PHOF  | F[15:8] |       |       |       |
| Default | 0     | 0     | 0     | 0     | 0       | 0     | 0     | 0     |

Bits 7 to 0: DPLL Phase Offset (PHOFF[15:8]). See the DPHOFF1 register description.

| Register Name:        | DPHOFF3                      |
|-----------------------|------------------------------|
| Register Description: | DPLL Phase Offset Register 3 |
| Register Address:     | 42Ah                         |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3   | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|---------|-------|-------|-------|
| Name    |       |       |       | PHOFF | [23:16] |       |       |       |
| Default | 0     | 0     | 0     | 0     | 0       | 0     | 0     | 0     |

Bits 7 to 0: DPLL Phase Offset (PHOFF[23:16]). See the DPHOFF1 register description.

| Register Name:        | DPHOFF4                      |
|-----------------------|------------------------------|
| Register Description: | DPLL Phase Offset Register 4 |
| Register Address:     | 42Bh                         |

|         | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3   | Bit 2 | Bit 1 | Bit 0 |
|---------|-------|-------|-------|-------|---------|-------|-------|-------|
| Name    |       |       |       | PHOFF | [31:24] |       |       |       |
| Default | 0     | 0     | 0     | 0     | 0       | 0     | 0     | 0     |

Bits 7 to 0: DPLL Phase Offset (PHOFF[31:24]). See the DPHOFF1 register description.



## 7. Electrical Characteristics

#### Absolute Maximum Ratings

| Parameter                                 | Symbol          | Min. | Max. | Units |
|---|-----------------|------|------|-------|
| Supply voltage, nominal 1.8V              | VDD18           | -0.3 | 1.98 | V     |
| Supply voltage, nominal 3.3V              | VDD33           | -0.3 | 3.63 | V     |
| Supply voltage, VDDOx (x=1,2,3)           | VDDOx           | -0.3 | 3.63 | V     |
| Voltage on XA, any ICxP/N, any OCxP/N pin | VANAPIN         | -0.3 | 3.63 | V     |
| Voltage on any digital I/O pin            | VDIGPIN         | -0.3 | 5.5  | V     |
| Storage Temperature Range                 | T <sub>ST</sub> | -55  | +125 | °C    |

\* Exceeding these values may cause permanent damage. Functional operation under these conditions is not implied. \* Voltages are with respect to ground (VSS) unless otherwise stated.

Note 1: The typical values listed in the tables of Section 7 are not production tested.

Note 2: Specifications to -40°C and 85°C are guaranteed by design or characterization and not production tested.

#### Table 6 - Recommended DC Operating Conditions

| Parameter                       | Symbol | Min.                            | Тур.                     | Max.                            | Units |
|---------------------------------|--------|---------------------------------|--------------------------|---------------------------------|-------|
| Supply voltage, nominal 1.8V    | VDD18  | 1.71                            | 1.8                      | 1.89                            | V     |
| Supply voltage, nominal 3.3V    | VDD33  | 3.135                           | 3.3                      | 3.465                           | V     |
| Supply voltage, VDDOx (x=1,2,3) | VDDOx  | 1.425<br>1.71<br>2.375<br>3.135 | 1.5<br>1.8<br>2.5<br>3.3 | 1.575<br>1.89<br>2.625<br>3.465 | V     |
| Operating temperature           | TA     | -40                             |                          | +85                             | °C    |

#### Table 7 - Electrical Characteristics: Supply Currents

| Characteristics  | Symbol                       | Min. | Typ. <sup>1</sup> | Max | Units | Notes  |
|--|------------------------------|------|-------------------|-----|-------|--------|
| Total power, DPLL+APLL configuration, one input and one nomal-swing CML output enabled           | PDISS                        |      | 0.67              |     | W     |        |
| Total current, all 1.8V supply pins, DPLL+APLL configuration (including NCO operation)           | I <sub>DD18</sub>            |      | 242               | 297 | mA    | Note 2 |
| Total current, all 3.3V supply pins, DPLL+APLL configuration (including NCO operation)           | Idd33                        |      | 184               | 225 | mA    | Note 2 |
| Total current, all 1.8V supply pins, APLL-only configuration                                     | I <sub>DD18</sub>            |      | 208               | 251 | mA    | Note 2 |
| Total current, all 3.3V supply pins, APLL-only configuration                                     | Idd33                        |      | 168               | 206 | mA    | Note 2 |
| 3.3V supply current change from enabling or disabling the crystal driver circuit                 | $\Delta I_{DD33XTAL}$        |      | 16                |     | mA    |        |
| 3.3V supply current change from enabling or disabling high-speed divider 2                       | $\Delta I_{\text{DD33HSD}}$  |      | 20                |     | mA    |        |
| 1.8V supply current from enabling/disabling per-<br>output mux and dividers using OCEN.OCxEN bit | $\Delta$ IDD180DIV           |      | 28                |     | mA    |        |
| 1.8V supply current change from enabling or<br>disabling a CML output, standard swing            | $\Delta I_{DD18CML}$         |      | 10                |     | mA    |        |
| 3.3V supply current change from enabling or disabling a CML output, standard swing               | $\Delta I_{DD33CML}$         |      | 17                |     | mA    |        |
| 1.8V supply current change from enabling or<br>disabling a CML output, narrow swing              | $\Delta I_{\text{DD18CMLN}}$ |      | 10                |     | mA    |        |
| 3.3V supply current change from enabling or disabling a CML output, narrow swing                 | $\Delta I$ dd33cmln          |      | 9                 |     | mA    |        |
| 1.8V supply current change from enabling or<br>disabling a pair of single-ended outputs          | $\Delta I_{DD18CMOS}$        |      | 2                 |     | mA    |        |
| VDDOx supply current change from enabling or disabling a pair of single-ended outputs            | $\Delta I_{DD33CMOS}$        |      | 16                |     | mA    | Note 3 |



| Characteristics   | Symbol            | Min. | Typ. <sup>1</sup> | Max | Units | Notes |
|---|-------------------|------|-------------------|-----|-------|-------|
| 1.8V supply current change from enabling or<br>disabling an input clock | $\Delta I$ dd18in |      | 13                |     | mA    |       |

Note 1: Typical values measured at 1.80V and 3.30V supply voltages and 25°C ambient temperature.

Note 2: Max I<sub>DD</sub> measurements made with all blocks enabled, 650MHz signals on IC1 and IC2 inputs, 187.5MHz signal on IC3, VCO frequency of 3750MHz, both HSDIV enabled and dividing by 6, all MSDIV dividing by 2, all LSDIV dividing by 2, and all outputs enabled as full-swing CML outputs driving 156.25MHz signals. DPLL+APLL mode: 114.285M XO master clock on XA. APLL-only mode: Crystal driver and doubler off, guaranteed by design.

Note 3: VDDOx=3.3V, 1x drive strength, f<sub>0</sub>=250MHz, 2pF load

#### Table 8 - Electrical Characteristics: Non-clock CMOS Pins

| Characteristics  | Symbol             | Min.           | Тур. | Max.           | Units | Notes       |
|--|--------------------|----------------|------|----------------|-------|-------------|
| Input high voltage, SCL and SDA                            | V <sub>IH</sub>    | 0.7 x<br>VDD33 |      |                | V     |             |
| Input low voltage, SCL and SDA                             | V <sub>IL</sub>    |                |      | 0.3 x<br>VDD33 | V     |             |
| Input high voltage, all other digital inputs               | V <sub>IH</sub>    | 2.0            |      |                | V     |             |
| Input low voltage, all other digital inputs                | V <sub>IL</sub>    |                |      | 0.8            | V     |             |
| Input leakage current, RSTN pin                            | I <sub>ILPU</sub>  | -85            |      | 10             | μA    | Note 1      |
| Input leakage current, GPIO3/IC3P pin                      | I <sub>ILGP3</sub> | -20            |      | 20             | μA    | Note 1      |
| Input leakage current, all other digital inputs            | I <sub>IL</sub>    | -10            |      | 10             | μA    | Note 1      |
| Input capacitance  | C <sub>IN</sub>    |                | 3    | 10             | pF    |             |
| Input capacitance, SCL/SCLK, SDA/MOSI                      | C <sub>IN</sub>    |                | 3    | 11             | pF    |             |
| Input hysteresis, SCL and SDA in I <sup>2</sup> C Bus Mode |                    | 0.05*<br>VDD33 |      |                | mV    |             |
| Output leakage (when high impedance)                       | I <sub>LO</sub>    | -10            |      | 10             | μA    | Note 1      |
| Output high voltage  | V <sub>OH</sub>    | 2.4            |      |                | V     | lo = -3.0mA |
| Output low voltage   | V <sub>OL</sub>    |                |      | 0.4            | V     | lo = 3.0mA  |

**Note 1:**  $0V < V_{IN} < VDD33$  for all other digital inputs.

Note 2:  $V_{OH}$  does not apply for SCL and SDA in I<sup>2</sup>C interface mode since they are open drain.

#### Table 9 - Electrical Characteristics: XA Clock Input

This table covers the case when there is no external crystal connected and an external oscillator or clock signal is connected to the XA pin.

| Characteristics   | Symbol          | Min. | Тур. | Max.   | Units | Notes |
|---|-----------------|------|------|--------|-------|-------|
| Input high voltage, XA  | V <sub>IH</sub> | 1.2  |      |        | V     |       |
| Input low voltage, XA   | V <sub>IL</sub> |      |      | 0.8    | V     |       |
| Input frequency on XA pin, master clock for input<br>block and DPLL, jitter attenuation mode, clock<br>doubler disabled | f <sub>IN</sub> | 93   |      | 130    | MHz   |       |
| Input frequency on XA pin, master clock for NCO mode, clock doubler disabled  | f <sub>IN</sub> | 80   |      | 130    | MHz   |       |
| Input frequency on XA pin, internally doubled to make master clock for NCO mode   | f <sub>IN</sub> | 40   |      | 65     | MHz   |       |
| Input frequency, XA pin to APLL mux   | f <sub>IN</sub> | 9.72 |      | 156.25 | MHz   |       |
| Input frequency, XA pin to HSDIV2 bypass mux  | f <sub>IN</sub> |      |      | 156.25 | MHz   |       |
| Input leakage current   | lıL             | -10  |      | 10     | μΑ    |       |
| Input duty cycle  |                 | 40   |      | 60     | %     |       |



#### Table 10 - Electrical Characteristics: Clock Inputs, ICxP/N

| Characteristics  | Symbol                          | Min.  | Тур.  | Max.  | Units | Notes        |
|--|---------------------------------|-------|---|-------|-------|--------------|
| Input voltage tolerance (each pin, single-ended)   | V <sub>TOL</sub>                | 0     |   | VDD33 | V     | Note 1       |
| Input differential voltage   | V <sub>ID</sub>                 | 0.1   |   | 1.4   | V     | Note 2       |
| Input DC bias voltage (internally biased)  | V <sub>CMI</sub>                |       | 1.3   |       | V     |              |
| Input frequency for signals going to the input   | f <sub>IN</sub>                 | 0.001 |   | 650   | MHz   | Differential |
| block  | ٩N                              | 0.001 |   | 300   | MHz   | Single-ended |
| Input frequency APLL only mode   | 4                               | 9.72  |   | 650   | MHz   | Differential |
| Input frequency, APLL-only mode  | f <sub>IN</sub>                 | 9.72  |   | 300   | MHz   | Single-ended |
| $\begin{array}{l} \mbox{Minimum input clock high, low time,} \\ f_{\text{IN}} \leq 250 \mbox{MHz} \end{array}$ | t <sub>H</sub> , t <sub>L</sub> |       | smaller of<br>3ns or 0.3 x 1<br>/ f <sub>IN</sub> |       | ns    | Note 5       |
| Minimum input clock high, low time, $f_{IN} > 250 MHz$   | t <sub>H</sub> , t <sub>L</sub> | 0.4   |   |       | ns    | Note 6       |
| Input resistance, single-ended to VDD18, ICxP or ICxN  | R <sub>INVDD18</sub>            |       | 50  |       | kΩ    |              |
| Input resistance, single-ended to VSS, ICxP or ICxN  | R <sub>INVSS</sub>              |       | 80  |       | kΩ    |              |

**Note 1:** The device can tolerate voltages as specified in V<sub>TOL</sub> w.r.t. VSS on its ICxP and ICxN pins without being damaged. For differential input signals, proper operation of the input circuitry is only guaranteed when the other specifications in this table, including |V<sub>ID</sub>|, are met.

**Note 2:** For inputs IC1P/N and IC2P/N  $V_{ID} = V_{ICxP} - V_{ICxN}$ . For input IC3P,  $V_{ID} = V_{IC3P} - V_{CMI}$ . The max  $V_{ID}$  spec only applies when a differential signal is applied on ICxP/N; it does not apply when a single-ended signal is applied on ICxP.

Note 3: Differential signals. The differential inputs can easily be interfaced to neighboring ICs driving LVDS, LVPECL, CML, HCSL, HSTL or other differential signal formats using a few external passive components. In general, Microsemi recommends terminating the signal with the termination/load recommended in the neighboring component's data sheet and then AC-coupling the signal into the ICxP/ICxN pins. See Figure 21 for details. To connect a differential signal to IC3, AC-couple one side of the signal to IC3P and AC-couple the other side to VSS. For DC-coupling, treat the input as 1.8V CML.

- Note 4: Single-ended signals can be connected to ICxP pins. Signals with amplitude greater than 2.5V must be DC-coupled. For signals with amplitudes less than 2.5V Microsemi recommends AC-coupling but DC-coupling can also be used. When a single-ended signal is connected to ICxP, ICxN should be connected to a capacitor (0.1μF or 0.01μF) to VSS.
- Note 5: If MCR1.MCSEL1=1 then IC1 is the DPLL's master clock source and therefore the duty cycle spec in Table 9 applies to IC1 rather than the t<sub>H</sub>, t<sub>L</sub> spec in this table.
- Note 6: The input high-speed divider must be used to divide the frequency by 2 or more.

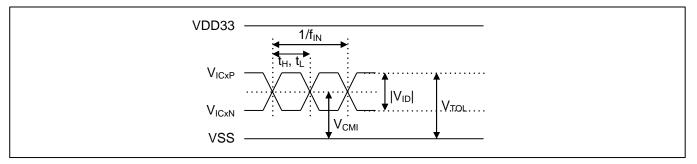


Figure 20 - Electrical Characteristics: Clock Inputs

🔍 Microsemi.

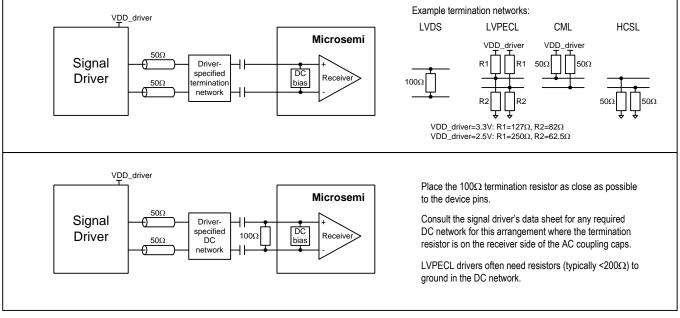


Figure 21 - Example External Components for Differential Input Signals

## Table 11 - Electrical Characteristics: CML Clock Outputs

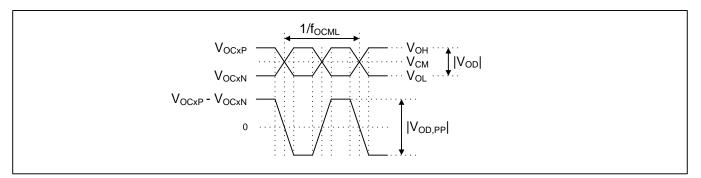
| Characteristics   | Symbol                          | Min. | Тур.           | Max. | Units             | Notes                                |
|---|---------------------------------|------|----------------|------|-------------------|--------------------------------------|
| Output frequency  | f <sub>OCML</sub>               |      |                | 650  | MHz               |                                      |
| Output frequency from medium-speed divider                                  | f <sub>OCML,MSDIV</sub>         |      |                | 425  | MHz               |                                      |
| Output high voltage, single-ended, OCxP or OCxN                             | V <sub>OH,S</sub>               |      | VDDOx<br>- 0.2 |      | V                 |                                      |
| Output low voltage, single-ended, OCxP or OCxN                              | V <sub>OL,S</sub>               |      | VDDOx<br>- 0.6 |      | V                 | Standard Swing<br>(OCxCR2.OCSF=1),   |
| Output common mode voltage  | V <sub>CM,S</sub>               |      | VDDOx<br>- 0.4 |      | V                 | AC coupled to $50\Omega$ termination |
| Output differential voltage   | V <sub>OD,S</sub>               | 320  | 400            | 500  | mV                |                                      |
| Output differential voltage, peak-to-peak                                   | V <sub>OD,S,PP</sub>            | 640  | 800            | 1000 | mV <sub>P-P</sub> |                                      |
| Output high voltage, single-ended, OCxP or OCxN                             | V <sub>OH,N</sub>               |      | VDDOx<br>- 0.1 |      | V                 |                                      |
| Output low voltage, single-ended, OCxP or OCxN                              | $V_{OL,N}$                      |      | VDDOx<br>- 0.3 |      | V                 | Narrow Swing<br>(half the power)     |
| Output common mode voltage  | V <sub>CM,N</sub>               |      | VDDOx<br>- 0.2 |      | V                 | (OCxCR2.OCSF=2),<br>AC coupled to    |
| Output differential voltage   | V <sub>OD,N</sub>               | 160  | 200            | 250  | mV                | 50Ω termination                      |
| Output differential voltage, peak-to-peak                                   | V <sub>OD,N,PP</sub>            | 320  | 400            | 500  | mV <sub>P-P</sub> |                                      |
| Difference in Magnitude of Differential<br>Voltage for Complementary States | V <sub>DOS</sub>                |      |                | 50   | mV                |                                      |
| Output Rise/Fall Time   | t <sub>R</sub> , t <sub>F</sub> |      | 150            |      | ps                | 20%-80%                              |
| Output Duty Cycle   |                                 | 45   | 50             | 55   | %                 | Notes 2                              |
| Output Duty Cycle   |                                 | 40   |                | 60   | %                 | Notes 3                              |
| Output Impedance  | R <sub>OUT</sub>                |      | 50             |      | Ω                 | Single Ended, to<br>VDDOx            |
| Mismatch in a pair  | $\Delta R_{OUT}$                |      |                | 10   | %                 |                                      |

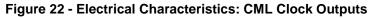
**Note 1:** The differential CML outputs can easily be interfaced to LVDS, LVPECL, CML and other differential inputs on neighboring ICs using a few external passive components. See Figure 23 for details.

**Note 2:** For all HSDIV, MSDIV and LSDIV combinations other than those specified in Note 3.



Note 3: For the case when APLLCR1.HSDIV specifies a half divide and OCxCR1.MSDIV=0 and OCxDIV=0.





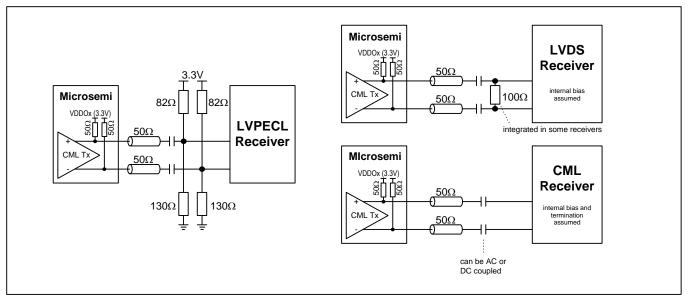


Figure 23 – Example External Components for CML Output Signals



#### Table 12 - Electrical Characteristics: CMOS and HSTL (Class I) Clock Outputs

| Characteristics                                       | Symbol                            | Min.          | Тур. | Max.  | Units | Notes         |
|---|-----------------------------------|---------------|------|-------|-------|---------------|
| Output frequency                                      | f <sub>OCMOS</sub>                | <<1Hz         |      | 250   | MHz   | Note 1        |
| Output high voltage                                   | V <sub>OH</sub>                   | VDDOx<br>-0.4 |      | VDDOx | V     | Notes 3, 4    |
| Output low voltage                                    | V <sub>OL</sub>                   | 0             |      | 0.4   | V     | Notes 3, 4    |
| Output rise/fall time, VCCOx=1.8V,<br>OCxCR2.DRIVE=4x |                                   |               | 0.4  |       | ns    | 2pF load      |
| Output rise/fall time, VCCOx=1.8V,<br>OCxCR2.DRIVE=4x | ]                                 |               | 1.2  |       | ns    | 15pF load     |
| Output rise/fall time, VCCOx=3.3V,<br>OCxCR2.DRIVE=1x | - t <sub>R</sub> , t <sub>F</sub> |               | 0.7  |       | ns    | 2pF load      |
| Output rise/fall time, VCCOx=3.3V,<br>OCxCR2.DRIVE=1x |                                   |               | 2.2  |       | ns    | 15pF load     |
| Output duty cycle                                     |                                   | 45            | 50   | 55    | %     | Note 5        |
| Output duty cycle                                     |                                   | 42            | 50   | 58    | %     | Notes 6, 7    |
| Output duty cycle, OCxNEG single-ended                |                                   |               | 50   |       | %     | Note 6        |
| Output duty cycle, OCxPOS single-ended                |                                   |               | 46   |       | %     | Note 6        |
| Output current when output disabled                   |                                   |               | 10   |       | μΑ    | OCxCR2.OCSF=0 |

Note 1: Minimum output frequency is a function of VCO frequency and output divider values and is guaranteed by design.

Note 2: Measured with a series resistor of  $33\Omega$  and a 5pF load capacitance unless otherwise specified.

**Note 3:** For HSTL Class I,  $V_{OH}$  and  $V_{OL}$  apply for both unterminated loads and for symmetrically terminated loads, i.e. 50 $\Omega$  to VDDOx/2.

Note 4: For VDDOx=3.3V and OCxCR2.DRIVE=1x, I<sub>0</sub>=4mA. For VDDOx=1.5V and OCxCR2.DRIVE=4x, I<sub>0</sub>=8mA.

**Note 5:** Output clock frequency  $\leq$  160MHz or VDDOx  $\geq$  1.8V.

**Note 6:** Output clock frequency > 160MHz and VDDOx < 1.8V.

**Note 7:** Measured differentially.

## Interfacing to HCSL Components

Outputs in HSTL mode with VDDOx=1.5V or VDDOx=1.8V can provide an HCSL signal ( $V_{OH}$  typ. 0.75V) to a neighboring component when configured as shown in Figure 24 below. For VDDOx=1.5V the value of  $R_s$  should be set to 30 $\Omega$  and OCxCR2.DRIVE should be set to 4x. For VDDOx=1.8V the value of  $R_s$  should be set to 20 $\Omega$  and OCxCR2.DRIVE should be set to 2x.

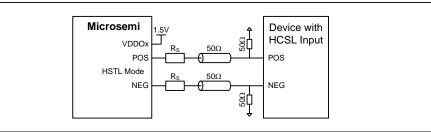


Figure 24 – Example External Components for HCSL Output Signals

#### Table 13 - Electrical Characteristics: APLL Frequencies

| Characteristics          | Symbol           | Min. | Тур. | Max.   | Units | Notes |
|--------------------------|------------------|------|------|--------|-------|-------|
| APLL VCO frequency range | f <sub>VCO</sub> | 3715 |      | 4180   | MHz   |       |
| APLL PFD input frequency | t <sub>PFD</sub> | 9.72 |      | 156.25 | MHz   |       |



#### Table 14 - Electrical Characteristics: Jitter Specifications

| Characteristics                                       | Min.   | Тур.       | Max.   | Units    | Notes           |
|---|--------|------------|--------|----------|-----------------|
| Output Phase Jitter, 622.08MHz, APLL-Only             |        | 0.16       | 0.225  | ps RMS   | Notes 1, 2      |
| Output Phase Jitter, 622.08MHz, DPLL+APLL             |        | 0.25       | 0.3    | ps RMS   | Notes 1, 3      |
| Output Phase Jitter, 625MHz, APLL-Only, (1.875-20MHz) |        | 0.06       |        | ps RMS   | Note 5          |
| Output Period Jitter                                  |        | 8          |        | ps pk-pk | N=10000, Note 6 |
| Output Half-Period Jitter                             |        | 14         |        | ps pk-pk | N=10000, Note 6 |
| Output Cycle-to-Cycle Jitter                          |        | 7.5        |        | ps pk    | N=10000, Note 6 |
| Jitter Transfer Bandwidth, DPLL+APLL                  | Progra | ammable: 1 | to 500 | Hz       |                 |
| Jitter Transfer Bandwidth, APLL-Only                  |        | 600        |        | kHz      | Note 4          |
| Bypass Path Additive Jitter, 100MHz in/out            |        | 0.18       |        | ps RMS   | 12kHz-20MHz     |

**Note 1:** Jitter calculated from integrated phase noise from 12kHz to 20MHz.

Note 2: Tested with 155.52MHz XO (Vectron VCC1) connected to IC1, APLL VCO frequency 3732.48MHz, HSDIV1=6, OC1 frequency 622.08MHz.

Note 3: Tested with 114.285MHz XO (Vectron VCC1-1537-114M285) connected to XA, APLL VCO frequency 3732.48MHz, HSDIV1=6, OC1 frequency 622.08MHz.

Note 4: APLL bandwidth and damping factor can be field configured over a limited range. Contact the factory for details.

Note 5: With 50MHz crystal doubled as APLL input. Jitter calculated from integrated phase noise from 1.875MHz to 20MHz.

**Note 6:** Outputs from a half-divide (e.g. 4.5) in the high-speed divider followed by only an odd divide in the medium-speed divider can have higher jitter values. Example: 100MHz from VCO=3750MHz, HSDIV1=7.5, MSDIV=5 has typical period jitter of 16ps, typical cycle-to-cycle jitter of 15ps and typical half-period jitter of 58ps.

#### Table 15 - Electrical Characteristics: Typical Output Jitter Performance, APLL Only

| Output Frequency    | Output Jitter, ps RMS,<br>125MHz XO Reference <sup>1</sup> | Output Jitter, ps RMS,<br>50MHz Crystal Reference <sup>2</sup> |
|---------------------|--|--|
| 625MHz              | 0.155  | 0.185  |
| 156.25MHz           | 0.18   | 0.21   |
| 125MHz              | 0.19   | 0.21   |
| 25MHz CMOS          | 0.26   | 0.28   |
| 622.08MHz           | 0.25   | 0.27   |
| 155.52MHz           | 0.27   | 0.315  |
| 622.08MHz * 255/237 | 0.26   | 0.29   |
| 155.52MHz * 255/237 | 0.275  | 0.30   |
| 614.4MHz            | 0.25   | 0.28   |
| 153.6MHz            | 0.28   | 0.32   |

Note 1: APLL locked to external 125MHz XO (Vectron VCC1-1535-125M000).

Note 2: APLL locked to external 50MHz crystal (TXC 7M50070021), internal doubler enabled when multiplication is fractional.

**Note 3:** All signals are differential unless otherwise stated. Jitter is integrated 12kHz to 5MHz for 25MHz output frequency and 12kHz to 20MHz for all other output frequencies.

#### Table 16 - Electrical Characteristics: Typical Output Jitter Performance, DPLL+APLL

| Output Frequency    | Output Jitter, ps RMS<br>114.285MHz XO Reference <sup>1</sup> | Output Jitter, ps RMS<br>57.1425MHz Crystal Ref. <sup>2</sup> |
|---------------------|---|---|
| 625MHz              | 0.26  | 0.34  |
| 156.25MHz           | 0.28  | 0.36  |
| 125MHz              | 0.29  | 0.35  |
| 25MHz CMOS          | 0.345   | 0.45  |
| 622.08MHz           | 0.26  | 0.34  |
| 155.52MHz           | 0.285   | 0.36  |
| 622.08MHz * 255/237 | 0.29  | 0.37  |
| 155.52MHz * 255/237 | 0.31  | 0.38  |
| 614.4MHz            | 0.275   | 0.36  |
| 153.6MHz            | 0.29  | 0.36  |

Note 1: DPLL Locked to 25MHz input on IC1, APLL locked to DPLL, Vectron VCC1-1537-114M285 on XA for DPLL master clock.

Note 2: DPLL Locked to 25MHz input on IC1, APLL locked to DPLL, TXC 7M57172001 crystal doubled for master clock.

**Note 3:** All signals are differential unless otherwise stated. Jitter is integrated 12kHz to 5MHz for 25MHz output frequency and 12kHz to 20MHz for all other output frequencies.



# Table 17 - Electrical Characteristics: Typical Input-to-Output Clock Delay

| Mode           | Delay, Input Clock Edge to Output Clock Edge  |
|----------------|---|
|                | Using external feedback: 0<br>(DPLL's DPHOFF field can be use to compensate for board propagation<br>delays. See section 5.9.4.3.1.)  |
|                | <b>Without using external feedback:</b> Non deterministic but constant as long as the DPLL and APLL remain locked and output clock phases are not adjusted as described in section 5.9.4.1. See section 5.9.4.3.2.            |
| DPLL+APLL Mode | External feedback configuration has a device output wired to a device input and (ICSCR1.FBSEL $\neq$ 0). In this configuration the DPLL drives the device's output clock phase to be equal to the input clock phase + DPHOFF. |
|                | Delay can be tuned for all outputs traceable to the DPLL by adjusting the DPLL's DPHOFF field. Delay for an individual output can be tuned using the output phase adjustment capability described in section 5.9.4.1.         |
| APLL-Only Mode | Non-deterministic but constant as long as the APLL remains locked and output clock phases are not adjusted as described in section 5.9.4.1.   |

## Table 18 - Electrical Characteristics: Typical Output-to-Output Clock Delay

| Mode                   | Delay, Output Clock Edge to Output Clock Edge  |
|------------------------|--|
|                        | <100ps   |
| DPLL+APLL or APLL-Only | Requires phase adjustment and phase alignment capability described in section 5.9.4. |

#### Table 19 - Electrical Characteristics: SPI Slave Interface Timing, Device Registers

| Characteristics (Note 1, 2)          | Symbol                          | Min. | Тур. | Max. | Units | Notes |
|--------------------------------------|---------------------------------|------|------|------|-------|-------|
| SCLK frequency                       | f <sub>BUS</sub>                |      |      | 10   | MHz   |       |
| SCLK cycle time                      | t <sub>CYC</sub>                | 100  |      |      | ns    |       |
| CSN setup to first SCLK edge         | t <sub>SUC</sub>                | 50   |      |      | ns    |       |
| CSN hold time after last SCLK edge   | t <sub>HDC</sub>                | 50   |      |      | ns    |       |
| CSN high time                        | t <sub>CSH</sub>                | 50   |      |      | ns    |       |
| SCLK high time                       | t <sub>CLKH</sub>               | 40   |      |      | ns    |       |
| SCLK low time                        | t <sub>CLKL</sub>               | 40   |      |      | ns    |       |
| MOSI data setup time                 | t <sub>sui</sub>                | 10   |      |      | ns    |       |
| MOSI data hold time                  | t <sub>HDI</sub>                | 10   |      |      | ns    |       |
| MISO enable time from SCLK edge      | t <sub>EN</sub>                 | 0    |      |      | ns    |       |
| MISO disable time from CSN high      | t <sub>DIS</sub>                |      |      | 80   | ns    |       |
| MISO data valid time                 | t <sub>DV</sub>                 |      |      | 40   | ns    |       |
| MISO data hold time from SCLK edge   | t <sub>HDO</sub>                | 0    |      |      | ns    |       |
| CSN, MOSI input rise time, fall time | t <sub>R</sub> , t <sub>F</sub> |      |      | 10   | ns    |       |

Note 1: All timing is specified with 100pF load on all SPI pins.

Note 2: All parameters in this table are guaranteed by design or characterization.

**Note 3:** See timing diagram in Figure 25.



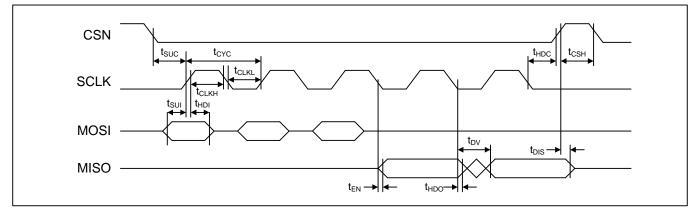


Figure 25 - SPI Interface Timing

#### Table 20 - Electrical Characteristics: SPI Slave Interface Timing, Internal EEPROM

| Characteristics (Note 1, 2)          | Symbol                          | Min. | Typ. | Max. | Units | Notes |
|--------------------------------------|---------------------------------|------|------|------|-------|-------|
| SCLK frequency                       | f <sub>BUS</sub>                |      |      | 10   | MHz   |       |
| SCLK cycle time                      | t <sub>CYC</sub>                | 100  |      |      | ns    |       |
| CSN setup to first SCLK edge         | t <sub>SUC</sub>                | 50   |      |      | ns    |       |
| CSN hold time after last SCLK edge   | t <sub>HDC</sub>                | 51   |      |      | ns    |       |
| CSN high time                        | t <sub>CSH</sub>                | 51   |      |      | ns    |       |
| SCLK high time                       | t <sub>CLKH</sub>               | 41   |      |      | ns    |       |
| SCLK low time                        | t <sub>CLKL</sub>               | 41   |      |      | ns    |       |
| MOSI data setup time                 | t <sub>sui</sub>                | 11   |      |      | ns    |       |
| MOSI data hold time                  | t <sub>HDI</sub>                | 11   |      |      | ns    |       |
| MISO enable time from SCLK edge      | t <sub>EN</sub>                 | 0    |      |      | ns    |       |
| MISO disable time from CSN high      | t <sub>DIS</sub>                |      |      | 90   | ns    |       |
| MISO data valid time                 | t <sub>DV</sub>                 |      |      | 60   | ns    |       |
| MISO data hold time from SCLK edge   | t <sub>HDO</sub>                | 0    |      |      | ns    |       |
| CSN, MOSI input rise time, fall time | t <sub>R</sub> , t <sub>F</sub> |      |      | 10   | ns    |       |

Note 1: This timing applies (a) when EESEL=1 and (b) in direct EEPROM write mode (see section 5.14.2).

Note 2: All timing is specified with 100pF load on all SPI pins.

Note 3: All parameters in this table are guaranteed by design or characterization.

**Note 4:** See timing diagram in Figure 25.



Table 21 - Electrical Characteristics: I<sup>2</sup>C Slave Interface Timing

| Characteristics   | Symbol              | Min.                      | Тур. | Max. | Units | Notes                         |
|---|---------------------|---------------------------|------|------|-------|-------------------------------|
| SCL clock frequency   | f <sub>SCL</sub>    |                           |      | 400  | kHz   |                               |
| Hold time, START condition  | t <sub>HD:STA</sub> | 0.6                       |      |      | μs    |                               |
| Low time, SCL   | t <sub>LOW</sub>    | 1.3                       |      |      | μs    |                               |
| High time, SCL  | t <sub>HIGH</sub>   | 0.6                       |      |      | μs    |                               |
| Setup time, START condition   | t <sub>SU:STA</sub> | 0.6                       |      |      | μs    |                               |
| Data hold time  | t <sub>HD:DAT</sub> | 0                         |      | 0.9  | μs    | Notes 2 and 3                 |
| Data setup time   | t <sub>SU:DAT</sub> | 100                       |      |      | ns    |                               |
| Rise time   | t <sub>R</sub>      |                           |      |      | ns    | Note 4                        |
| Fall time   | t <sub>F</sub>      | 20 +<br>0.1C <sub>b</sub> |      | 300  | ns    | $C_b$ is cap. of one bus line |
| Setup time, STOP condition  | t <sub>su:sto</sub> | 0.6                       |      |      | μs    |                               |
| Bus free time between STOP/START                                      | t <sub>BUF</sub>    | 1.3                       |      |      | μs    |                               |
| Pulse width of spikes which must be<br>suppressed by the input filter | t <sub>SP</sub>     | 0                         |      | 50   | ns    |                               |

**Note 1:** The timing parameters in this table are specifically for 400kbps Fast Mode. Fast Mode devices are downward-compatible with 100kbps Standard Mode I<sup>2</sup>C bus timing. All parameters in this table are guaranteed by design or characterization. All values referred to V<sub>IHmin</sub> and V<sub>ILmax</sub> levels (see Table 8).

Note 2: The device internally provides a hold time of at least 300ns for the SDA signal (referred to the V<sub>IHmin</sub> of the SCL signal) to bridge the undefined region of the falling edge of SCL. Other devices must provide this hold time as well per the I<sup>2</sup>C specification.

Note 3: The  $l^2C$  specification indicates that the maximum  $t_{HD:DAT}$  spec only has to be met if the device does not stretch the low period  $(t_{LOW})$  of the SCL signal. The device does not stretch the low period of the SCL signal.

Note 4: Determined by choice of pull-up resistor.

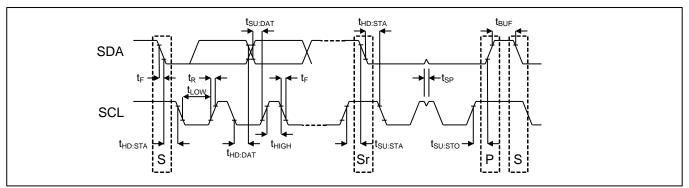
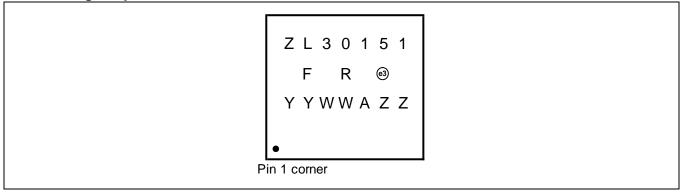


Figure 26 - I<sup>2</sup>C Slave Interface Timing

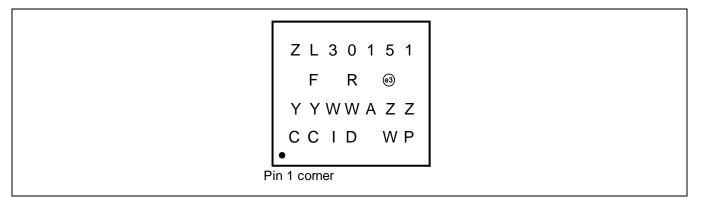


## 8. Package and Thermal Information

## 8.1 Package Top Mark Format



#### Figure 27 - Non-customized Device Top Mark





#### Table 22 – Package Top Mark Legend

| Line | Characters | Description                                  |
|------|------------|--|
| 1    | ZL30151    | Part Number                                  |
| 2    | F          | Fab Code                                     |
| 2    | R          | Product Revision Code                        |
| 2    | e3         | Denotes Pb-Free Package                      |
| 3    | YY         | Last Two Digits of the Year of Encapsulation |
| 3    | WW         | Work Week of Assembly                        |
| 3    | А          | Assembly Location Code                       |
| 3    | ZZ         | Assembly Lot Sequence                        |
| 4    | CCID       | Custom Programming Identification Code       |
| 4    | WP         | Work Week of Programming                     |



## 8.2 Thermal Specifications

#### Table 23 - 5x5mm QFN Package Thermal Properties

| PARAMETER  | SYMBOL             | CONDITIONS     | VALUE | UNITS |
|--|--------------------|----------------|-------|-------|
| Maximum Ambient Temperature                                  | TA                 |                | 85    | °C    |
| Maximum Junction Temperature                                 | TJMAX              |                | 125   | °C    |
| Junction to Ambient Thermal Resistance                       |                    | still air      | 29.6  |       |
| (Note 1)   | θја                | 1m/s airflow   | 23.3  | °C/W  |
|  |                    | 2.5m/s airflow | 20.6  |       |
| Junction to Board Thermal Resistance                         | $\theta_{JB}$      |                | 9.8   | °C/W  |
| Junction to Case Thermal Resistance                          | θις                |                | 17.5  | °C/W  |
| Junction to Pad Thermal Resistance (Note 2)                  | θյթ                | Still air      | 3.4   | °C/W  |
| Junction to Top-Center Thermal<br>Characterization Parameter | $\psi_{\text{JT}}$ | Still air      | 0.2   | °C/W  |

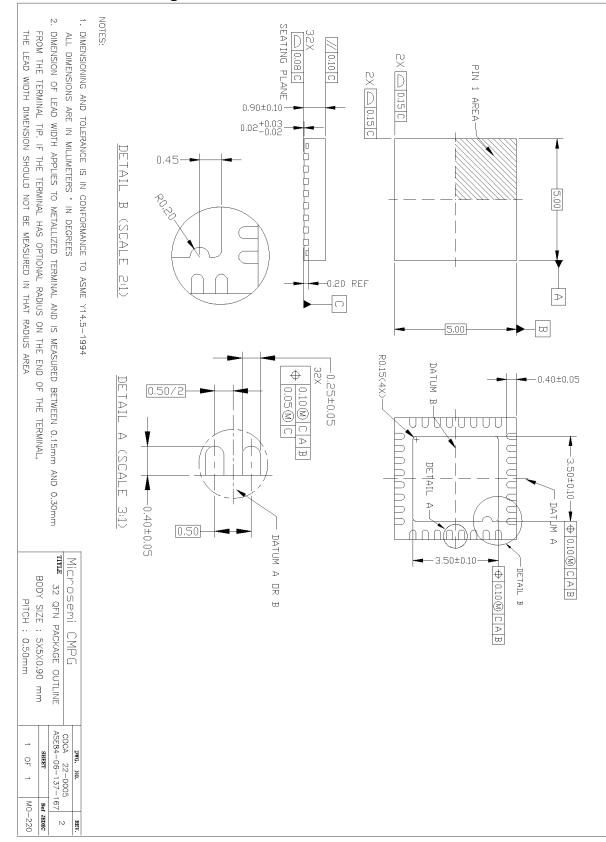
Note 1: Theta-JA ( $\theta_{JA}$ ) is the thermal resistance from junction to ambient when the package is mounted on an 4-layer JEDEC standard test board and dissipating maximum power.

Note 2: Theta-JP  $(\theta_{JP})$  is the thermal resistance from junction to the center exposed pad on the bottom of the package.

**Note 3:** For all numbers in the table, the exposed pad is connected to the ground plane with a 5x5 array of thermal vias; via diameter 0.33mm; via pitch 0.76mm.



## 9. Mechanical Drawing





## **10. Acronyms and Abbreviations**

| io. / or only i |  |
|-----------------|--|
| APLL            | analog phase locked loop                   |
| BITS            | building integrated timing supply          |
| CML             | current mode logic                         |
| DFS             | digital frequency synthesis                |
| DPLL            | digital phase locked loop                  |
| EEC             | Ethernet equipment clock                   |
| GbE             | gigabit Ethernet                           |
| HCSL            | high-speed current steering logic          |
| HSTL            | high-speed transceiver logic               |
| I/O             | input/output                               |
| LVDS            | low-voltage differential signal            |
| LVPECL          | low-voltage positive emitter-coupled logic |
| MTIE            | maximum time interval error                |
| OCXO            | oven controlled crystal oscillator         |
| PBO             | phase build-out                            |
| PFD             | phase/frequency detector                   |
| PLL             | phase locked loop                          |
| ppb             | parts per billion                          |
| ppm             | parts per million                          |
| pk-pk           | peak-to-peak                               |
| RMS             | root-mean-square                           |
| RO              | read-only                                  |
| R/W             | read/write                                 |
| SDH             | synchronous digital hierarchy              |
| SEC             | SDH equipment clock                        |
| SETS            | synchronous equipment timing source        |
| SONET           | synchronous optical network                |
| SSU             | synchronization supply unit                |
| STM             | synchronous transport module               |
| TDEV            | time deviation                             |
| тсхо            | temperature-compensated crystal oscillator |
| UI              | unit interval                              |
| UIPP or UIP-P   | unit interval, peak to peak                |
| XO              | crystal oscillator                         |
|                 |  |



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# 11. Data Sheet Revision History

| Revision      | Description   |
|---------------|---|
| 23-Jun-2014   | First general release   |
|               | In Table 7 added <i>AIDD180DIV</i> spec. and added typical power spec for DPLL+APLL with one input and one output enabled.  |
| 07-Jul-2014   | In Table 9 changed XA VIH min from 1.65V to 1.2V.   |
|               | In Table 14 added phase jitter for 625MHz measured 1.875-20MHz, period jitter and cycle-to-<br>cycle jitter plus Note 5.  |
|               | Changed title to Any-to-Any.  |
| 07-Aug-2014   | In Table 1, in ICx row changed the note about IC3 to delete the recommendation to AC-couple the NEG trace to VSS.   |
|               | Above Figure 24 specified $R_s$ should be set to $30\Omega$ and OCxCR2.DRIVE should be set to 4x.   |
|               | Corrected references to section 0.  |
|               | Edited section 5.5 to match the Table 1 edit done 07-Aug-2014.  |
| 29-Sep-2014   | In Table 14, reduced typical period jitter to 8ps and typical cycle-to-cycle jitter to 7.5ps. In both specs removed "100MHz" from the name and changed N=50000 to N=10000. Added half-period jitter spec and footnote 6.  |
|               | Added section 8.1 to document package top mark.   |
|               | In section 5.3 added two guidelines to ensure the device properly samples the reset values of TEST, IF[1:0] and AC[1:0] pins.   |
|               | In section 5.12 change min reset assert time from 100ns to 100ms to ensure AC0/GPIO0, AC1/GPIO1, TEST/GPIO2, IF0/CSN and IF1/MISO pads have enough time to set up their "latched at reset" values. Also added that system software must wait for for GLOBISR.BCDONE=1 before configuring the device.  |
|               | In Table 21 Note 1 clarified device compatibility with I <sup>2</sup> C 400kbps Fast Mode and 100kbps Standard Mode.  |
|               | In section 5.14.2 specified that MISO is driven continually during Direct EEPROM Write Mode.  |
|               | Documented the 100 and 101 decodes of APLLCR3.APLLMUX.  |
|               | Changed the VDDO1, VDDO2, VDDO3 descriptions in Table 1 to clearly indicate that VDDO1 is for output OC1, VDDO2 is for output OC2, etc.   |
| 31-Mar-2015   | Deleted section 5.14.1, renamed and rewrote section 5.14.2 (which became new section 5.14.1) and renamed section 5.14.  |
|               | Documented the MCR2.AINCDIS bit.  |
|               | Modified Figure 23. In the LVDS diagram removed the $5k\Omega$ resistors to ground, which are only appropriate for one type of LVDS receiver design. Added $100\Omega$ differential termination and note about how it may be integrated in some receivers. Added note that internal bias and termination is assumed for the CML receiver diagram. |
|               | Edited the <i>Interfacing to HCSL Components</i> discussion on page 91 to include a recommendation for HCSL when VDDOx=1.8V.  |
|               | In Table 14 added bypass path additive jitter spec.   |
|               | Widened the master clock frequency range to 93-130MHz without gaps in Table 9 and the MCR2.MCLK description.  |
|               | Added section 5.14.3, Holding Other Devices in Reset During Auto-Configuration.   |
| 28-Mar-2016   | In the ID2 descrption corrected the bit 0 default value to 1.   |
| 20-iviai-2010 | Corrected Figure 4 to have square corners rather than chamfered corners to match the  |



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| Revision    | Description  |
|-------------|--|
|             | mechanical drawing in section 9.   |
|             | Added Note 3 to Table 23.  |
|             | In Table 10 changed $t_H$ , $t_L$ specs for $f_{IN}$ > 250MHz from 0.4/ $f_{IN}$ typical to 0.4ns min and added Note 6.  |
|             | In DPLLCR1.HOMODE description corrected decodes to 00=HO no reset, 01=HO w/ reset, 10=freerun.   |
|             | Edited the DPHOFF1 and DPHASE1 descriptions to indicate the fields are in units of picoseconds.  |
|             | Edited section 5.12 to reduce RSTN assertion time for all but one specific situation.  |
|             | Added a note to the MCR1.RST description to indicate the need to clear the MCSEL, MCSEL1 and ROSCD bits before setting the RST bit.  |
|             | In section 5.10.2 in the Read Transactions paragraph added a note describing the case where the $I^2C$ write is separated in time from the $I^2C$ read.  |
|             | In section 5.2.2 changed "49MHz to 60MHz" to "46.5MHz to 60MHz".   |
| 11-Jul-2016 | Documented DPLLCR2.HSEN.   |
|             | Documented the PHLKTO and LKATO registers.   |
|             | In section 5.9.2. second paragraph added maximum input frequency sentences for the medium-speed and low-speed dividers.  |
|             | In section 6 changed the end of the address range from 0x1FF to 0x6FF to include test registers.   |
|             | In the DPHASE and DPHOFF register descriptions corrected units from ps to 2 <sup>-10</sup> ns and indicated that positive values represent phase earlier in time.  |
| 23-Jan-2018 | In the EESEL register description, added a note that the EESEL bit is write-only.  |
|             | In Table 1, in the SCL/SCLK and SDA/MOSI pin descriptions added notes indicating the need for an external pullup resistor for I <sup>2</sup> C operation and referring the reader to the I <sup>2</sup> C specification for details. |
|             | In OCxPH register description, indicated that positive values represent later in time.   |
|             | In the APLLCR4 register description indicated that "increment" moves the signal later in time and "decrement" moves the signal earlier in time.  |



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